

October 2009

## Features

### General

- Circuit Emulation Services over Packet (CESoP) transport for MPLS, IP and Ethernet networks
- On chip timing & synchronization recovery across a packet network
- Grooming capability for Nx64 Kbps trunking

### Circuit Emulation Services

- Supports ITU-T Recommendation Y.1413 and Y.1453
- Supports IETF RFC4553 and RFC5086
- Supports MEF8 and MFA 8.0.0
- Structured, synchronous CESoP with clock recovery
- Unstructured, asynchronous CESoP, with integral per stream clock recovery



### TDM Interfaces

- Up to 32 T1/E1, 8 J2, or 2 T3/E3 ports
- H.110, H-MVIP, ST-BUS backplanes
- Up to 1024 bi-directional 64 Kbps channels
- Direct connection to LIUs, framers, backplanes

### Ordering Information

|             |            |                       |
|-------------|------------|-----------------------|
| ZL50110GAG  | 552 PBGA   | Trays, Bake & Drypack |
| ZL50111GAG  | 552 PBGA   | Trays, Bake & Drypack |
| ZL50112GAG  | 552 PBGA   | Trays, Bake & Drypack |
| ZL50114GAG  | 552 PBGA   | Trays, Bake & Drypack |
| ZL50110GAG2 | 552 PBGA** | Trays, Bake & Drypack |
| ZL50111GAG2 | 552 PBGA** | Trays, Bake & Drypack |
| ZL50112GAG2 | 552 PBGA** | Trays, Bake & Drypack |
| ZL50114GAG2 | 552 PBGA** | Trays, Bake & Drypack |

\*\*Pb Free Tin Silver/Copper

**-40°C to +85°C**

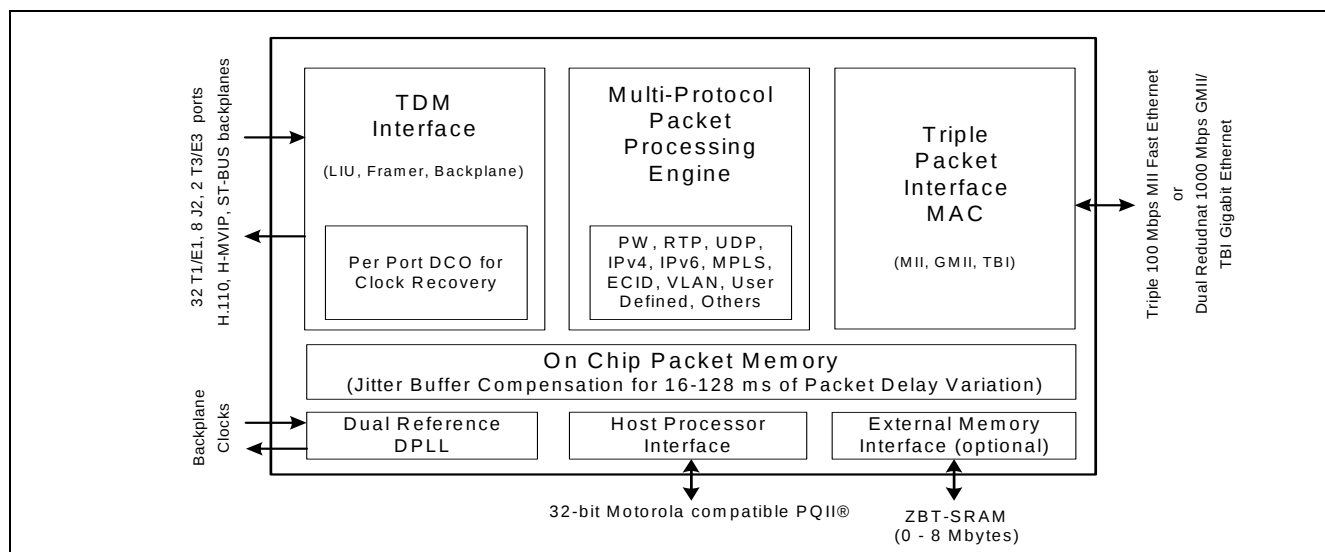
- Dual reference Stratum 4 and 4E DPLL for synchronous operation

### Network Interfaces

- Up to 3 x 100 Mbps MII Fast Ethernet or Dual Redundant 1000 Mbps GMII/TBI Ethernet Interfaces

### System Interfaces

- Flexible 32 bit host CPU interface (Motorola PowerQUICC™ compatible)
- On-chip packet memory for self-contained operation, with buffer depths of over 16 ms
- Up to 8 Mbytes of off-chip packet memory, supporting buffer depths of over 128 ms



**Figure 1 - ZL50111 High Level Overview**

**Packet Processing Functions**

- Flexible, multi-protocol packet encapsulation including support for IPv4, IPv6, RTP, MPLS, L2TPv3, ITU-T Y.1413, RFC4553, RFC5086 and user programmable
- Packet re-sequencing to allow lost packet detection
- Four classes of service with programmable priority mechanisms (WFQ and SP) using egress queues
- Flexible classification of incoming packets at layers 2, 3, 4 and 5
- Supports up to 128 separate CESoP connections across the Packet Switched Network

**Applications**

- Circuit Emulation Services over Packet Networks
  - Leased Line support over packet networks
  - Multi-Tenant Unit access concentration
  - TDM over Cable
  - Fibre To The Premises G/E-PON
  - Layer 2 VPN services
- Customer-premise and Provider Edge Routers and Switches
- Packet switched backplane applications

## Description

The ZL50110/11/12/14 family of CESoP processors are highly functional TDM to Packet bridging devices. The ZL50110/11/12/14 provides both structured and unstructured circuit emulation services over packet (CESoP) for up to 32 T1, 32 E1 and 8 J2 streams across a packet network based on MPLS, IP or Ethernet. The ZL50111 also supports unstructured T3 and E3 streams.

The circuit emulation features in the ZL50110/11/12/14 family supports the ITU Recommendations Y.1413 and Y.1453, as well as the CESoP standards from the Metro Ethernet Forum (MEF)–and MPLS and Frame Relay Alliance. The ZL50110/11/14 also supports IETF RFC4553 and RFC5086.

The ZL50110/11/12/14 provides up to triple 100 Mbps MII ports or dual redundant 1000 Mbps GMII/TBI ports.

The ZL50110/11/12/14 incorporates a range of powerful clock recovery mechanisms for each TDM stream, allowing the frequency of the source clock to be faithfully generated at the destination, enabling greater system performance and quality. Timing is carried using RTP or similar protocols, and both adaptive and differential clock recovery schemes are included, allowing the customer to choose the correct scheme for the application. An externally supplied clock may also be used to drive the TDM interface of the ZL50110/11/12/14.

The ZL50110/11/12/14 incur very low latency for the data flow, thereby increasing QoS when carrying voice services across the Packet Switched Network. Voice, when carried using CESoP, which typically has latencies of less than 10 ms, does not require expensive processing such as compression and echo cancellation.

The ZL50110/11/12/14 is capable of assembling user-defined packets of TDM traffic from the TDM interface and transmitting them out the packet interfaces using a variety of protocols. The ZL50110/11/12/14 supports a range of different packet switched networks, including Ethernet VLANs, IP and MPLS.

The ZL50110/11/12/14 can support up to 4 protocol stacks at the same time, provided that each protocol stack can be uniquely identified by a mask & match approach.

Packets received from the packet interfaces are parsed to determine the egress destination, and are appropriately queued to the TDM interface, they can also be forwarded to the host interface, or back toward the packet interface. Packets queued to the TDM interface can be re-ordered based on sequence number, and lost packets filled in to maintain timing integrity.

The ZL50110/11/12/14 family includes sufficient on-chip memory that external memory is not required in most applications. This reduces system costs and simplifies the design. For applications that do require more memory (e.g., high stream count or high latency), the device supports up to 8 Mbytes of SSRAM.

A comprehensive evaluation system is available upon request from your local Zarlink representative or distributor. This system includes the CESoP processor, various TDM interfaces and a fully featured evaluation software GUI that runs on a Windows PC.

## Device Line Up

There are four products within the ZL50110/11/12/14 family, with capacity as shown in the following table:

| Device  | TDM Interfaces                                                                                                                         | Ethernet Packet I/F                                                                                                    | Notes  |
|---------|----------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------|--------|
| ZL50114 | 4 T1, 4 E1, or 1 J2 streams or<br>4 MVIP/ST-BUS streams at 2.048 Mbps or<br>1 H.110/H-MVIP/ST-BUS streams at<br>8.192 Mbps             | Dual 100 Mbps MII or<br>Dual Redundant 1000 Mbps GMII/TBI                                                              | Note 1 |
| ZL50110 | 8 T1, 8 E1 or 2 J2 streams or<br>8 MVIP/ST-BUS streams at 2.048 Mbps or<br>2 H.110/H-MVIP/ST-BUS streams at<br>8.192 Mbps              | Dual 100 Mbps MII or<br>Dual Redundant 1000 Mbps GMII/TBI                                                              | Note 1 |
| ZL50112 | 16 T1, 16 E1, 4 J2 streams or<br>16 MVIP/ST-BUS streams at 2.048 Mbps or<br>4 H.110/H-MVIP/ST-BUS streams at<br>8.192 Mbps             | Triple 100 Mbps MII or<br>Dual Redundant 1000 Mbps GMII/TBI<br>or Single 100 Mbps MII and Single<br>1000 Mbps GMII/TBI | Note 1 |
| ZL50111 | 32 T1, 32 E1, 8 J2, 2 T3, 2 E3 streams or<br>32 MVIP/ST-BUS streams at 2.048 Mbps or<br>8 H.110/H-MVIP/ST-BUS streams at<br>8.192 Mbps | Triple 100 Mbps MII or<br>Dual Redundant 1000 Mbps GMII/TBI<br>or Single 100 Mbps MII and Single<br>1000 Mbps GMII/TBI | Note 1 |

**Table 1 - Capacity of Devices in the ZL50110/11/14 Family**

Note 1: T1/E1/J2 is for unstructured mode, and the H-MVIP/H.110/ST-BUS is for structured mode.

## Table of Contents

|                                                                   |           |
|-------------------------------------------------------------------|-----------|
| <b>1.0 Changes Summary</b>                                        | <b>11</b> |
| <b>2.0 Physical Specification</b>                                 | <b>14</b> |
| <b>3.0 External Interface Description</b>                         | <b>24</b> |
| 3.1 TDM Interface                                                 | 24        |
| 3.1.1 ZL50111 Variant TDM Stream Connection                       | 24        |
| 3.1.2 ZL50112 Variant TDM Stream Connection                       | 26        |
| 3.1.3 ZL50110 Variant TDM Stream Connection                       | 29        |
| 3.1.4 ZL50114 Variant TDM Stream Connection                       | 30        |
| 3.1.5 TDM Signals Common to ZL50110, ZL50111, ZL50112 and ZL50114 | 31        |
| 3.2 PAC Interface                                                 | 32        |
| 3.3 Packet Interfaces                                             | 33        |
| 3.4 External Memory Interface                                     | 43        |
| 3.5 CPU Interface                                                 | 45        |
| 3.6 System Function Interface                                     | 48        |
| 3.7 Test Facilities                                               | 49        |
| 3.7.1 Administration, Control and Test Interface                  | 49        |
| 3.7.2 JTAG Interface                                              | 49        |
| 3.8 Miscellaneous Inputs                                          | 50        |
| 3.9 Power and Ground Connections                                  | 50        |
| 3.10 ZL50111, ZL50112, ZL50110 and ZA50114 Internal Connections   | 51        |
| 3.11 ZL50112 Internal Connections                                 | 51        |
| 3.12 ZL50112 Auxiliary Clocks                                     | 51        |
| <b>4.0 Typical Applications</b>                                   | <b>51</b> |
| 4.1 Leased Line Provision                                         | 51        |
| 4.2 Metropolitan Area Network Aggregation                         | 52        |
| 4.3 Digital Loop Carrier                                          | 53        |
| 4.4 Remote Concentrator                                           | 54        |
| 4.5 Cell Site Backhaul                                            | 55        |
| 4.6 Equipment Architecture Example                                | 56        |
| <b>5.0 Functional Description</b>                                 | <b>57</b> |
| 5.1 Block Diagram                                                 | 57        |
| 5.2 Data and Control Flows                                        | 58        |
| 5.3 TDM Interface                                                 | 59        |
| 5.3.1 TDM Interface Block                                         | 59        |
| 5.3.2 Structured TDM Port Data Formats                            | 60        |
| 5.3.3 TDM Clock Structure                                         | 61        |
| 5.3.3.1 Synchronous TDM Clock Generation                          | 61        |
| 5.3.3.2 Asynchronous TDM Clock Generation                         | 61        |
| 5.4 Payload Assembly                                              | 61        |
| 5.4.1 Structured Payload Operation                                | 62        |
| 5.4.1.1 Structured Payload Order                                  | 63        |
| 5.4.2 Unstructured Payload Operation                              | 63        |
| 5.5 Protocol Engine                                               | 64        |
| 5.6 Packet Transmission                                           | 64        |
| 5.7 Packet Reception                                              | 64        |
| 5.8 TDM Formatter                                                 | 64        |
| <b>6.0 Clock Recovery</b>                                         | <b>65</b> |
| 6.1 Differential Clock Recovery                                   | 65        |
| 6.2 Adaptive Clock Recovery                                       | 66        |
| 6.3 SYSTEM_CLK Considerations                                     | 67        |
| <b>7.0 System Features</b>                                        | <b>68</b> |

## Table of Contents

|                                                         |           |
|---------------------------------------------------------|-----------|
| 7.1 Latency .....                                       | 68        |
| 7.2 Loopback Modes .....                                | 68        |
| 7.3 Host Packet Generation .....                        | 68        |
| 7.4 Loss of Service (LOS) .....                         | 69        |
| 7.5 External Memory Requirement .....                   | 69        |
| 7.6 GIGABIT Ethernet - Recommended Configurations ..... | 70        |
| 7.6.1 Central Ethernet Switch .....                     | 71        |
| 7.6.2 Redundant Ethernet Switch .....                   | 72        |
| 7.7 Power Up sequence .....                             | 72        |
| 7.8 JTAG Interface and Board Level Test Features .....  | 73        |
| 7.9 External Component Requirements .....               | 73        |
| 7.9.1 Host Processor .....                              | 73        |
| 7.9.2 Other components .....                            | 73        |
| 7.10 Miscellaneous Features .....                       | 73        |
| 7.11 Test Modes Operation .....                         | 74        |
| 7.11.1 Overview .....                                   | 74        |
| 7.11.1.1 System Normal Mode .....                       | 74        |
| 7.11.1.2 System Tri-State Mode .....                    | 74        |
| 7.11.2 Test Mode Control .....                          | 74        |
| 7.11.3 System Normal Mode .....                         | 74        |
| 7.11.4 System Tri-state Mode .....                      | 74        |
| <b>8.0 DPLL Specification .....</b>                     | <b>75</b> |
| 8.1 Modes of Operation .....                            | 75        |
| 8.1.1 Locking Mode (normal operation) .....             | 75        |
| 8.1.2 Holdover Mode .....                               | 76        |
| 8.1.3 Freerun Mode .....                                | 76        |
| 8.1.4 Powerdown Mode .....                              | 76        |
| 8.2 Reference Monitor Circuit .....                     | 76        |
| 8.3 Locking Mode Reference Switching .....              | 77        |
| 8.4 Locking Range .....                                 | 77        |
| 8.5 Locking Time .....                                  | 77        |
| 8.6 Lock Status .....                                   | 78        |
| 8.7 Jitter .....                                        | 78        |
| 8.7.1 Acceptance of Input Wander .....                  | 78        |
| 8.7.2 Intrinsic Jitter .....                            | 78        |
| 8.7.3 Jitter Tolerance .....                            | 78        |
| 8.7.4 Jitter Transfer .....                             | 78        |
| 8.8 Maximum Time Interval Error (MTIE) .....            | 79        |
| <b>9.0 Memory Map and Register Definitions .....</b>    | <b>80</b> |
| <b>10.0 DC Characteristics .....</b>                    | <b>81</b> |
| <b>11.0 AC Characteristics .....</b>                    | <b>83</b> |
| 11.1 TDM Interface Timing - ST-BUS .....                | 83        |
| 11.1.1 ST-BUS Slave Clock Mode .....                    | 83        |
| 11.1.2 ST-BUS Master Clock Mode .....                   | 85        |
| 11.2 TDM Interface Timing - H.110 Mode .....            | 86        |
| 11.3 TDM Interface Timing - H-MVIP .....                | 87        |
| 11.4 TDM LIU Interface Timing .....                     | 88        |
| 11.5 PAC Interface Timing .....                         | 89        |
| 11.6 Packet Interface Timing .....                      | 89        |
| 11.6.1 MII Transmit Timing .....                        | 89        |
| 11.6.2 MII Receive Timing .....                         | 91        |
| 11.6.3 GMII Transmit Timing .....                       | 92        |

## Table of Contents

|                                                                               |            |
|-------------------------------------------------------------------------------|------------|
| 11.6.4 GMII Receive Timing .....                                              | 93         |
| 11.6.5 TBI Interface Timing .....                                             | 94         |
| 11.6.6 Management Interface Timing .....                                      | 95         |
| 11.7 External Memory Interface Timing .....                                   | 96         |
| 11.8 CPU Interface Timing .....                                               | 97         |
| 11.9 System Function Port .....                                               | 100        |
| 11.10 JTAG Interface Timing .....                                             | 101        |
| <b>12.0 Power Characteristics .....</b>                                       | <b>103</b> |
| <b>13.0 Design and Layout Guidelines .....</b>                                | <b>104</b> |
| 13.1 High Speed Clock & Data Interfaces .....                                 | 104        |
| 13.1.1 External Memory Interface - special considerations during layout ..... | 105        |
| 13.1.2 GMAC Interface - special considerations during layout .....            | 105        |
| 13.1.3 TDM Interface - special considerations during layout .....             | 105        |
| 13.1.4 Summary .....                                                          | 105        |
| 13.2 CPU TA Output .....                                                      | 105        |
| 13.3 Mx_LINKUP_LED Outputs .....                                              | 106        |
| <b>14.0 Reference Documents .....</b>                                         | <b>109</b> |
| 14.1 External Standards/Specifications .....                                  | 109        |
| 14.2 Zarlink Standards .....                                                  | 109        |
| <b>15.0 Glossary .....</b>                                                    | <b>110</b> |

## List of Figures

|                                                                                 |     |
|---------------------------------------------------------------------------------|-----|
| Figure 1 - ZL50111 High Level Overview . . . . .                                | 1   |
| Figure 2 - ZL50111 Package View and Ball Positions . . . . .                    | 15  |
| Figure 3 - ZL50112 Package View and Ball Positions . . . . .                    | 16  |
| Figure 4 - ZL50110 Package View and Ball Positions . . . . .                    | 17  |
| Figure 5 - ZL50114 Package View and Ball Positions . . . . .                    | 18  |
| Figure 6 - Leased Line Services Over a Circuit Emulation Link. . . . .          | 52  |
| Figure 7 - Metropolitan Area Network Aggregation using CESoP . . . . .          | 52  |
| Figure 8 - Digital Loop Carrier using CESoP . . . . .                           | 53  |
| Figure 9 - Remote Concentrator using CESoP . . . . .                            | 54  |
| Figure 10 - Cell Site Backhaul using CESoP . . . . .                            | 55  |
| Figure 11 - Equipment example using CESoP . . . . .                             | 56  |
| Figure 12 - ZL50110/11/12/14 Family Operation . . . . .                         | 57  |
| Figure 13 - ZL50110/11/12/14 Data and Control Flows . . . . .                   | 57  |
| Figure 14 - Synchronous TDM Clock Generation . . . . .                          | 61  |
| Figure 15 - ZL50110/11/12/14 Packet Format - Structured Mode . . . . .          | 62  |
| Figure 16 - Channel Order for Packet Formation. . . . .                         | 63  |
| Figure 17 - ZL50110/11/12/14 Packet Format - Unstructured Mode . . . . .        | 64  |
| Figure 18 - Differential Clock Recovery . . . . .                               | 66  |
| Figure 19 - Adaptive Clock Recovery . . . . .                                   | 67  |
| Figure 20 - External Memory Requirement for ZL50111 . . . . .                   | 69  |
| Figure 21 - External Memory Requirement for ZL50110 . . . . .                   | 70  |
| Figure 22 - Gigabit Ethernet Connection - Central Ethernet Switch. . . . .      | 71  |
| Figure 23 - Gigabit Ethernet Connection - Redundant Ethernet Switch. . . . .    | 72  |
| Figure 24 - Powering Up the ZL50110/11/12/14 . . . . .                          | 73  |
| Figure 25 - Jitter Transfer Function . . . . .                                  | 79  |
| Figure 26 - Jitter Transfer Function - Detail . . . . .                         | 80  |
| Figure 27 - TDM ST-BUS Slave Mode Timing at 8.192 Mbps . . . . .                | 84  |
| Figure 28 - TDM ST-BUS Slave Mode Timing at 2.048 Mbps . . . . .                | 84  |
| Figure 29 - TDM Bus Master Mode Timing at 8.192 Mbps . . . . .                  | 85  |
| Figure 30 - TDM Bus Master Mode Timing at 2.048 Mbps . . . . .                  | 86  |
| Figure 31 - H.110 Timing Diagram . . . . .                                      | 87  |
| Figure 32 - TDM - H-MVIP Timing Diagram for 16 MHz Clock (8.192 Mbps) . . . . . | 88  |
| Figure 33 - TDM-LIU Structured Transmission/Reception . . . . .                 | 89  |
| Figure 34 - MII Transmit Timing Diagram. . . . .                                | 90  |
| Figure 35 - MII Receive Timing Diagram . . . . .                                | 91  |
| Figure 36 - GMII Transmit Timing Diagram . . . . .                              | 92  |
| Figure 37 - GMII Receive Timing Diagram. . . . .                                | 93  |
| Figure 38 - TBI Transmit Timing Diagram . . . . .                               | 94  |
| Figure 39 - TBI Receive Timing Diagram. . . . .                                 | 95  |
| Figure 40 - Management Interface Timing for Ethernet Port - Read . . . . .      | 95  |
| Figure 41 - Management Interface Timing for Ethernet Port - Write . . . . .     | 96  |
| Figure 42 - External RAM Read and Write Timing. . . . .                         | 96  |
| Figure 43 - CPU Read - MPC8260 . . . . .                                        | 98  |
| Figure 44 - CPU Write - MPC8260. . . . .                                        | 98  |
| Figure 45 - CPU DMA Read - MPC8260 . . . . .                                    | 99  |
| Figure 46 - CPU DMA Write - MPC8260 . . . . .                                   | 99  |
| Figure 47 - JTAG Signal Timing . . . . .                                        | 102 |
| Figure 48 - JTAG Clock and Reset Timing. . . . .                                | 102 |

## List of Figures

|                                                               |     |
|---------------------------------------------------------------|-----|
| Figure 49 - ZL50110/11/12/14 Power Consumption Plot . . . . . | 103 |
| Figure 50 - CPU_TA Board Circuit . . . . .                    | 106 |
| Figure 51 - Mx_LINKUP_LED Stuffing Option . . . . .           | 107 |

## List of Tables

|                                                                                           |     |
|-------------------------------------------------------------------------------------------|-----|
| Table 1 - Capacity of Devices in the ZL50110/11/14 Family . . . . .                       | 4   |
| Table 2 - TDM Interface ZL50111 Stream Pin Definition . . . . .                           | 24  |
| Table 3 - TDM Interface ZL50112 Stream Pin Definition . . . . .                           | 26  |
| Table 4 - TDM Interface ZL50110 Stream Pin Definition . . . . .                           | 29  |
| Table 5 - TDM Interface ZL50114 Stream Pin Definition . . . . .                           | 30  |
| Table 6 - TDM Interface Common Pin Definition . . . . .                                   | 31  |
| Table 7 - PAC Interface Package Ball Definition . . . . .                                 | 32  |
| Table 8 - Packet Interface Signal Mapping - MII to GMII/TBI . . . . .                     | 33  |
| Table 9 - MII Management Interface Package Ball Definition . . . . .                      | 34  |
| Table 10 - MII Port 0 Interface Package Ball Definition . . . . .                         | 35  |
| Table 11 - MII Port 1 Interface Package Ball Definition . . . . .                         | 38  |
| Table 12 - MII Port 2 Interface Package Ball Definition . . . . .                         | 40  |
| Table 13 - MII Port 3 Interface Package Ball Definition . . . . .                         | 41  |
| Table 14 - External Memory Interface Package Ball Definition . . . . .                    | 43  |
| Table 15 - CPU Interface Package Ball Definition . . . . .                                | 45  |
| Table 16 - System Function Interface Package Ball Definition . . . . .                    | 48  |
| Table 17 - Administration/Control Interface Package Ball Definition . . . . .             | 49  |
| Table 18 - JTAG Interface Package Ball Definition . . . . .                               | 49  |
| Table 19 - Miscellaneous Inputs Package Ball Definitions . . . . .                        | 50  |
| Table 20 - Power and Ground Package Ball Definition . . . . .                             | 50  |
| Table 21 - No Connection Ball Definition . . . . .                                        | 51  |
| Table 22 - No Connection Ball Definition . . . . .                                        | 51  |
| Table 23 - Auxiliary clock Ball Definition . . . . .                                      | 51  |
| Table 24 - Standard Device Flows . . . . .                                                | 58  |
| Table 25 - TDM Services Offered by the ZL50110/11/12/14 Family . . . . .                  | 59  |
| Table 26 - Some of the TDM Port Formats Accepted by the ZL50110/11/12/14 Family . . . . . | 60  |
| Table 27 - DMA Maximum Bandwidths . . . . .                                               | 68  |
| Table 28 - Test Mode Control . . . . .                                                    | 74  |
| Table 29 - DPLL Input Reference Frequencies . . . . .                                     | 75  |
| Table 30 - TDM ST-BUS Master Timing Specification . . . . .                               | 85  |
| Table 31 - TDM H.110 Timing Specification . . . . .                                       | 86  |
| Table 32 - TDM H-MVIP Timing Specification . . . . .                                      | 87  |
| Table 33 - TDM - LIU Structured Transmission/Reception . . . . .                          | 88  |
| Table 34 - PAC Timing Specification . . . . .                                             | 89  |
| Table 35 - MII Transmit Timing - 100 Mbps . . . . .                                       | 89  |
| Table 36 - MII Receive Timing - 100 Mbps . . . . .                                        | 91  |
| Table 37 - GMII Transmit Timing - 1000 Mbps . . . . .                                     | 92  |
| Table 38 - GMII Receive Timing - 1000 Mbps . . . . .                                      | 93  |
| Table 39 - TBI Timing - 1000 Mbps . . . . .                                               | 94  |
| Table 40 - MAC Management Timing Specification . . . . .                                  | 95  |
| Table 41 - External Memory Timing . . . . .                                               | 96  |
| Table 42 - CPU Timing Specification . . . . .                                             | 97  |
| Table 43 - System Clock Timing . . . . .                                                  | 100 |
| Table 44 - JTAG Interface Timing . . . . .                                                | 101 |
| Table 45 - Mx_LINKUP_LED Pin Assignments . . . . .                                        | 106 |
| Table 46 - Mx_LINKUP_LED Stuffing Option . . . . .                                        | 108 |

## 1.0 Changes Summary

The following table captures the changes from the March 2009 issue.

| Page | Item     | Change                                       |
|------|----------|----------------------------------------------|
| 1    | MEF logo | Added MEF logo to show MEF 18 certification. |

The following table captures the changes from the January 2009 issue.

| Page    | Item                        | Change                                                                                            |
|---------|-----------------------------|---------------------------------------------------------------------------------------------------|
| 61 & 64 | Section 5.4 and Section 5.8 | Replaced ZLAN-202 with ZL5011x Design Manual section “13.1 Understanding forceDelete”.            |
| 67      | Section 6.3                 | Replaced ZLAN-143 with ZL5011x Design Manual section “3.6 System Clock Block.”                    |
| 69      | Section 7.4                 | Replaced ZLAN-159 with ZL5011x Design Manual section “3.1.1 Connection to LIU”.                   |
| 94      | Section 11.6.5              | Replaced ZLAN-239 with ZL5011x Design Manual section “7.1.3.1 TBI Interface Timing”.              |
| 109     | Section 14.1                | Removed references to IETF PWE3 draft-ietf-l2tpext-l2tp-base and IETF PWE3 draft-ietf-pwe3-cesop. |

The following table captures the changes from the April 2008 issue.

| Page | Item        | Change     |
|------|-------------|------------|
| 68   | Section 7.3 | Add Note 3 |

The following table captures the changes from the October 2006 issue.

| Page                 | Item                   | Change                                                                                          |
|----------------------|------------------------|-------------------------------------------------------------------------------------------------|
| Several              | Include ZL50112 device | Add description for ZL50112                                                                     |
| 1, 2 and 3           | Standard               | Updated IETF RFC number and standards in general                                                |
| 1, 58, 74, 75 and 77 | Stratum 3 DPLL         | Updated the description for Stratum 3 DPLL                                                      |
| 1, 4, 24, 52 and 59  | STS-1 stream           | Remove STS-1 stream                                                                             |
| 14                   | Section 2.0            | Combine the packaged descriptions for all devices                                               |
| 33                   | Section 3.3            | Include more detailed description for the packet interface                                      |
| 49                   | Section 3.7.2          | ZL50112 and ZL50111 share the same JTAG ID                                                      |
| 56                   | Section 4.6            | Change the title of the section                                                                 |
| 57                   | Section 5.0            | Add a note about jumbo packets                                                                  |
| 59                   | Section 5.3            | Include a paragraph to clarify the support for structure and unstructure modes at the same time |
| 61                   | Section 5.4            | Include more detailed description for the Payload Assembly                                      |
| 63                   | Section 5.4.2          | Add a note at the end of the section                                                            |
| 64                   | Section 5.8            | Include more detailed description for the TDM formatter                                         |

| Page | Item                    | Change                                                                                                   |
|------|-------------------------|----------------------------------------------------------------------------------------------------------|
| 65   | Section 6.0             | Include more detailed description for Clock Recovery                                                     |
| 65   | Section 6.1             | Include more detailed description for Differential Clock Recovery                                        |
| 66   | Section 6.2             | Updated the description of Adaptive Clock Recovery                                                       |
| 73   | Section 7.9             | Added sub sections                                                                                       |
| 87   | Table 32                | TDM_HDS Input Setup and TDM_HDS Input Hold, Max. time corrected.                                         |
| 94   | Section 11.6.5          | Updated TXD[9:0] output delay                                                                            |
| 95   | Section 11.6.6          | Updated Section 11.6.6 Management Interface Timing (M_MDIO hold time and Figure 40)                      |
| 97   | Figure 43 and Figure 44 | CPU_TS_ALE and CPU_TA. Added mode details in Figure 43 and Figure 44<br>Added the CPU_TA assertion time. |

The following table captures the changes from the February 2006 issue.

| Page | Item                                        | Change               |
|------|---------------------------------------------|----------------------|
| 96   | Table 41, Table 41 - External Memory Timing | Added Minimum Values |

The following table captures the changes from the April 2005 issue.

| Page   | Item                          | Change                                                                                                       |
|--------|-------------------------------|--------------------------------------------------------------------------------------------------------------|
|        |                               | Clarified ZL50111 supports 3 MII ports, ZL50110/4 support 2 MII ports.                                       |
| 48, 49 | Section 3.6 and Section 3.7.2 | Added external pull-up/pull-down resistor recommendations for SYSTEM_RST, SYSTEM_DEBUG, JTAG_TRST, JTAG_TCK. |
| 67     | Section 6.3                   | Added Section 6.3 SYSTEM_CLK Considerations.                                                                 |

The following table captures the changes from the January 2005 issue.

| Page | Item      | Change                                                                                                                                             |
|------|-----------|----------------------------------------------------------------------------------------------------------------------------------------------------|
|      |           | Clarified data sheet to indicate ZL50110/11/12/14 supports clock recovery in both synchronous and asynchronous modes of operation.                 |
| 99   | Figure 45 | Inverted polarity of CPU_DREQ0 and CPU_DREQ1 to conform with default MPC8260. Polarity of CPU_DREQ and CPU_SDACK remains programmable through API. |
| 99   | Figure 46 | Inverted polarity of CPU_DREQ0 and CPU_DREQ1 to conform with default MPC8260. Polarity of CPU_DREQ and CPU_SDACK remains programmable through API. |

The following table captures the changes from the October 2004 issue.

| Page | Item          | Change                                                |
|------|---------------|-------------------------------------------------------|
| 49   | Section 3.7.1 | Added 5 kohm pulldown recommendation to GPIO signals. |

The following table captures the changes from the September 2004 issue.

| Page       | Item                                                        | Change                                                                                      |
|------------|-------------------------------------------------------------|---------------------------------------------------------------------------------------------|
| 12, 16, 19 | Fig. 2 and Ball Signal Assignment Table                     | Corrected Mx_LINKUP_LED pin assignment.                                                     |
| 73         | DC Electrical Characteristics Table and Output Levels Table | Changed Electrical Characteristics to differentiate between 3.3 V and 5 V tolerant signals. |
| 98         | Section 13.3                                                | New section added; Mx_LINKUP_LED Outputs.                                                   |

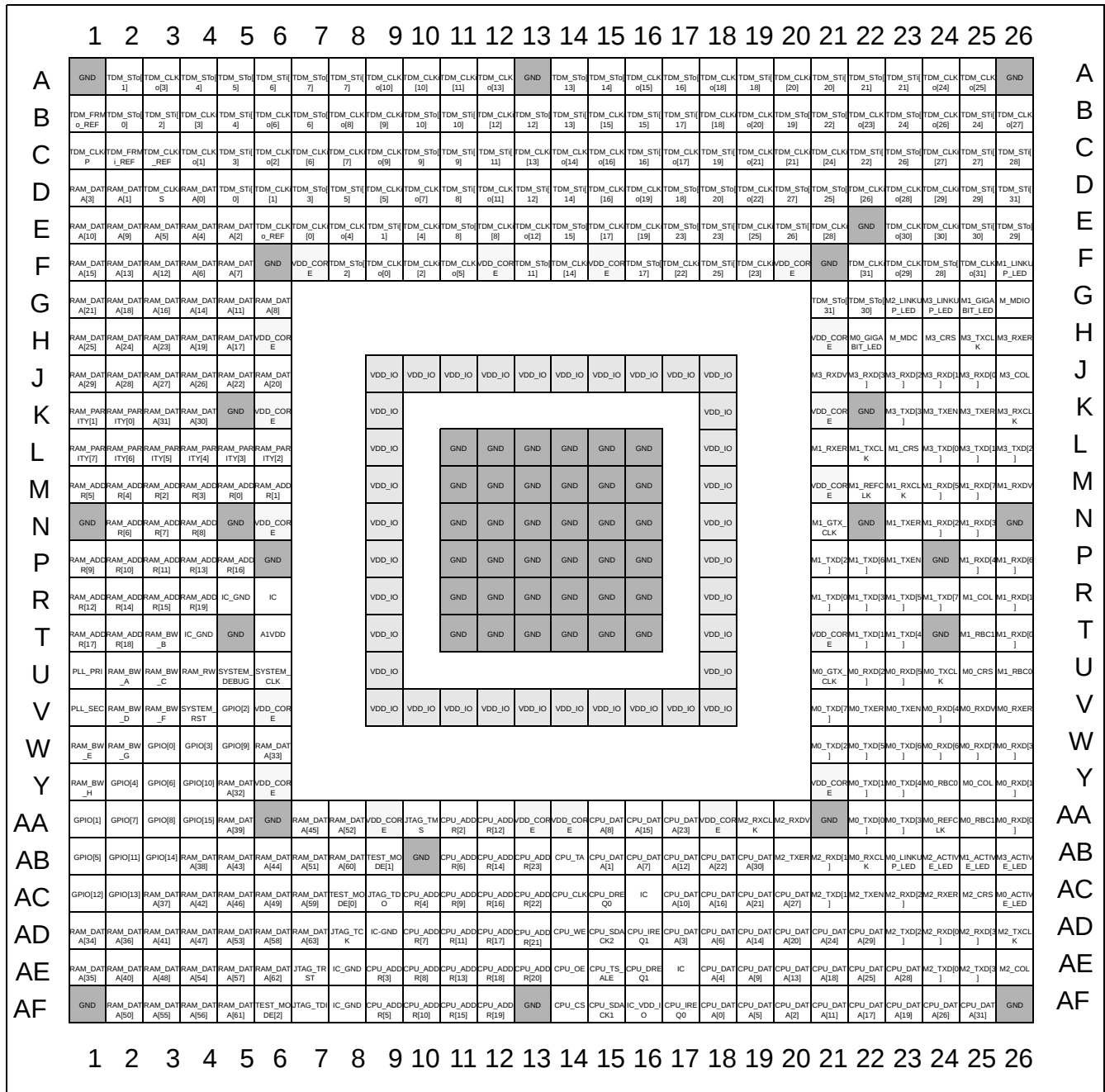
## 2.0 Physical Specification

The ZL50110/11/12/14 is packaged in a PBGA device.

**Features:**

- Body Size: 35 mm x 35 mm (typ)
- Ball Count: 552
- Ball Pitch: 1.27 mm (typ)
- Ball Matrix: 26 x 26
- Ball Diameter: 0.75 mm (typ)
- Total Package Thickness: 2.33 mm (typ)

ZL50111 Package view from TOP side. Note that ball A1 is non-chamfered corner.



### Figure 2 - ZL50111 Package View and Ball Positions

ZL50112 Package view from TOP side. Note that ball A1 is non-chamfered corner.

|    | 1               | 2               | 3               | 4               | 5                | 6               | 7             | 8             | 9             | 10             | 11             | 12            | 13            | 14            | 15            | 16            | 17            | 18            | 19            | 20            | 21            | 22              | 23            | 24            | 25              | 26            |               |   |
|----|-----------------|-----------------|-----------------|-----------------|------------------|-----------------|---------------|---------------|---------------|----------------|----------------|---------------|---------------|---------------|---------------|---------------|---------------|---------------|---------------|---------------|---------------|-----------------|---------------|---------------|-----------------|---------------|---------------|---|
| A  | GND             | TDM_ST0_1       | TDM_CLK_0[3]    | TDM_ST0_4       | TDM_ST0_5        | TDM_ST0_6       | TDM_ST0_7     | TDM_ST0_7     | TDM_CLK_0[10] | TDM_CLK_10[10] | TDM_CLK_11[11] | TDM_CLK_0[13] | GND           | TDM_ST0_13    | TDM_ST0_14    | TDM_CLK_0[15] | N/C           | AUX1_CL_K0[8] | N/C           | N/C           | N/C           | N/C             | N/C           | N/C           | N/C             | N/C           | GND           | A |
| B  | TDM_FRM_0_REF   | TDM_ST0_2       | TDM_CLK_3       | TDM_ST0_4       | TDM_CLK_0[6]     | TDM_CLK_6       | TDM_ST0_8     | TDM_CLK_0[8]  | TDM_CLK_9     | TDM_ST0_10     | TDM_CLK_10     | TDM_ST0_11    | TDM_CLK_12    | TDM_ST0_13    | TDM_CLK_15    | TDM_CLK_15    | N/C           | AUX1_CL_K0[8] | N/C           | N/C           | N/C           | N/C             | N/C           | N/C           | N/C             | N/C           | N/C           | B |
| C  | TDM_CLK_P       | TDM_FRM_1_REF   | TDM_CLK_1       | TDM_ST0_3       | TDM_CLK_0[2]     | TDM_CLK_6       | TDM_CLK_7     | TDM_CLK_0[9]  | TDM_ST0_9     | TDM_CLK_10     | TDM_ST0_11     | TDM_ST0_11    | TDM_CLK_13    | TDM_CLK_0[14] | AUX2_CL_K0[0] | N/C           | AUX2_CL_K0[1] | N/C           | N/C           | N/C           | N/C           | N/C             | N/C           | N/C           | N/C             | N/C           | N/C           | C |
| D  | RAM_DAT_A[3]    | RAM_DAT_A[1]    | TDM_CLK_0       | RAM_DAT_A[0]    | TDM_ST0_1        | TDM_CLK_3       | TDM_ST0_5     | TDM_CLK_5     | TDM_CLK_0[7]  | TDM_ST0_8      | TDM_ST0_11     | TDM_CLK_12    | TDM_ST0_14    | AUX2_CL_K0[0] | AUX1_CL_K0[1] | N/C           | N/C           | N/C           | N/C           | N/C           | N/C           | N/C             | N/C           | N/C           | N/C             | N/C           | N/C           | D |
| E  | RAM_DAT_A[10]   | RAM_DAT_A[9]    | RAM_DAT_A[5]    | RAM_DAT_A[4]    | RAM_DAT_A[2]     | TDM_CLK_0_REF   | TDM_CLK_0[4]  | TDM_ST0_1     | TDM_CLK_4     | TDM_ST0_8      | TDM_CLK_8      | TDM_CLK_0[12] | TDM_ST0_15    | AUX2_CL_K1[1] | AUX1_CL_K1[1] | N/C           | N/C           | N/C           | N/C           | N/C           | GND           | N/C             | N/C           | N/C           | N/C             | N/C           | IC            | E |
| F  | RAM_DAT_A[15]   | RAM_DAT_A[13]   | RAM_DAT_A[12]   | RAM_DAT_A[6]    | RAM_DAT_A[7]     | GND             | VDD_COR_E     | TDM_ST0_2     | TDM_CLK_0[5]  | TDM_CLK_2      | TDM_CLK_0[5]   | VDD_COR_E     | TDM_ST0_11    | TDM_CLK_14    | VDD_COR_E     | N/C           | N/C           | N/C           | N/C           | N/C           | VDD_COR_E     | GND             | N/C           | N/C           | N/C             | IC            | M1_LINK_P_LED | F |
| G  | RAM_DAT_A[21]   | RAM_DAT_A[18]   | RAM_DAT_A[16]   | RAM_DAT_A[14]   | RAM_DAT_A[11]    | RAM_DAT_A[9]    |               |               |               |                |                |               |               |               |               |               |               |               |               |               | IC            | IC              | M2_LINK_P_LED | N/C           | M1_GIGA_BIT_LED | M_MDIO        | G             |   |
| H  | RAM_DAT_A[25]   | RAM_DAT_A[24]   | RAM_DAT_A[23]   | RAM_DAT_A[19]   | RAM_DAT_A[17]    | VDD_COR_E       |               |               |               |                |                |               |               |               |               |               |               |               |               |               | VDD_COR_E     | M0_GIGA_BIT_LED | M_MDC         | N/C           | N/C             | N/C           | H             |   |
| J  | RAM_DAT_A[29]   | RAM_DAT_A[28]   | RAM_DAT_A[27]   | RAM_DAT_A[26]   | RAM_DAT_A[22]    | RAM_DAT_A[20]   |               |               |               |                |                |               |               |               |               |               |               |               |               |               | N/C           | N/C             | N/C           | N/C           | N/C             | N/C           | J             |   |
| K  | RAM_PARR_ITY[1] | RAM_PARR_ITY[0] | RAM_PARR_A[31]  | RAM_PARR_A[30]  | GND              | VDD_COR_E       |               |               |               |                |                |               |               |               |               |               |               |               |               |               | VDD_COR_E     | GND             | N/C           | N/C           | N/C             | N/C           | K             |   |
| L  | RAM_PARR_ITY[7] | RAM_PARR_ITY[6] | RAM_PARR_ITY[5] | RAM_PARR_ITY[4] | RAM_PARR_ITY[3]  | RAM_PARR_ITY[2] |               |               |               |                |                |               |               |               |               |               |               |               |               |               | VDD_COR_E     | M1_RXER_K       | M1_TXCLK_K    | M1_CRS        | N/C             | N/C           | N/C           | L |
| M  | RAM_ADDR_R[5]   | RAM_ADDR_R[4]   | RAM_ADDR_R[3]   | RAM_ADDR_R[0]   | RAM_ADDR_R[1]    |                 |               |               |               |                |                |               |               |               |               |               |               |               |               |               | VDD_COR_E     | M1_REFCLK_K     | M1_RXCLK_K    | M1_RXD[5]     | M1_RXD[4]       | M1_RXD[3]     | M             |   |
| N  | GND             | RAM_ADDR_R[6]   | RAM_ADDR_R[7]   | RAM_ADDR_R[8]   | GND              | VDD_COR_E       |               |               |               |                |                |               |               |               |               |               |               |               |               |               | VDD_COR_E     | M1_GTX_CLK      | GND           | M1_TXER_K     | M1_RXD[2]       | M1_RXD[1]     | GND           | N |
| P  | RAM_ADDR_R[9]   | RAM_ADDR_R[10]  | RAM_ADDR_R[11]  | RAM_ADDR_R[13]  | RAM_ADDR_R[16]   | GND             |               |               |               |                |                |               |               |               |               |               |               |               |               |               | VDD_COR_E     | M1_TXD[3]       | M1_TXD[6]     | M1_TXEN_K     | GND             | M1_RXD[4]     | M1_RXD[5]     | P |
| R  | RAM_ADDR_R[12]  | RAM_ADDR_R[14]  | RAM_ADDR_R[15]  | RAM_ADDR_R[19]  | IC_GND           | IC              |               |               |               |                |                |               |               |               |               |               |               |               |               |               | VDD_COR_E     | M1_TXD[0]       | M1_TXD[3]     | M1_TXD[7]     | M1_COL_K        | M1_RXD[1]     |               | R |
| T  | RAM_ADDR_R[17]  | RAM_ADDR_R[18]  | IC_GND          | IC_GND          | GND              | A1VDD           |               |               |               |                |                |               |               |               |               |               |               |               |               |               | VDD_COR_E     | M1_TXD[1]       | M1_TXD[4]     | GND           | M1_RBCLK_K      | M1_RXD[2]     |               | T |
| U  | PLL_PRI_A       | RAM_BW_C        | RAM_BW_C        | RAM_RW_C        | SYSTEM_DEBUG     | SYSTEM_CLK      |               |               |               |                |                |               |               |               |               |               |               |               |               |               | VDD_COR_E     | M0_GTX_CLK      | M0_RXD[2]     | M0_RXD[3]     | M0_TXCLK_K      | M0_CRS        | M1_RBCLK_K    | U |
| V  | PLL_SEC_D       | RAM_BW_F        | SYSTEM_RST      | GPIO[2]         | VDD_COR_E        |                 |               |               |               |                |                |               |               |               |               |               |               |               |               |               | VDD_COR_E     | M0_TXD[7]       | M0_TXER_K     | M0_TXEN_K     | M0_RXD[4]       | M0_RXD[5]     | M0_RXER_K     | V |
| W  | RAM_BW_E        | RAM_BW_G        | GPIO[3]         | GPIO[3]         | GPIO[9]          | RAM_DAT_A[33]   |               |               |               |                |                |               |               |               |               |               |               |               |               |               | VDD_COR_E     | M0_TXD[2]       | M0_TXD[5]     | M0_TXD[6]     | M0_RXD[1]       | M0_RXD[2]     | M0_RXD[3]     | W |
| Y  | RAM_BW_H        | GPIO[4]         | GPIO[6]         | GPIO[10]        | RAM_DAT_A[32]    | VDD_COR_E       |               |               |               |                |                |               |               |               |               |               |               |               |               |               | VDD_COR_E     | M0_TXD[0]       | M0_TXD[1]     | M0_TXD[4]     | M0_RBCLK_K      | M0_COL_K      | M0_RXD[4]     | Y |
| AA | GPIO[1]         | GPIO[7]         | GPIO[8]         | GPIO[15]        | RAM_DAT_A[39]    | GND             | RAM_DAT_A[45] | RAM_DAT_A[52] | VDD_COR_E     | JTAG_TMS       | CPU_ADD_R[2]   | CPU_ADD_R[12] | VDD_COR_E     | VDD_COR_E     | CPU_DAT_A[8]  | CPU_DAT_A[15] | CPU_DAT_A[23] | VDD_COR_E     | M2_RXCLK_K    | M2_RXD[5]     | GND           | M0_TXD[3]       | M0_TXD[5]     | M0_REFCLK_K   | M0_RBCLK_K      | M0_RXD[5]     | AA            |   |
| AB | GPIO[5]         | GPIO[11]        | GPIO[14]        | RAM_DAT_A[38]   | RAM_DAT_A[43]    | RAM_DAT_A[44]   | RAM_DAT_A[51] | RAM_DAT_A[60] | TEST_MODE[1]  | GND            | CPU_ADD_R[6]   | CPU_ADD_R[14] | CPU_ADD_R[23] | CPU_ADD_R[22] | CPU_TA_A[1]   | CPU_DAT_A[7]  | CPU_DAT_A[12] | CPU_DAT_A[22] | M2_TXER_K     | M2_RXD[3]     | M0_RXCLK_K    | M0_LINK_P_LED   | M2_ACTIVE_LED | M1_ACTIVE_LED | N/C             | AB            |               |   |
| AC | GPIO[12]        | GPIO[13]        | RAM_DAT_A[37]   | RAM_DAT_A[42]   | RAM_DAT_A[46]    | RAM_DAT_A[49]   | RAM_DAT_A[59] | TEST_MODE[5]  | JTAG_TDO      | CPU_ADD_R[4]   | CPU_ADD_R[9]   | CPU_ADD_R[16] | CPU_ADD_R[22] | CPU_CLK_Q0    | CPU_DRE_Q0    | IC_Q0         | CPU_DAT_A[10] | CPU_DAT_A[16] | CPU_DAT_A[21] | CPU_DAT_A[27] | M2_TXD[1]     | M2_TXEN_K       | M2_RXD[1]     | M2_RXER_K     | M2_CRS          | M0_ACTIVE_LED | AC            |   |
| AD | RAM_DAT_A[34]   | RAM_DAT_A[36]   | RAM_DAT_A[41]   | RAM_DAT_A[47]   | RAM_DAT_A[53]    | RAM_DAT_A[58]   | RAM_DAT_A[63] | JTAG_TCK      | IC_GND        | CPU_ADD_R[7]   | CPU_ADD_R[11]  | CPU_ADD_R[17] | CPU_ADD_R[21] | CPU_WE_Q1     | CPU_SDA_Q2    | CPU_I2C_Q1    | CPU_I2C_Q1    | CPU_DAT_A[14] | CPU_DAT_A[20] | CPU_DAT_A[24] | CPU_DAT_A[29] | M2_TXD[2]       | M2_RXD[2]     | M2_RXD[3]     | M2_TXCLK_K      | AD            |               |   |
| AE | RAM_DAT_A[35]   | RAM_DAT_A[40]   | RAM_DAT_A[48]   | RAM_DAT_A[54]   | RAM_DAT_A[57]    | RAM_DAT_A[62]   | JTAG_TRST     | IC_GND        | IC_GND        | CPU_ADD_R[8]   | CPU_ADD_R[13]  | CPU_ADD_R[18] | CPU_ADD_R[20] | CPU_OE_Q1     | CPU_TS_Q1     | CPU_DRE_Q1    | IC_Q1         | CPU_DAT_A[4]  | CPU_DAT_A[13] | CPU_DAT_A[18] | CPU_DAT_A[25] | CPU_DAT_A[28]   | M2_TXD[4]     | M2_TXD[5]     | M2_COL_K        | AE            |               |   |
| AF | GND             | RAM_DAT_A[50]   | RAM_DAT_A[56]   | RAM_DAT_A[61]   | TEST_MOUNT_DE[2] | JTAG_TDI        | IC_GND        | CPU_ADD_R[9]  | CPU_ADD_R[10] | CPU_ADD_R[15]  | CPU_ADD_R[19]  | GND           | CPU_CS_Q1     | CPU_SDA_Q1    | IC_VDD_Q0     | CPU_I2C_Q0    | CPU_I2C_Q0    | CPU_DAT_A[9]  | CPU_DAT_A[15] | CPU_DAT_A[21] | CPU_DAT_A[26] | CPU_DAT_A[31]   | CPU_DAT_A[32] | CPU_DAT_A[33] | GND             | AF            |               |   |
|    | 1               | 2               | 3               | 4               | 5                | 6               | 7             | 8             | 9             | 10             | 11             | 12            | 13            | 14            | 15            | 16            | 17            | 18            | 19            | 20            | 21            | 22              | 23            | 24            | 25              | 26            |               |   |

Figure 3 - ZL50112 Package View and Ball Positions

ZL50110 Package view from TOP side. Note that ball A1 is non-chamfered corner.

|    | 1              | 2              | 3              | 4              | 5              | 6              | 7             | 8             | 9             | 10            | 11            | 12            | 13            | 14          | 15           | 16            | 17            | 18            | 19            | 20            | 21            | 22            | 23              | 24             | 25             | 26              |           |                |    |
|----|----------------|----------------|----------------|----------------|----------------|----------------|---------------|---------------|---------------|---------------|---------------|---------------|---------------|-------------|--------------|---------------|---------------|---------------|---------------|---------------|---------------|---------------|-----------------|----------------|----------------|-----------------|-----------|----------------|----|
| A  | GND            | TDM_ST[1]      | TDM_CL K[3]    | TDM_ST[4]      | TDM_ST[5]      | TDM_ST[6]      | TDM_ST[7]     | TDM_ST[7]     | N/C           | N/C           | N/C           | N/C           | GND           | N/C         | N/C          | N/C           | N/C           | N/C           | N/C           | N/C           | N/C           | N/C           | N/C             | N/C            | N/C            | N/C             | GND       | A              |    |
| B  | TDM_FR Mo REF  | TDM_ST[2]      | TDM_CL K[3]    | TDM_ST[4]      | TDM_ST[5]      | TDM_ST[6]      | TDM_ST[6]     | N/C           | N/C           | N/C           | N/C           | N/C           | N/C           | N/C         | N/C          | N/C           | N/C           | N/C           | N/C           | N/C           | N/C           | N/C           | N/C             | N/C            | N/C            | N/C             | N/C       | B              |    |
| C  | TDM_CL K[0]    | TDM_FR M[0]    | TDM_CL K[1]    | TDM_ST[3]      | TDM_ST[3]      | TDM_ST[3]      | TDM_ST[3]     | N/C           | N/C           | N/C           | N/C           | N/C           | N/C           | N/C         | N/C          | N/C           | N/C           | N/C           | N/C           | N/C           | N/C           | N/C           | N/C             | N/C            | N/C            | N/C             | N/C       | C              |    |
| D  | RAM_DA TA[3]   | RAM_DA TA[1]   | RAM_DA TA[5]   | RAM_DA TA[0]   | TDM_ST[0]      | TDM_ST[0]      | TDM_ST[0]     | TDM_ST[0]     | TDM_ST[0]     | TDM_ST[0]     | TDM_ST[0]     | TDM_ST[0]     | TDM_ST[0]     | TDM_ST[0]   | TDM_ST[0]    | TDM_ST[0]     | TDM_ST[0]     | TDM_ST[0]     | TDM_ST[0]     | TDM_ST[0]     | TDM_ST[0]     | TDM_ST[0]     | TDM_ST[0]       | TDM_ST[0]      | TDM_ST[0]      | TDM_ST[0]       | TDM_ST[0] | D              |    |
| E  | RAM_DA TA[10]  | RAM_DA TA[9]   | RAM_DA TA[5]   | RAM_DA TA[4]   | RAM_DA TA[2]   | TDM_CL K[0]    | TDM_CL K[0]   | TDM_CL K[0]   | TDM_ST[1]     | TDM_ST[1]     | TDM_ST[1]     | TDM_ST[1]     | N/C           | N/C         | N/C          | N/C           | N/C           | N/C           | N/C           | N/C           | N/C           | N/C           | GND             | N/C            | N/C            | N/C             | N/C       | E              |    |
| F  | RAM_DA TA[15]  | RAM_DA TA[13]  | RAM_DA TA[12]  | RAM_DA TA[6]   | RAM_DA TA[7]   | GND            | VDD_CO RE     | TDM_ST[2]     | TDM_ST[2]     | TDM_ST[2]     | TDM_ST[2]     | TDM_ST[2]     | TDM_ST[2]     | TDM_ST[2]   | TDM_ST[2]    | TDM_ST[2]     | TDM_ST[2]     | TDM_ST[2]     | TDM_ST[2]     | TDM_ST[2]     | TDM_ST[2]     | TDM_ST[2]     | GND             | N/C            | N/C            | N/C             | N/C       | N/C            | F  |
| G  | RAM_DA TA[21]  | RAM_DA TA[18]  | RAM_DA TA[16]  | RAM_DA TA[14]  | RAM_DA TA[11]  | RAM_DA TA[8]   |               |               |               |               |               |               |               |             |              |               |               |               |               |               |               | N/C           | N/C             | M1_LINK UP_LED | M1_LINK UP_LED | M1_GIGA BIT_LED | M_MIO     | G              |    |
| H  | RAM_DA TA[25]  | RAM_DA TA[24]  | RAM_DA TA[23]  | RAM_DA TA[19]  | RAM_DA TA[17]  | VDD_CO RE      |               |               |               |               |               |               |               |             |              |               |               |               |               |               |               | VDD_CO RE     | M1_GIGA BIT_LED | M_MDC          | N/C            | N/C             | N/C       | N/C            | H  |
| J  | RAM_DA TA[29]  | RAM_DA TA[28]  | RAM_DA TA[27]  | RAM_DA TA[26]  | RAM_DA TA[22]  | RAM_DA TA[20]  | VDD_IO        | VDD_IO        | VDD_IO        | VDD_IO        | VDD_IO        | VDD_IO        | VDD_IO        | VDD_IO      | VDD_IO       | VDD_IO        | VDD_IO        | VDD_IO        | VDD_IO        | VDD_IO        | VDD_IO        | N/C           | N/C             | N/C            | N/C            | N/C             | N/C       | N/C            | J  |
| K  | RAM_PA RITY[1] | RAM_PA RITY[0] | RAM_PA TA[31]  | RAM_PA TA[30]  | GND            | VDD_CO RE      |               |               |               |               |               |               |               |             |              |               |               |               |               |               |               | VDD_CO RE     | GND             | N/C            | N/C            | N/C             | N/C       | N/C            | K  |
| L  | RAM_PA RITY[7] | RAM_PA RITY[6] | RAM_PA RITY[5] | RAM_PA RITY[4] | RAM_PA RITY[3] | RAM_PA RITY[2] | VDD_IO        |               |               |               |               |               |               |             |              |               |               |               |               |               |               | VDD_IO        | M1_RXE R        | M1_TXCL K      | M1_CRS         | N/C             | N/C       | N/C            | L  |
| M  | RAM_AD DR[5]   | RAM_AD DR[4]   | RAM_AD DR[2]   | RAM_AD DR[3]   | RAM_AD DR[0]   | RAM_AD DR[1]   | VDD_IO        |               |               |               |               |               |               |             |              |               |               |               |               |               |               | VDD_IO        | M1_REF CLK      | M1_RXD[5]      | M1_RXD[7]      | M1_RXD V        | M1_RXD[6] | M              |    |
| N  | GND            | RAM_AD DR[6]   | RAM_AD DR[7]   | RAM_AD DR[8]   | GND            | VDD_CO RE      | VDD_IO        |               |               |               |               |               |               |             |              |               |               |               |               |               |               | VDD_IO        | M1_GTX CLK      | GND            | M1_TXER        | M1_RXD[2]       | M1_RXD[3] | GND            | N  |
| P  | RAM_AD DR[9]   | RAM_AD DR[10]  | RAM_AD DR[11]  | RAM_AD DR[13]  | RAM_AD DR[16]  | GND            | VDD_IO        |               |               |               |               |               |               |             |              |               |               |               |               |               |               | VDD_IO        | M1_TXD[2]       | M1_TXD[4]      | M1_TXEN        | GND             | M1_RXD[6] | M1_RXD[5]      | P  |
| R  | RAM_AD DR[12]  | RAM_AD DR[14]  | RAM_AD DR[15]  | RAM_AD DR[19]  | IC_GND         | IC             | VDD_IO        |               |               |               |               |               |               |             |              |               |               |               |               |               |               | VDD_IO        | M1_TXD[0]       | M1_TXD[3]      | M1_TXD[5]      | M1_TXD[7]       | M1_COL    | M1_RXD[1]      | R  |
| T  | RAM_AD DR[17]  | RAM_AD DR[18]  | RAM_BW _B      | IC_GND         | GND            | A1VDD          | VDD_IO        |               |               |               |               |               |               |             |              |               |               |               |               |               |               | VDD_IO        | VDD_CO RE       | M1_TXD[1]      | M1_TXD[4]      | GND             | M1_RBC[1] | M1_RXD[0]      | T  |
| U  | PLL_PRI _A     | RAM_BW _C      | RAM_BW _D      | RAM_BW _E      | SYSTEM DEBUC   | SYSTEM _CLK    | VDD_IO        |               |               |               |               |               |               |             |              |               |               |               |               |               |               | VDD_IO        | M0_GTX CLK      | M0_RXD[5]      | M0_RXD[7]      | M0_TXCL K       | M0_CRS    | M1_RBC0        | U  |
| V  | PLL_SEC _D     | RAM_BW _F      | SYSTEM _RST    | GPIO[2]        | VDD_CO RE      |                | VDD_IO        | VDD_IO        | VDD_IO        | VDD_IO        | VDD_IO        | VDD_IO        | VDD_IO        | VDD_IO      | VDD_IO       | VDD_IO        | VDD_IO        | VDD_IO        | VDD_IO        | VDD_IO        | VDD_IO        | VDD_IO        | M0_TXD[7]       | M0_TXER        | M0_TXEN        | M0_RXD[4]       | M0_RXD V  | M0_RXE R       | V  |
| W  | RAM_BW _E      | RAM_BW _G      | GPIO[0]        | GPIO[3]        | GPIO[9]        | RAM_DA TA[33]  |               |               |               |               |               |               |               |             |              |               |               |               |               |               |               | M0_TXD[2]     | M0_TXD[5]       | M0_TXD[6]      | M0_RXD[6]      | M0_RXD[7]       | M0_RXD[3] |                | W  |
| Y  | RAM_BW _H      | GPIO[4]        | GPIO[6]        | GPIO[10]       | RAM_DA TA[32]  | VDD_CO RE      |               |               |               |               |               |               |               |             |              |               |               |               |               |               |               | VDD_CO RE     | M0_TXD[3]       | M0_TXD[4]      | M0_RBC0        | M0_COL          | M0_RXD[1] |                | Y  |
| AA | GPIO[1]        | GPIO[7]        | GPIO[8]        | GPIO[15]       | RAM_DA TA[39]  | GND            | RAM_DA TA[45] | RAM_DA TA[52] | VDD_CO RE     | JTAG_TMS      | CPU_AD DR[2]  | CPU_AD DR[12] | VDD_CO RE     | VDD_CO RE   | CPU_DAT A[8] | CPU_DAT A[15] | CPU_DAT A[23] | CPU_DAT A[23] | VDD_CO RE     | N/C           | N/C           | GND           | M0_TXD[0]       | M0_TXD[3]      | M0_REF CLK     | M0_RBC0         | M0_RXD[0] |                | AA |
| AB | GPIO[5]        | GPIO[11]       | GPIO[14]       | RAM_DA TA[38]  | RAM_DA TA[43]  | RAM_DA TA[44]  | RAM_DA TA[51] | RAM_DA TA[56] | TEST_M ODE[1] | GND           | CPU_AD DR[6]  | CPU_AD DR[14] | CPU_AD DR[23] | CPU_TA A[1] | CPU_DAT A[7] | CPU_DAT A[12] | CPU_DAT A[22] | CPU_DAT A[30] | N/C           | N/C           | N/C           | M0_RXCL K     | N/C             | N/C            | N/C            | M1_ACTI VE_LED  | N/C       |                | AB |
| AC | GPIO[12]       | GPIO[13]       | RAM_DA TA[37]  | RAM_DA TA[42]  | RAM_DA TA[46]  | RAM_DA TA[49]  | RAM_DA TA[59] | TEST_M ODE[0] | JTAG_TDO      | CPU_AD DR[4]  | CPU_AD DR[9]  | CPU_AD DR[16] | CPU_AD DR[22] | CPU_CLK     | CPU_DR EQ0   | IC            | CPU_DAT A[10] | CPU_DAT A[16] | CPU_DAT A[21] | CPU_DAT A[27] | N/C           | N/C           | N/C             | N/C            | N/C            | N/C             | N/C       | M0_ACTI VE_LED | AC |
| AD | RAM_DA TA[34]  | RAM_DA TA[36]  | RAM_DA TA[47]  | RAM_DA TA[53]  | RAM_DA TA[58]  | RAM_DA TA[63]  | JTAG_TC K     | IC_GND        | CPU_AD DR[3]  | CPU_AD DR[8]  | CPU_AD DR[17] | CPU_AD DR[21] | CPU_WE ACK2   | CPU_SD ACK2 | CPU_IREQ1    | CPU_DAT A[6]  | CPU_DAT A[14] | CPU_DAT A[20] | CPU_DAT A[24] | CPU_DAT A[29] | N/C           | N/C           | N/C             | N/C            | N/C            | N/C             | N/C       |                | AD |
| AE | RAM_DA TA[35]  | RAM_DA TA[40]  | RAM_DA TA[48]  | RAM_DA TA[54]  | RAM_DA TA[57]  | RAM_DA TA[62]  | JTAG_TR ST    | IC_GND        | CPU_AD DR[9]  | CPU_AD DR[10] | CPU_AD DR[13] | CPU_AD DR[19] | CPU_AD DR[20] | CPU_OE ACK2 | CPU_TS ALE   | CPU_DR EQ1    | IC            | CPU_DAT A[4]  | CPU_DAT A[9]  | CPU_DAT A[13] | CPU_DAT A[18] | CPU_DAT A[25] | CPU_DAT A[28]   | N/C            | N/C            | N/C             | N/C       |                | AE |
| AF | GND            | RAM_DA TA[50]  | RAM_DA TA[55]  | RAM_DA TA[56]  | RAM_DA TA[61]  | TEST_M ODE[2]  | JTAG_TD O     | IC_GND        | CPU_AD DR[5]  | CPU_AD DR[10] | CPU_AD DR[15] | CPU_AD DR[19] | GND           | CPU_CS ACK1 | CPU_SD ACK1  | IC_VDD O      | CPU_IREQ0     | CPU_DAT A[0]  | CPU_DAT A[5]  | CPU_DAT A[21] | CPU_DAT A[22] | CPU_DAT A[11] | CPU_DAT A[17]   | CPU_DAT A[19]  | CPU_DAT A[26]  | CPU_DAT A[31]   | GND       | AF             |    |
|    | 1              | 2              | 3              | 4              | 5              | 6              | 7             | 8             | 9             | 10            | 11            | 12            | 13            | 14          | 15           | 16            | 17            | 18            | 19            | 20            | 21            | 22            | 23              | 24             | 25             | 26              |           |                |    |

Figure 4 - ZL50110 Package View and Ball Positions

ZL50114 Package view from TOP side. Note that ball A1 is non-chamfered corner.

|    | 1                 | 2                 | 3                 | 4                 | 5                 | 6                 | 7                | 8                | 9                | 10               | 11               | 12               | 13               | 14             | 15              | 16               | 17               | 18               | 19               | 20               | 21               | 22                 | 23                | 24                | 25                 | 26                |               |    |
|----|-------------------|-------------------|-------------------|-------------------|-------------------|-------------------|------------------|------------------|------------------|------------------|------------------|------------------|------------------|----------------|-----------------|------------------|------------------|------------------|------------------|------------------|------------------|--------------------|-------------------|-------------------|--------------------|-------------------|---------------|----|
| A  | GND               | TDM_ST0<br>K0[9]  | TDM_CL<br>K0[3]   | N/C               | N/C               | N/C               | N/C              | N/C              | N/C              | N/C              | N/C              | N/C              | GND              | N/C            | N/C             | N/C              | N/C              | N/C              | N/C              | N/C              | N/C              | N/C                | N/C               | N/C               | N/C                | N/C               | GND           | A  |
| B  | TDM_FR<br>M0_REF  | TDM_ST0<br>K0[2]  | TDM_ST0<br>K0[3]  | N/C               | N/C               | N/C               | N/C              | N/C              | N/C              | N/C              | N/C              | N/C              | N/C              | N/C            | N/C             | N/C              | N/C              | N/C              | N/C              | N/C              | N/C              | N/C                | N/C               | N/C               | N/C                | N/C               | N/C           | B  |
| C  | TDM_CL<br>K0[1]   | TDM_FR<br>M0_REF  | TDM_CL<br>K0[1]   | TDM_ST0<br>K0[3]  | TDM_CL<br>K0[2]   | N/C               | N/C              | N/C              | N/C              | N/C              | N/C              | N/C              | N/C              | N/C            | N/C             | N/C              | N/C              | N/C              | N/C              | N/C              | N/C              | N/C                | N/C               | N/C               | N/C                | N/C               | N/C           | C  |
| D  | RAM_DA<br>TA[3]   | RAM_DA<br>TA[1]   | TDM_CL<br>K0[5]   | RAM_DA<br>TA[0]   | TDM_ST0<br>K0[1]  | TDM_CL<br>K0[2]   | N/C              | N/C              | N/C              | N/C              | N/C              | N/C              | N/C              | N/C            | N/C             | N/C              | N/C              | N/C              | N/C              | N/C              | N/C              | N/C                | N/C               | N/C               | N/C                | N/C               | N/C           | D  |
| E  | RAM_DA<br>TA[10]  | RAM_DA<br>TA[9]   | RAM_DA<br>TA[5]   | RAM_DA<br>TA[4]   | RAM_DA<br>TA[2]   | TDM_CL<br>K0_REF  | TDM_ST0<br>K0[0] | N/C              | TDM_ST0<br>K0[1] | N/C              | N/C              | N/C              | N/C              | N/C            | N/C             | N/C              | N/C              | N/C              | N/C              | N/C              | N/C              | N/C                | GND               | N/C               | N/C                | N/C               | N/C           | E  |
| F  | RAM_DA<br>TA[15]  | RAM_DA<br>TA[13]  | RAM_DA<br>TA[12]  | RAM_DA<br>TA[6]   | RAM_DA<br>TA[7]   | GND               | VDD_CO<br>RE     | TDM_ST0<br>K0[2] | TDM_CL<br>K0[0]  | TDM_CL<br>K0[2]  | N/C              | VDD_CO<br>RE     | N/C              | N/C            | VDD_CO<br>RE    | N/C              | N/C              | N/C              | N/C              | N/C              | VDD_CO<br>RE     | GND                | N/C               | N/C               | N/C                | N/C               | N/C           | F  |
| G  | RAM_DA<br>TA[21]  | RAM_DA<br>TA[18]  | RAM_DA<br>TA[16]  | RAM_DA<br>TA[14]  | RAM_DA<br>TA[11]  | RAM_DA<br>TA[9]   |                  |                  |                  |                  |                  |                  |                  |                |                 |                  |                  |                  |                  |                  | N/C              | N/C                | M1_LINK<br>UP_LED | M0_LINK<br>UP_LED | M1_GIGA<br>BIT_LED | M_MDIO            | G             |    |
| H  | RAM_DA<br>TA[25]  | RAM_DA<br>TA[24]  | RAM_DA<br>TA[23]  | RAM_DA<br>TA[19]  | RAM_DA<br>TA[17]  | VDD_CO<br>RE      |                  |                  |                  |                  |                  |                  |                  |                |                 |                  |                  |                  |                  |                  | VDD_CO<br>RE     | M0_GIGA<br>BIT_LED | M_MDC             | N/C               | N/C                | N/C               | N/C           | H  |
| J  | RAM_DA<br>TA[29]  | RAM_DA<br>TA[28]  | RAM_DA<br>TA[27]  | RAM_DA<br>TA[26]  | RAM_DA<br>TA[22]  | RAM_DA<br>TA[20]  |                  |                  |                  |                  |                  |                  |                  |                |                 |                  |                  |                  |                  |                  | N/C              | N/C                | N/C               | N/C               | N/C                | N/C               | N/C           | J  |
| K  | RAM_PA<br>RITY[1] | RAM_PA<br>RITY[0] | RAM_DA<br>TA[31]  | RAM_DA<br>TA[30]  | GND               | VDD_CO<br>RE      |                  |                  |                  |                  |                  |                  |                  |                |                 |                  |                  |                  |                  |                  | VDD_CO<br>RE     | GND                | N/C               | N/C               | N/C                | N/C               | N/C           | K  |
| L  | RAM_PA<br>RITY[7] | RAM_PA<br>RITY[6] | RAM_PA<br>RITY[5] | RAM_PA<br>RITY[4] | RAM_PA<br>RITY[3] | RAM_PA<br>RITY[2] |                  |                  |                  |                  |                  |                  |                  |                |                 |                  |                  |                  |                  |                  | M1_RXE<br>R      | M1_TXCL<br>K       | M1_CRS            | N/C               | N/C                | N/C               | N/C           | L  |
| M  | RAM_AD<br>DR[5]   | RAM_AD<br>DR[4]   | RAM_AD<br>DR[2]   | RAM_AD<br>DR[3]   | RAM_AD<br>DR[0]   | RAM_AD<br>DR[1]   |                  |                  |                  |                  |                  |                  |                  |                |                 |                  |                  |                  |                  |                  | VDD_CO<br>RE     | M1_REF<br>CLK      | M1_RXCL<br>K      | M1_RXD<br>5]      | M1_RXD<br>7]       | M1_RXD<br>V       | M             |    |
| N  | GND               | RAM_AD<br>DR[6]   | RAM_AD<br>DR[7]   | RAM_AD<br>DR[8]   | GND               | VDD_CO<br>RE      |                  |                  |                  |                  |                  |                  |                  |                |                 |                  |                  |                  |                  |                  | M1 GTX<br>CLK    | GND                | M1_TXER<br>CLK    | M1_RXD<br>3]      | M1_RXD<br>3]       | GND               | N             |    |
| P  | RAM_AD<br>DR[9]   | RAM_AD<br>DR[10]  | RAM_AD<br>DR[11]  | RAM_AD<br>DR[13]  | RAM_AD<br>DR[14]  | GND               |                  |                  |                  |                  |                  |                  |                  |                |                 |                  |                  |                  |                  |                  | VDD_CO<br>RE     | M1_TXD<br>2]       | M1_TXD<br>6]      | M1_TXEN           | GND                | M1_RXD<br>4]      | M1_RXD<br>6]  | P  |
| R  | RAM_AD<br>DR[12]  | RAM_AD<br>DR[14]  | RAM_AD<br>DR[15]  | RAM_AD<br>DR[19]  | IC_GND            | IC                |                  |                  |                  |                  |                  |                  |                  |                |                 |                  |                  |                  |                  |                  | VDD_CO<br>RE     | M1_TXD<br>0]       | M1_TXD<br>3]      | M1_TXD<br>5]      | M1_TXD<br>7]       | M1_COL<br>1]      | M1_RXD<br>1]  | R  |
| T  | RAM_AD<br>DR[17]  | RAM_AD<br>DR[18]  | RAM_AD<br>DR[19]  | IC_GND            | GND               | A1VDD             |                  |                  |                  |                  |                  |                  |                  |                |                 |                  |                  |                  |                  |                  | VDD_CO<br>RE     | M1_TXD<br>1]       | M1_TXD<br>4]      | GND               | M1_RBCL<br>1]      | M1_RXD<br>3]      | T             |    |
| U  | PLL_PRI<br>A      | RAM_BW<br>C       | RAM_BW<br>C       | RAM_BW<br>C       | SYSTEM<br>DEBCLK  | SYSTEM<br>CLK     |                  |                  |                  |                  |                  |                  |                  |                |                 |                  |                  |                  |                  |                  | VDD_CO<br>RE     | M0 GTX<br>CLK      | M0_RXD<br>2]      | M0_RXD<br>5]      | M0_K               | M0_CRS            | M1_RBCL<br>1] | U  |
| V  | PLL_SEC<br>D      | RAM_BW<br>F       | RAM_BW<br>F       | SYSTEM<br>RST     | GPIO[2]           | VDD_CO<br>RE      |                  |                  |                  |                  |                  |                  |                  |                |                 |                  |                  |                  |                  |                  | VDD_CO<br>RE     | M0_TXD<br>7]       | M0_TXER<br>CLK    | M0_TXEN           | M0_RXD<br>4]       | M0_RXD<br>V       | M0_RXE<br>R   | V  |
| W  | RAM_BW<br>E       | RAM_BW<br>G       | GPIO[0]           | GPIO[3]           | GPIO[9]           | RAM_DA<br>TA[33]  |                  |                  |                  |                  |                  |                  |                  |                |                 |                  |                  |                  |                  |                  | VDD_CO<br>RE     | M0_TXD<br>2]       | M0_TXD<br>5]      | M0_TXD<br>6]      | M0_RXD<br>6]       | M0_RXD<br>7]      | M0_RXD<br>3]  | W  |
| Y  | RAM_BW<br>H       | GPIO[4]           | GPIO[6]           | GPIO[10]          | RAM_DA<br>TA[32]  | VDD_CO<br>RE      |                  |                  |                  |                  |                  |                  |                  |                |                 |                  |                  |                  |                  |                  | VDD_CO<br>RE     | M0_TXD<br>1]       | M0_TXD<br>4]      | M0_RBCL<br>1]     | M0_COL<br>1]       | M0_RXD<br>1]      | Y             |    |
| AA | GPIO[1]           | GPIO[7]           | GPIO[8]           | GPIO[15]          | RAM_DA<br>TA[39]  | GND               | RAM_DA<br>TA[45] | RAM_DA<br>TA[52] | VDD_CO<br>RE     | JTAG_TM<br>S     | CPU_AD<br>DR[2]  | CPU_AD<br>DR[12] | VDD_CO<br>RE     | VDD_CO<br>RE   | CPU_DAT<br>A[8] | CPU_DAT<br>A[15] | CPU_DAT<br>A[23] | VDD_CO<br>RE     | N/C              | N/C              | GND              | M0_TXD<br>0]       | M0_TXD<br>3]      | M0_REF<br>CLK     | M0_RBCL<br>1]      | M0_RXD<br>0]      | AA            |    |
| AB | GPIO[5]           | GPIO[11]          | GPIO[14]          | RAM_DA<br>TA[38]  | RAM_DA<br>TA[43]  | RAM_DA<br>TA[44]  | RAM_DA<br>TA[51] | RAM_DA<br>TA[60] | TEST_M<br>ODE[1] | GND              | CPU_AD<br>DR[6]  | CPU_AD<br>DR[14] | CPU_AD<br>DR[23] | CPU_TA<br>A[1] | CPU_DAT<br>A[7] | CPU_DAT<br>A[12] | CPU_DAT<br>A[22] | CPU_DAT<br>A[30] | N/C              | N/C              | M0_RXCL<br>K     | N/C                | N/C               | N/C               | M1_ACTI<br>VE_LED  | N/C               | AB            |    |
| AC | GPIO[12]          | GPIO[13]          | RAM_DA<br>TA[37]  | RAM_DA<br>TA[42]  | RAM_DA<br>TA[46]  | RAM_DA<br>TA[49]  | RAM_DA<br>TA[59] | TEST_M<br>ODE[0] | JTAG_TD<br>O     | CPU_AD<br>DR[4]  | CPU_AD<br>DR[9]  | CPU_AD<br>DR[16] | CPU_AD<br>DR[22] | CPU_CLK<br>EQ0 | IC              | CPU_DAT<br>A[10] | CPU_DAT<br>A[16] | CPU_DAT<br>A[21] | CPU_DAT<br>A[27] | N/C              | N/C              | N/C                | N/C               | N/C               | N/C                | M0_ACTI<br>VE_LED | AC            |    |
| AD | RAM_DA<br>TA[34]  | RAM_DA<br>TA[36]  | RAM_DA<br>TA[41]  | RAM_DA<br>TA[47]  | RAM_DA<br>TA[53]  | RAM_DA<br>TA[58]  | RAM_DA<br>TA[63] | JTAG_TC<br>K     | IC_GND           | CPU_AD<br>DR[7]  | CPU_AD<br>DR[11] | CPU_AD<br>DR[17] | CPU_AD<br>DR[21] | CPU_WE<br>ACK2 | CPU_SD<br>Q1    | CPU_IREF<br>A[0] | CPU_DAT<br>A[3]  | CPU_DAT<br>A[6]  | CPU_DAT<br>A[14] | CPU_DAT<br>A[20] | N/C              | N/C                | N/C               | N/C               | N/C                | N/C               | AD            |    |
| AE | RAM_DA<br>TA[35]  | RAM_DA<br>TA[40]  | RAM_DA<br>TA[48]  | RAM_DA<br>TA[54]  | RAM_DA<br>TA[57]  | RAM_DA<br>TA[62]  | JTAG_TR<br>ST    | IC_GND           | CPU_AD<br>DR[3]  | CPU_AD<br>DR[8]  | CPU_AD<br>DR[13] | CPU_AD<br>DR[18] | CPU_AD<br>DR[20] | CPU_OE<br>ACK1 | CPU_TS<br>EQ1   | IC               | CPU_DAT<br>A[4]  | CPU_DAT<br>A[9]  | CPU_DAT<br>A[13] | CPU_DAT<br>A[18] | CPU_DAT<br>A[25] | CPU_DAT<br>A[28]   | N/C               | N/C               | N/C                | N/C               | AE            |    |
| AF | GND               | RAM_DA<br>TA[50]  | RAM_DA<br>TA[55]  | RAM_DA<br>TA[56]  | RAM_DA<br>TA[61]  | TEST_M<br>ODE[2]  | JTAG_TD<br>I     | IC_GND           | CPU_AD<br>DR[5]  | CPU_AD<br>DR[10] | CPU_AD<br>DR[15] | CPU_AD<br>DR[19] | GND              | CPU_CS         | CPU_SD<br>Q0    | IC_VDD<br>Q0     | CPU_IREF<br>A[0] | CPU_DAT<br>A[5]  | CPU_DAT<br>A[21] | CPU_DAT<br>A[31] | CPU_DAT<br>A[32] | CPU_DAT<br>A[33]   | CPU_DAT<br>A[34]  | CPU_DAT<br>A[35]  | CPU_DAT<br>A[36]   | CPU_DAT<br>A[37]  | GND           | AF |
|    | 1                 | 2                 | 3                 | 4                 | 5                 | 6                 | 7                | 8                | 9                | 10               | 11               | 12               | 13               | 14             | 15              | 16               | 17               | 18               | 19               | 20               | 21               | 22                 | 23                | 24                | 25                 | 26                |               |    |

Figure 5 - ZL50114 Package View and Ball Positions

## Ball Signal Assignment

| Ball Number       | Signal Name  |
|-------------------|--------------|
| A1                | GND          |
| A2                | TDM_STo[1]   |
| A3                | TDM_CLKo[3]  |
| A4 <sup>†</sup>   | TDM_STo[4]   |
| A5 <sup>‡</sup>   | TDM_STo[5]   |
| A6 <sup>‡</sup>   | TDM_STi[6]   |
| A7 <sup>‡</sup>   | TDM_STo[7]   |
| A8 <sup>‡</sup>   | TDM_STi[7]   |
| A9 <sup>†</sup>   | TDM_CLKo[10] |
| A10 <sup>†</sup>  | TDM_CLKi[10] |
| A11 <sup>†</sup>  | TDM_CLKi[11] |
| A12 <sup>†</sup>  | TDM_CLKo[13] |
| A13               | GND          |
| A14 <sup>†</sup>  | TDM_STo[13]  |
| A15 <sup>†</sup>  | TDM_STo[14]  |
| A16 <sup>†</sup>  | TDM_CLKo[15] |
| A17 <sup>*</sup>  | TDM_STo[16]  |
| A18 <sup>†*</sup> | TDM_CLKo[18] |
| A19 <sup>*</sup>  | TDM_STi[18]  |
| A20 <sup>*</sup>  | TDM_CLKi[20] |
| A21 <sup>*</sup>  | TDM_STi[20]  |
| A22 <sup>*</sup>  | TDM_STo[21]  |
| A23 <sup>*</sup>  | TDM_STi[21]  |
| A24 <sup>*</sup>  | TDM_CLKo[24] |
| A25 <sup>*</sup>  | TDM_CLKo[25] |
| A26               | GND          |
| B1                | TDM_FRMo_REF |
| B2                | TDM_STo[0]   |
| B3                | TDM_STi[2]   |
| B4                | TDM_CLKi[3]  |
| B5 <sup>‡</sup>   | TDM_STi[4]   |
| B6 <sup>‡</sup>   | TDM_CLKo[6]  |
| B7 <sup>‡</sup>   | TDM_STo[6]   |
| B8 <sup>†</sup>   | TDM_CLKo[8]  |
| B9 <sup>†</sup>   | TDM_CLKi[9]  |
| B10 <sup>†</sup>  | TDM_STo[10]  |
| B11 <sup>†</sup>  | TDM_STi[10]  |

| Ball Number       | Signal Name  |
|-------------------|--------------|
| B12 <sup>†</sup>  | TDM_CLKi[12] |
| B13 <sup>†</sup>  | TDM_STo[12]  |
| B14 <sup>†</sup>  | TDM_STi[13]  |
| B15 <sup>†</sup>  | TDM_CLKi[15] |
| B16 <sup>†</sup>  | TDM_STi[15]  |
| B17 <sup>*</sup>  | TDM_STi[17]  |
| B18 <sup>†*</sup> | TDM_CLKi[18] |
| B19 <sup>*</sup>  | TDM_CLKo[20] |
| B20 <sup>*</sup>  | TDM_STo[19]  |
| B21 <sup>*</sup>  | TDM_STo[22]  |
| B22 <sup>*</sup>  | TDM_CLKo[23] |
| B23 <sup>*</sup>  | TDM_STo[24]  |
| B24 <sup>*</sup>  | TDM_CLKo[26] |
| B25 <sup>*</sup>  | TDM_STi[24]  |
| B26 <sup>*</sup>  | TDM_CLKo[27] |
| C1                | TDM_CLKiP    |
| C2                | TDM_FRMi_REF |
| C3                | TDM_CLKi_REF |
| C4                | TDM_CLKo[1]  |
| C5                | TDM_STi[3]   |
| C6                | TDM_CLKo[2]  |
| C7 <sup>‡</sup>   | TDM_CLKi[6]  |
| C8 <sup>‡</sup>   | TDM_CLKi[7]  |
| C9 <sup>†</sup>   | TDM_CLKo[9]  |
| C10 <sup>†</sup>  | TDM_STo[9]   |
| C11 <sup>†</sup>  | TDM_STi[9]   |
| C12 <sup>†</sup>  | TDM_STi[11]  |
| C13 <sup>†</sup>  | TDM_CLKi[13] |
| C14 <sup>†</sup>  | TDM_CLKo[14] |
| C15 <sup>*</sup>  | TDM_CLKo[16] |
| C16 <sup>*</sup>  | TDM_STi[16]  |
| C17 <sup>*</sup>  | TDM_CLKo[17] |
| C18 <sup>*</sup>  | TDM_STi[19]  |
| C19 <sup>*</sup>  | TDM_CLKo[21] |
| C20 <sup>*</sup>  | TDM_CLKi[21] |
| C21 <sup>*</sup>  | TDM_CLKi[24] |
| C22 <sup>*</sup>  | TDM_STi[22]  |
| C23 <sup>*</sup>  | TDM_STo[26]  |

| Ball Number       | Signal Name  |
|-------------------|--------------|
| C24 <sup>*</sup>  | TDM_CLKi[27] |
| C25 <sup>*</sup>  | TDM_STi[27]  |
| C26 <sup>*</sup>  | TDM_STi[28]  |
| D1                | RAM_DATA[3]  |
| D2                | RAM_DATA[1]  |
| D3                | TDM_CLKiS    |
| D4                | RAM_DATA[0]  |
| D5                | TDM_STi[0]   |
| D6                | TDM_CLKi[1]  |
| D7                | TDM_STo[3]   |
| D8 <sup>‡</sup>   | TDM_STi[5]   |
| D9 <sup>‡</sup>   | TDM_CLKi[5]  |
| D10 <sup>‡</sup>  | TDM_CLKo[7]  |
| D11 <sup>†</sup>  | TDM_STi[8]   |
| D12 <sup>†</sup>  | TDM_CLKo[11] |
| D13 <sup>†</sup>  | TDM_STi[12]  |
| D14 <sup>†</sup>  | TDM_STi[14]  |
| D15 <sup>†*</sup> | TDM_CLKi[16] |
| D16 <sup>†</sup>  | TDM_CLKo[19] |
| D17 <sup>*</sup>  | TDM_STo[18]  |
| D18 <sup>*</sup>  | TDM_STo[20]  |
| D19 <sup>*</sup>  | TDM_CLKo[22] |
| D20 <sup>*</sup>  | TDM_STo[27]  |
| D21 <sup>*</sup>  | TDM_STo[25]  |
| D22 <sup>*</sup>  | TDM_CLKi[26] |
| D23 <sup>*</sup>  | TDM_CLKo[28] |
| D24 <sup>*</sup>  | TDM_CLKi[29] |
| D25 <sup>*</sup>  | TDM_STi[29]  |
| D26 <sup>*</sup>  | TDM_STi[31]  |
| E1                | RAM_DATA[10] |
| E2                | RAM_DATA[9]  |
| E3                | RAM_DATA[5]  |
| E4                | RAM_DATA[4]  |
| E5                | RAM_DATA[2]  |
| E6                | TDM_CLKo_REF |
| E7                | TDM_CLKi[0]  |
| E8 <sup>‡</sup>   | TDM_CLKo[4]  |
| E9                | TDM_STi[1]   |

| Ball Number       | Signal Name  |
|-------------------|--------------|
| E10 <sup>‡</sup>  | TDM_CLKi[4]  |
| E11 <sup>†</sup>  | TDM_STo[8]   |
| E12 <sup>†</sup>  | TDM_CLKi[8]  |
| E13 <sup>†</sup>  | TDM_CLKo[12] |
| E14 <sup>†</sup>  | TDM_STo[15]  |
| E15 <sup>*</sup>  | TDM_CLKi[17] |
| E16 <sup>*</sup>  | TDM_CLKi[19] |
| E17 <sup>*</sup>  | TDM_STo[23]  |
| E18 <sup>*</sup>  | TDM_STi[23]  |
| E19 <sup>*</sup>  | TDM_CLKi[25] |
| E20 <sup>*</sup>  | TDM_STi[26]  |
| E21 <sup>*</sup>  | TDM_CLKi[28] |
| E22               | GND          |
| E23 <sup>*</sup>  | TDM_CLKo[30] |
| E24 <sup>*</sup>  | TDM_CLKi[30] |
| E25 <sup>*</sup>  | TDM_STi[30]  |
| E26 <sup>†*</sup> | TDM_STo[29]  |
| F1                | RAM_DATA[15] |
| F2                | RAM_DATA[13] |
| F3                | RAM_DATA[12] |
| F4                | RAM_DATA[6]  |
| F5                | RAM_DATA[7]  |
| F6                | GND          |
| F7                | VDD_CORE     |
| F8                | TDM_STo[2]   |
| F9                | TDM_CLKo[0]  |
| F10               | TDM_CLKi[2]  |
| F11 <sup>‡</sup>  | TDM_CLKo[5]  |
| F12               | VDD_CORE     |
| F13 <sup>†</sup>  | TDM_STo[11]  |
| F14 <sup>†</sup>  | TDM_CLKi[14] |
| F15               | VDD_CORE     |
| F16 <sup>*</sup>  | TDM_STo[17]  |
| F17 <sup>*</sup>  | TDM_CLKi[22] |
| F18 <sup>*</sup>  | TDM_STi[25]  |
| F19 <sup>*</sup>  | TDM_CLKi[23] |
| F20               | VDD_CORE     |
| F21               | GND          |

| Ball Number      | Signal Name     |
|------------------|-----------------|
| F22 <sup>*</sup> | TDM_CLKi[31]    |
| F23 <sup>*</sup> | TDM_CLKo[29]    |
| F24 <sup>*</sup> | TDM_STo[28]     |
| F25 <sup>*</sup> | TDM_CLKo[31]    |
| F26 <sup>†</sup> | M1_LINKUP_LED   |
| G1               | RAM_DATA[21]    |
| G2               | RAM_DATA[18]    |
| G3               | RAM_DATA[16]    |
| G4               | RAM_DATA[14]    |
| G5               | RAM_DATA[11]    |
| G6               | RAM_DATA[8]     |
| G21 <sup>*</sup> | TDM_STo[31]     |
| G22 <sup>*</sup> | TDM_STo[30]     |
| G23              | M1/2_LINKUP_LED |
| G24              | M0/3_LINKUP_LED |
| G25              | M1_GIGABIT_LED  |
| G26              | M_MDIO          |
| H1               | RAM_DATA[25]    |
| H2               | RAM_DATA[24]    |
| H3               | RAM_DATA[23]    |
| H4               | RAM_DATA[19]    |
| H5               | RAM_DATA[17]    |
| H6               | VDD_CORE        |
| H21              | VDD_CORE        |
| H22              | M0_GIGABIT_LED  |
| H23              | M_MDC           |
| H24 <sup>*</sup> | M3_CRS          |
| H25 <sup>*</sup> | M3_TXCLK        |
| H26 <sup>*</sup> | M3_RXER         |
| J1               | RAM_DATA[29]    |
| J2               | RAM_DATA[28]    |
| J3               | RAM_DATA[27]    |
| J4               | RAM_DATA[26]    |
| J5               | RAM_DATA[22]    |
| J6               | RAM_DATA[20]    |
| J9               | VDD_IO          |
| J10              | VDD_IO          |
| J11              | VDD_IO          |

| Ball Number      | Signal Name   |
|------------------|---------------|
| J12              | VDD_IO        |
| J13              | VDD_IO        |
| J14              | VDD_IO        |
| J15              | VDD_IO        |
| J16              | VDD_IO        |
| J17              | VDD_IO        |
| J18              | VDD_IO        |
| J21 <sup>*</sup> | M3_RXDV       |
| J22 <sup>*</sup> | M3_RXD[3]     |
| J23 <sup>*</sup> | M3_RXD[2]     |
| J24 <sup>*</sup> | M3_RXD[1]     |
| J25 <sup>*</sup> | M3_RXD[0]     |
| J26 <sup>*</sup> | M3_COL        |
| K1               | RAM_PARITY[1] |
| K2               | RAM_PARITY[0] |
| K3               | RAM_DATA[31]  |
| K4               | RAM_DATA[30]  |
| K5               | GND           |
| K6               | VDD_CORE      |
| K9               | VDD_IO        |
| K18              | VDD_IO        |
| K21              | VDD_CORE      |
| K22              | GND           |
| K23 <sup>*</sup> | M3_TXD[3]     |
| K24 <sup>*</sup> | M3_TXEN       |
| K25 <sup>*</sup> | M3_TXER       |
| K26 <sup>*</sup> | M3_RXCLK      |
| L1               | RAM_PARITY[7] |
| L2               | RAM_PARITY[6] |
| L3               | RAM_PARITY[5] |
| L4               | RAM_PARITY[4] |
| L5               | RAM_PARITY[3] |
| L6               | RAM_PARITY[2] |
| L9               | VDD_IO        |
| L11              | GND           |
| L12              | GND           |
| L13              | GND           |
| L14              | GND           |

| Ball Number | Signal Name |
|-------------|-------------|
| L15         | GND         |
| L16         | GND         |
| L18         | VDD_IO      |
| L21         | M1_RXER     |
| L22         | M1_TXCLK    |
| L23         | M1_CRS      |
| L24*        | M3_TXD[0]   |
| L25*        | M3_TXD[1]   |
| L26*        | M3_TXD[2]   |
| M1          | RAM_ADDR[5] |
| M2          | RAM_ADDR[4] |
| M3          | RAM_ADDR[2] |
| M4          | RAM_ADDR[3] |
| M5          | RAM_ADDR[0] |
| M6          | RAM_ADDR[1] |
| M9          | VDD_IO      |
| M11         | GND         |
| M12         | GND         |
| M13         | GND         |
| M14         | GND         |
| M15         | GND         |
| M16         | GND         |
| M18         | VDD_IO      |
| M21         | VDD_CORE    |
| M22         | M1_REFCLK   |
| M23         | M1_RXCLK    |
| M24         | M1_RXD[5]   |
| M25         | M1_RXD[7]   |
| M26         | M1_RXDV     |
| N1          | GND         |
| N2          | RAM_ADDR[6] |
| N3          | RAM_ADDR[7] |
| N4          | RAM_ADDR[8] |
| N5          | GND         |
| N6          | VDD_CORE    |
| N9          | VDD_IO      |
| N11         | GND         |
| N12         | GND         |

| Ball Number | Signal Name  |
|-------------|--------------|
| N13         | GND          |
| N14         | GND          |
| N15         | GND          |
| N16         | GND          |
| N18         | VDD_IO       |
| N21         | M1_GTX_CLK   |
| N22         | GND          |
| N23         | M1_TXER      |
| N24         | M1_RXD[2]    |
| N25         | M1_RXD[3]    |
| N26         | GND          |
| P1          | RAM_ADDR[9]  |
| P2          | RAM_ADDR[10] |
| P3          | RAM_ADDR[11] |
| P4          | RAM_ADDR[13] |
| P5          | RAM_ADDR[16] |
| P6          | GND          |
| P9          | VDD_IO       |
| P11         | GND          |
| P12         | GND          |
| P13         | GND          |
| P14         | GND          |
| P15         | GND          |
| P16         | GND          |
| P18         | VDD_IO       |
| P21         | M1_TXD[2]    |
| P22         | M1_TXD[6]    |
| P23         | M1_TXEN      |
| P24         | GND          |
| P25         | M1_RXD[4]    |
| P26         | M1_RXD[6]    |
| R1          | RAM_ADDR[12] |
| R2          | RAM_ADDR[14] |
| R3          | RAM_ADDR[15] |
| R4          | RAM_ADDR[19] |
| R5          | IC_GND       |
| R6          | IC           |
| R9          | VDD_IO       |

| Ball Number | Signal Name  |
|-------------|--------------|
| R11         | GND          |
| R12         | GND          |
| R13         | GND          |
| R14         | GND          |
| R15         | GND          |
| R16         | GND          |
| R18         | VDD_IO       |
| R21         | M1_TXD[0]    |
| R22         | M1_TXD[3]    |
| R23         | M1_TXD[5]    |
| R24         | M1_TXD[7]    |
| R25         | M1_COL       |
| R26         | M1_RXD[1]    |
| T1          | RAM_ADDR[17] |
| T2          | RAM_ADDR[18] |
| T3          | RAM_BW_B     |
| T4          | IC_GND       |
| T5          | GND          |
| T6          | A1VDD        |
| T9          | VDD_IO       |
| T11         | GND          |
| T12         | GND          |
| T13         | GND          |
| T14         | GND          |
| T15         | GND          |
| T16         | GND          |
| T18         | VDD_IO       |
| T21         | VDD_CORE     |
| T22         | M1_TXD[1]    |
| T23         | M1_TXD[4]    |
| T24         | GND          |
| T25         | M1_RBC1      |
| T26         | M1_RXD[0]    |
| U1          | PLL_PRI      |
| U2          | RAM_BW_A     |
| U3          | RAM_BW_C     |
| U4          | RAM_RW       |
| U5          | SYSTEM_DEBUG |

| Ball Number | Signal Name  |
|-------------|--------------|
| U6          | SYSTEM_CLK   |
| U9          | VDD_IO       |
| U18         | VDD_IO       |
| U21         | M0_GTX_CLK   |
| U22         | M0_RXD[2]    |
| U23         | M0_RXD[5]    |
| U24         | M0_TXCLK     |
| U25         | M0_CRS       |
| U26         | M1_RBC0      |
| V1          | PLL_SEC      |
| V2          | RAM_BW_D     |
| V3          | RAM_BW_F     |
| V4          | SYSTEM_RST   |
| V5          | GPIO[2]      |
| V6          | VDD_CORE     |
| V9          | VDD_IO       |
| V10         | VDD_IO       |
| V11         | VDD_IO       |
| V12         | VDD_IO       |
| V13         | VDD_IO       |
| V14         | VDD_IO       |
| V15         | VDD_IO       |
| V16         | VDD_IO       |
| V17         | VDD_IO       |
| V18         | VDD_IO       |
| V21         | M0_TXD[7]    |
| V22         | M0_TXER      |
| V23         | M0_TXEN      |
| V24         | M0_RXD[4]    |
| V25         | M0_RXDV      |
| V26         | M0_RXER      |
| W1          | RAM_BW_E     |
| W2          | RAM_BW_G     |
| W3          | GPIO[0]      |
| W4          | GPIO[3]      |
| W5          | GPIO[9]      |
| W6          | RAM_DATA[33] |
| W21         | M0_TXD[2]    |

| Ball Number       | Signal Name  |
|-------------------|--------------|
| W22               | M0_TXD[5]    |
| W23               | M0_TXD[6]    |
| W24               | M0_RXD[6]    |
| W25               | M0_RXD[7]    |
| W26               | M0_RXD[3]    |
| Y1                | RAM_BW_H     |
| Y2                | GPIO[4]      |
| Y3                | GPIO[6]      |
| Y4                | GPIO[10]     |
| Y5                | RAM_DATA[32] |
| Y6                | VDD_CORE     |
| Y21               | VDD_CORE     |
| Y22               | M0_TXD[1]    |
| Y23               | M0_TXD[4]    |
| Y24               | M0_RBC0      |
| Y25               | M0_COL       |
| Y26               | M0_RXD[1]    |
| AA1               | GPIO[1]      |
| AA2               | GPIO[7]      |
| AA3               | GPIO[8]      |
| AA4               | GPIO[15]     |
| AA5               | RAM_DATA[39] |
| AA6               | GND          |
| AA7               | RAM_DATA[45] |
| AA8               | RAM_DATA[52] |
| AA9               | VDD_CORE     |
| AA10              | JTAG_TMS     |
| AA11              | CPU_ADDR[2]  |
| AA12              | CPU_ADDR[12] |
| AA13              | VDD_CORE     |
| AA14              | VDD_CORE     |
| AA15              | CPU_DATA[8]  |
| AA16              | CPU_DATA[15] |
| AA17              | CPU_DATA[23] |
| AA18              | VDD_CORE     |
| AA19 <sup>†</sup> | M2_RXCLK     |
| AA20 <sup>†</sup> | M2_RXDV      |
| AA21              | GND          |

| Ball Number       | Signal Name   |
|-------------------|---------------|
| AA22              | M0_TXD[0]     |
| AA23              | M0_TXD[3]     |
| AA24              | M0_REFCLK     |
| AA25              | M0_RBC1       |
| AA26              | M0_RXD[0]     |
| AB1               | GPIO[5]       |
| AB2               | GPIO[11]      |
| AB3               | GPIO[14]      |
| AB4               | RAM_DATA[38]  |
| AB5               | RAM_DATA[43]  |
| AB6               | RAM_DATA[44]  |
| AB7               | RAM_DATA[51]  |
| AB8               | RAM_DATA[60]  |
| AB9               | TEST_MODE[1]  |
| AB10              | GND           |
| AB11              | CPU_ADDR[6]   |
| AB12              | CPU_ADDR[14]  |
| AB13              | CPU_ADDR[23]  |
| AB14              | CPU_TA        |
| AB15              | CPU_DATA[1]   |
| AB16              | CPU_DATA[7]   |
| AB17              | CPU_DATA[12]  |
| AB18              | CPU_DATA[22]  |
| AB19              | CPU_DATA[30]  |
| AB20 <sup>†</sup> | M2_TXER       |
| AB21 <sup>†</sup> | M2_RXD[1]     |
| AB22              | M0_RXCLK      |
| AB23 <sup>†</sup> | M0_LINKUP_LED |
| AB24 <sup>†</sup> | M2_ACTIVE_LED |
| AB25              | M1_ACTIVE_LED |
| AB26 <sup>*</sup> | M3_ACTIVE_LED |
| AC1               | GPIO[12]      |
| AC2               | GPIO[13]      |
| AC3               | RAM_DATA[37]  |
| AC4               | RAM_DATA[42]  |
| AC5               | RAM_DATA[46]  |
| AC6               | RAM_DATA[49]  |
| AC7               | RAM_DATA[59]  |

| Ball Number       | Signal Name   |
|-------------------|---------------|
| AC8               | TEST_MODE[0]  |
| AC9               | JTAG_TDO      |
| AC10              | CPU_ADDR[4]   |
| AC11              | CPU_ADDR[9]   |
| AC12              | CPU_ADDR[16]  |
| AC13              | CPU_ADDR[22]  |
| AC14              | CPU_CLK       |
| AC15              | CPU_DREQ0     |
| AC16              | IC            |
| AC17              | CPU_DATA[10]  |
| AC18              | CPU_DATA[16]  |
| AC19              | CPU_DATA[21]  |
| AC20              | CPU_DATA[27]  |
| AC21 <sup>†</sup> | M2_TXD[1]     |
| AC22 <sup>†</sup> | M2_TXEN       |
| AC23 <sup>†</sup> | M2_RXD[2]     |
| AC24 <sup>†</sup> | M2_RXER       |
| AC25 <sup>†</sup> | M2_CRS        |
| AC26              | M0_ACTIVE_LED |
| AD1               | RAM_DATA[34]  |
| AD2               | RAM_DATA[36]  |
| AD3               | RAM_DATA[41]  |
| AD4               | RAM_DATA[47]  |
| AD5               | RAM_DATA[53]  |
| AD6               | RAM_DATA[58]  |
| AD7               | RAM_DATA[63]  |
| AD8               | JTAG_TCK      |
| AD9               | IC_GND        |
| AD10              | CPU_ADDR[7]   |
| AD11              | CPU_ADDR[11]  |
| AD12              | CPU_ADDR[17]  |
| AD13              | CPU_ADDR[21]  |
| AD14              | CPU_WE        |
| AD15              | CPU_SDACK2    |
| AD16              | CPU_IREQ1     |
| AD17              | CPU_DATA[3]   |
| AD18              | CPU_DATA[6]   |
| AD19              | CPU_DATA[14]  |

| Ball Number       | Signal Name  |
|-------------------|--------------|
| AD20              | CPU_DATA[20] |
| AD21              | CPU_DATA[24] |
| AD22              | CPU_DATA[29] |
| AD23 <sup>†</sup> | M2_TXD[2]    |
| AD24 <sup>†</sup> | M2_RXD[0]    |
| AD25 <sup>†</sup> | M2_RXD[3]    |
| AD26 <sup>†</sup> | M2_TXCLK     |
| AE1               | RAM_DATA[35] |
| AE2               | RAM_DATA[40] |
| AE3               | RAM_DATA[48] |
| AE4               | RAM_DATA[54] |
| AE5               | RAM_DATA[57] |
| AE6               | RAM_DATA[62] |
| AE7               | JTAG_TRST    |
| AE8               | IC_GND       |
| AE9               | CPU_ADDR[3]  |
| AE10              | CPU_ADDR[8]  |
| AE11              | CPU_ADDR[13] |
| AE12              | CPU_ADDR[18] |
| AE13              | CPU_ADDR[20] |
| AE14              | CPU_OE       |
| AE15              | CPU_TS_ALE   |
| AE16              | CPU_DREQ1    |
| AE17              | IC           |
| AE18              | CPU_DATA[4]  |
| AE19              | CPU_DATA[9]  |
| AE20              | CPU_DATA[13] |
| AE21              | CPU_DATA[18] |
| AE22              | CPU_DATA[25] |
| AE23              | CPU_DATA[28] |
| AE24 <sup>†</sup> | M2_TXD[0]    |
| AE25 <sup>†</sup> | M2_TXD[3]    |
| AE26 <sup>†</sup> | M2_COL       |
| AF1               | GND          |
| AF2               | RAM_DATA[50] |
| AF3               | RAM_DATA[55] |
| AF4               | RAM_DATA[56] |
| AF5               | RAM_DATA[61] |

| Ball Number | Signal Name  |
|-------------|--------------|
| AF6         | TEST_MODE[2] |
| AF7         | JTAG_TDI     |
| AF8         | IC_GND       |
| AF9         | CPU_ADDR[5]  |
| AF10        | CPU_ADDR[10] |
| AF11        | CPU_ADDR[15] |
| AF12        | CPU_ADDR[19] |
| AF13        | GND          |
| AF14        | CPU_CS       |
| AF15        | CPU_SDACK1   |
| AF16        | IC_VDD_IO    |
| AF17        | CPU_IREQ0    |
| AF18        | CPU_DATA[0]  |
| AF19        | CPU_DATA[5]  |
| AF20        | CPU_DATA[2]  |
| AF21        | CPU_DATA[11] |
| AF22        | CPU_DATA[17] |
| AF23        | CPU_DATA[19] |
| AF24        | CPU_DATA[26] |
| AF25        | CPU_DATA[31] |
| AF26        | GND          |

\* Not connected on ZL50112, ZL50110 and ZL50114 - leave open circuit.

† Not Connected on ZL50110 and ZL50114 - leave open circuit.

‡ Not Connected on ZL50114 - leave open circuit.

N/C - Not Connected - leave open circuit.

\* Internally Connected on ZL50112 - leave open circuit.

IC - Internally Connected - leave open circuit.

IC\_GND - tie to ground

IC\_VDD\_IO - tie to VDD\_IO

### 3.0 External Interface Description

The following key applies to all tables:

|   |                                                    |
|---|----------------------------------------------------|
| I | Input                                              |
| O | Output                                             |
| D | Internal 100 k $\Omega$ pull-down resistor present |
| U | Internal 100 k $\Omega$ pull-up resistor present   |
| T | Tri-state Output                                   |

#### 3.1 TDM Interface

All TDM Interface signals are 5 V tolerant.

All TDM Interface inputs (including data, clock and frame pulse) have internal pull-down resistors so they can be safely left unconnected if not used.

##### 3.1.1 ZL50111 Variant TDM Stream Connection

| Signal        | I/O | Package Balls |     |      |     | Description                                                                                                                                                                                                                                                                                                                                                                                         |
|---------------|-----|---------------|-----|------|-----|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TDM_STi[31:0] | I D | [31]          | D26 | [15] | B16 | TDM port serial data input streams. For different standards these pins are given different identities:<br>ST-BUS: TDM_STi[31:0]<br>H.110: TDM_D[31:0]<br>H-MVIP: TDM_HDS[31:0]<br>Triggered on rising edge or falling edge depending on standard. At 8.192 Mbps only streams [7:0] are used, with 128 channels per stream. Streams [7:0] are used for J2, and streams [1:0] are used for T3 and E3. |
|               |     | [30]          | E25 | [14] | D14 |                                                                                                                                                                                                                                                                                                                                                                                                     |
|               |     | [29]          | D25 | [13] | B14 |                                                                                                                                                                                                                                                                                                                                                                                                     |
|               |     | [28]          | C26 | [12] | D13 |                                                                                                                                                                                                                                                                                                                                                                                                     |
|               |     | [27]          | C25 | [11] | C12 |                                                                                                                                                                                                                                                                                                                                                                                                     |
|               |     | [26]          | E20 | [10] | B11 |                                                                                                                                                                                                                                                                                                                                                                                                     |
|               |     | [25]          | F18 | [9]  | C11 |                                                                                                                                                                                                                                                                                                                                                                                                     |
|               |     | [24]          | B25 | [8]  | D11 |                                                                                                                                                                                                                                                                                                                                                                                                     |
|               |     | [23]          | E18 | [7]  | A8  |                                                                                                                                                                                                                                                                                                                                                                                                     |
|               |     | [22]          | C22 | [6]  | A6  |                                                                                                                                                                                                                                                                                                                                                                                                     |
|               |     | [21]          | A23 | [5]  | D8  |                                                                                                                                                                                                                                                                                                                                                                                                     |
|               |     | [20]          | A21 | [4]  | B5  |                                                                                                                                                                                                                                                                                                                                                                                                     |
|               |     | [19]          | C18 | [3]  | C5  |                                                                                                                                                                                                                                                                                                                                                                                                     |
|               |     | [18]          | A19 | [2]  | B3  |                                                                                                                                                                                                                                                                                                                                                                                                     |
|               |     | [17]          | B17 | [1]  | E9  |                                                                                                                                                                                                                                                                                                                                                                                                     |
|               |     | [16]          | C16 | [0]  | D5  |                                                                                                                                                                                                                                                                                                                                                                                                     |

**Table 2 - TDM Interface ZL50111 Stream Pin Definition**

| Signal         | I/O | Package Balls |     |      |     | Description                                                                                                                                                                                                                                                                                                                                                                                          |
|----------------|-----|---------------|-----|------|-----|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TDM_STo[31:0]  | OT  | [31]          | G21 | [15] | E14 | TDM port serial data output streams. For different standards these pins are given different identities:<br>ST-BUS: TDM_STo[31:0]<br>H.110: TDM_D[31:0]<br>H-MVIP: TDM_HDS[31:0]<br>Triggered on rising edge or falling edge depending on standard. At 8.192 Mbps only streams [7:0] are used, with 128 channels per stream. Streams [7:0] are used for J2, and streams [1:0] are used for T3 and E3. |
|                |     | [30]          | G22 | [14] | A15 |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [29]          | E26 | [13] | A14 |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [28]          | F24 | [12] | B13 |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [27]          | D20 | [11] | F13 |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [26]          | C23 | [10] | B10 |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [25]          | D21 | [9]  | C10 |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [24]          | B23 | [8]  | E11 |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [23]          | E17 | [7]  | A7  |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [22]          | B21 | [6]  | B7  |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [21]          | A22 | [5]  | A5  |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [20]          | D18 | [4]  | A4  |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [19]          | B20 | [3]  | D7  |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [18]          | D17 | [2]  | F8  |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [17]          | F16 | [1]  | A2  |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [16]          | A17 | [0]  | B2  |                                                                                                                                                                                                                                                                                                                                                                                                      |
| TDM_CLKi[31:0] | I D | [31]          | F22 | [15] | B15 | TDM port clock inputs. Programmable as active high or low. Can accept frequencies of 1.544 MHz, 2.048 MHz, 4.096 MHz, 6.312 MHz, 8.192 MHz, 16.384 MHz, 34.368 MHz or 44.736 MHz depending on standard used. At 8.192 Mbps only streams [7:0] are used. Streams [7:0] are used for J2, and streams [1:0] are used for T3 and E3.                                                                     |
|                |     | [30]          | E24 | [14] | F14 |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [29]          | D24 | [13] | C13 |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [28]          | E21 | [12] | B12 |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [27]          | C24 | [11] | A11 |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [26]          | D22 | [10] | A10 |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [25]          | E19 | [9]  | B9  |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [24]          | C21 | [8]  | E12 |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [23]          | F19 | [7]  | C8  |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [22]          | F17 | [6]  | C7  |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [21]          | C20 | [5]  | D9  |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [20]          | A20 | [4]  | E10 |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [19]          | E16 | [3]  | B4  |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [18]          | B18 | [2]  | F10 |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [17]          | E15 | [1]  | D6  |                                                                                                                                                                                                                                                                                                                                                                                                      |
|                |     | [16]          | D15 | [0]  | E7  |                                                                                                                                                                                                                                                                                                                                                                                                      |

Table 2 - TDM Interface ZL50111 Stream Pin Definition (continued)

| Signal         | I/O | Package Balls |     |      |     | Description                                                                                                                                                                                                                                                                       |
|----------------|-----|---------------|-----|------|-----|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TDM_CLKo[31:0] | O   | [31]          | F25 | [15] | A16 | TDM port clock outputs. Will generate 1.544 MHz, 2.048 MHz, 4.096 MHz, 6.312 MHz, 8.192 MHz, 16.384 MHz, 34.368 MHz or 44.736 MHz depending on standard used. At 8.192 Mbps only streams [7:0] are used. Streams [7:0] are used for J2, and streams [1:0] are used for T3 and E3. |
|                |     | [30]          | E23 | [14] | C14 |                                                                                                                                                                                                                                                                                   |
|                |     | [29]          | F23 | [13] | A12 |                                                                                                                                                                                                                                                                                   |
|                |     | [28]          | D23 | [12] | E13 |                                                                                                                                                                                                                                                                                   |
|                |     | [27]          | B26 | [11] | D12 |                                                                                                                                                                                                                                                                                   |
|                |     | [26]          | B24 | [10] | A9  |                                                                                                                                                                                                                                                                                   |
|                |     | [25]          | A25 | [9]  | C9  |                                                                                                                                                                                                                                                                                   |
|                |     | [24]          | A24 | [8]  | B8  |                                                                                                                                                                                                                                                                                   |
|                |     | [23]          | B22 | [7]  | D10 |                                                                                                                                                                                                                                                                                   |
|                |     | [22]          | D19 | [6]  | B6  |                                                                                                                                                                                                                                                                                   |
|                |     | [21]          | C19 | [5]  | F11 |                                                                                                                                                                                                                                                                                   |
|                |     | [20]          | B19 | [4]  | E8  |                                                                                                                                                                                                                                                                                   |
|                |     | [19]          | D16 | [3]  | A3  |                                                                                                                                                                                                                                                                                   |
|                |     | [18]          | A18 | [2]  | C6  |                                                                                                                                                                                                                                                                                   |
|                |     | [17]          | C17 | [1]  | C4  |                                                                                                                                                                                                                                                                                   |
|                |     | [16]          | C15 | [0]  | F9  |                                                                                                                                                                                                                                                                                   |

**Table 2 - TDM Interface ZL50111 Stream Pin Definition (continued)**

Note: Speed modes:

2.048 Mbps - all 32 streams active (bits [31:0]), with 32 channels per stream - 1024 total channels.

8.192 Mbps - 8 streams active (bits [7:0]), with 128 channels per stream - 1024 total channels.

J2 - 8 streams active (bits [7:0]), with 98 channels per stream - 784 total channels.

E3 - 2 streams active (bits [1:0]), with 537 channels per stream - 1074 total channels.

T3 - 2 streams active (bits [1:0]), with 699 channels per stream - 1398 total channels.

Note: All TDM Interface inputs (including data, clock and frame pulse) have internal pull-down resistors so they can be safely left unconnected if not used.

### 3.1.2 ZL50112 Variant TDM Stream Connection

| Signal        | I/O | Package Balls |  |      |     | Description                                                                                                                                                                                                                                                                                                                                               |
|---------------|-----|---------------|--|------|-----|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TDM_STi[15:0] | I D |               |  | [15] | B16 | TDM port serial data input streams. For different standards these pins are given different identities:<br>ST-BUS: TDM_STi[15:0]<br>H.110: TDM_D[15:0]<br>H-MVIP: TDM_HDS[15:0]<br>Triggered on rising edge or falling edge depending on standard. At 8.192 Mbps only streams [3:0] are used, with 128 channels per stream. Streams [3:0] are used for J2. |
|               |     |               |  | [14] | D14 |                                                                                                                                                                                                                                                                                                                                                           |
|               |     |               |  | [13] | B14 |                                                                                                                                                                                                                                                                                                                                                           |
|               |     |               |  | [12] | D13 |                                                                                                                                                                                                                                                                                                                                                           |
|               |     |               |  | [11] | C12 |                                                                                                                                                                                                                                                                                                                                                           |
|               |     |               |  | [10] | B11 |                                                                                                                                                                                                                                                                                                                                                           |
|               |     |               |  | [9]  | C11 |                                                                                                                                                                                                                                                                                                                                                           |
|               |     |               |  | [8]  | D11 |                                                                                                                                                                                                                                                                                                                                                           |
|               |     |               |  | [7]  | A8  |                                                                                                                                                                                                                                                                                                                                                           |
|               |     |               |  | [6]  | A6  |                                                                                                                                                                                                                                                                                                                                                           |
|               |     |               |  | [5]  | D8  |                                                                                                                                                                                                                                                                                                                                                           |
|               |     |               |  | [4]  | B5  |                                                                                                                                                                                                                                                                                                                                                           |
|               |     |               |  | [3]  | C5  |                                                                                                                                                                                                                                                                                                                                                           |
|               |     |               |  | [2]  | B3  |                                                                                                                                                                                                                                                                                                                                                           |
|               |     |               |  | [1]  | E9  |                                                                                                                                                                                                                                                                                                                                                           |
|               |     |               |  | [0]  | D5  |                                                                                                                                                                                                                                                                                                                                                           |

**Table 3 - TDM Interface ZL50112 Stream Pin Definition**

| Signal         | I/O | Package Balls                                                                                                                                                               | Description                                                                                                                                                                                                                                                                                                                                                |
|----------------|-----|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TDM_STo[15:0]  | OT  | [15] E14<br>[14] A15<br>[13] A14<br>[12] B13<br>[11] F13<br>[10] B10<br>[9] C10<br>[8] E11<br>[7] A7<br>[6] B7<br>[5] A5<br>[4] A4<br>[3] D7<br>[2] F8<br>[1] A2<br>[0] B2  | TDM port serial data output streams. For different standards these pins are given different identities:<br>ST-BUS: TDM_STo[15:0]<br>H.110: TDM_D[15:0]<br>H-MVIP: TDM_HDS[15:0]<br>Triggered on rising edge or falling edge depending on standard. At 8.192 Mbps only streams [3:0] are used, with 128 channels per stream. Streams [3:0] are used for J2. |
| TDM_CLKi[15:0] | I D | [15] B15<br>[14] F14<br>[13] C13<br>[12] B12<br>[11] A11<br>[10] A10<br>[9] B9<br>[8] E12<br>[7] C8<br>[6] C7<br>[5] D9<br>[4] E10<br>[3] B4<br>[2] F10<br>[1] D6<br>[0] E7 | TDM port clock inputs. Programmable as active high or low. Can accept frequencies of 1.544 MHz, 2.048 MHz, 4.096 MHz, 6.312 MHz, 8.192 MHz, 16.384 MHz, 34.368 MHz or 44.736 MHz depending on standard used. At 8.192 Mbps only streams [3:0] are used. Streams [3:0] are used for J2.                                                                     |

Table 3 - TDM Interface ZL50112 Stream Pin Definition (continued)

| Signal         | I/O | Package Balls                                                                                                                                                             | Description                                                                                                                                                                                                   |
|----------------|-----|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TDM_CLKo[15:0] | O   | [15] A16<br>[14] C14<br>[13] A12<br>[12] E13<br>[11] D12<br>[10] A9<br>[9] C9<br>[8] B8<br>[7] D10<br>[6] B6<br>[5] F11<br>[4] E8<br>[3] A3<br>[2] C6<br>[1] C4<br>[0] F9 | TDM port clock outputs. Will generate 1.544 MHz, 2.048 MHz, 4.096 MHz, 6.312 MHz, 8.192 MHz, 16.384 MHz depending on standard used. At 8.192 Mbps only streams [3:0] are used. Streams [3:0] are used for J2. |

**Table 3 - TDM Interface ZL50112 Stream Pin Definition (continued)**

Note: Speed modes:

2.048 Mbps - all 16 streams active (bits [15:0]), with 32 channels per stream - 512 total channels.

8.192 Mbps - 4 streams active (bits [3:0]), with 128 channels per stream - 512 total channels.

J2 - 4 streams active (bits [3:0]), with 98 channels per stream - 392 total channels.

Note: All TDM Interface inputs (including data, clock and frame pulse) have internal pull-down resistors so they can be safely left unconnected if not used.

### 3.1.3 ZL50110 Variant TDM Stream Connection

| Signal        | I/O | Package Balls                                        |                                                | Description                                                                                                                                                                                                                                                                                                               |
|---------------|-----|------------------------------------------------------|------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TDM_STi[7:0]  | I D | [7]<br>[6]<br>[5]<br>[4]<br>[3]<br>[2]<br>[1]<br>[0] | A8<br>A6<br>D8<br>B5<br>C5<br>B3<br>E9<br>D5   | TDM port serial data input streams. For different standards these pins are given different identities:<br>ST-BUS: TDM_STi[7:0]<br>H.110: TDM_D[7:0]<br>H-MVIP: TDM_HDS[7:0]<br>Triggered on rising edge or falling edge depending on standard. At 8.192 Mbps only streams [1:0] are used. Streams [1:0] are used for J2.  |
| TDM_STo[7:0]  | OT  | [7]<br>[6]<br>[5]<br>[4]<br>[3]<br>[2]<br>[1]<br>[0] | A7<br>B7<br>A5<br>A4<br>D7<br>F8<br>A2<br>B2   | TDM port serial data output streams. For different standards these pins are given different identities:<br>ST-BUS: TDM_STo[7:0]<br>H.110: TDM_D[7:0]<br>H-MVIP: TDM_HDS[7:0]<br>Triggered on rising edge or falling edge depending on standard. At 8.192 Mbps only streams [1:0] are used. Streams [1:0] are used for J2. |
| TDM_CLKi[7:0] | I D | [7]<br>[6]<br>[5]<br>[4]<br>[3]<br>[2]<br>[1]<br>[0] | C8<br>C7<br>D9<br>E10<br>B4<br>F10<br>D6<br>E7 | TDM port clock inputs programmable as active high or low. Can accept frequencies of 1.544 MHz, 2.048 MHz, 4.096 MHz, 8.192 MHz, 6.312 MHz or 16.384 MHz depending on standard used. At 8.192 Mbps only streams [1:0] are used. Streams [1:0] are used for J2.                                                             |
| TDM_CLKo[7:0] | O   | [7]<br>[6]<br>[5]<br>[4]<br>[3]<br>[2]<br>[1]<br>[0] | D10<br>B6<br>F11<br>E8<br>A3<br>C6<br>C4<br>F9 | TDM port clock outputs. Will generate 1.544 MHz, 2.048 MHz, 4.096 MHz, 6.312 MHz, 8.192 MHz or 16.384 MHz depending on standard used. At 8.192 Mbps only streams [1:0] are used. Streams [1:0] are used for J2.                                                                                                           |

**Table 4 - TDM Interface ZL50110 Stream Pin Definition**

Note: Speed modes:

2.048 Mbps - all 8 streams active (bits [7:0]), with 32 channels per stream - 256 total channels.

8.192 Mbps - 2 streams active (bits [1:0]), with 128 channels per stream - 256 total channels.

J2 - 2 streams active (bits [1:0]), with 98 channels per stream - 196 total channels.

Note: All TDM Interface inputs (including data, clock and frame pulse) have internal pull-down resistors so they can be safely left unconnected if not used.

### 3.1.4 ZL50114 Variant TDM Stream Connection

| Signal        | I/O | Package Balls                         | Description                                                                                                                                                                                                                                                                                                               |
|---------------|-----|---------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TDM_STi[3:0]  | I D | [3] C5<br>[2] B3<br>[1] E9<br>[0] D5  | TDM port serial data input streams. For different standards these pins are given different identities:<br>ST-BUS: TDM_STi[3:0]<br>H.110: TDM_D[3:0]<br>H-MVIP: TDM_HDS[3:0]<br>Triggered on rising edge or falling edge depending on standard. At 8.192 Mbps only streams [1:0] are used. Streams [1:0] are used for J2.  |
| TDM_STo[3:0]  | OT  | [3] D7<br>[2] F8<br>[1] A2<br>[0] B2  | TDM port serial data output streams. For different standards these pins are given different identities:<br>ST-BUS: TDM_STo[3:0]<br>H.110: TDM_D[3:0]<br>H-MVIP: TDM_HDS[3:0]<br>Triggered on rising edge or falling edge depending on standard. At 8.192 Mbps only streams [1:0] are used. Streams [1:0] are used for J2. |
| TDM_CLKi[3:0] | I D | [3] B4<br>[2] F10<br>[1] D6<br>[0] E7 | TDM port clock inputs programmable as active high or low. Can accept frequencies of 1.544 MHz, 2.048 MHz, 4.096 MHz, 8.192 MHz, 6.312 MHz or 16.384 MHz depending on standard used. At 8.192 Mbps only streams [1:0] are used. Streams [1:0] are used for J2.                                                             |
| TDM_CLKo[3:0] | O   | [3] A3<br>[2] C6<br>[1] C4<br>[0] F9  | TDM port clock outputs. Will generate 1.544 MHz, 2.048 MHz, 4.096 MHz, 6.312 MHz, 8.192 MHz or 16.384 MHz depending on standard used. At 8.192 Mbps only streams [1:0] are used. Streams [1:0] are used for J2.                                                                                                           |

**Table 5 - TDM Interface ZL50114 Stream Pin Definition**

Note: Speed modes:

2.048 Mbps - all 4 streams active (bits [3:0]), with 32 channels per stream - 128 total channels.

8.192 Mbps - 2 streams active (bits [1:0]), with 128 channels per stream - 256 total channels.

J2 - 2 streams active (bits [1:0]), with 98 channels per stream - 196 total channels.

Note: All TDM Interface inputs (including data, clock and frame pulse) have internal pull-down resistors so they can be safely left unconnected if not used.

**3.1.5 TDM Signals Common to ZL50110, ZL50111, ZL50112 and ZL50114**

| Signal       | I/O | Package Balls | Description                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|--------------|-----|---------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TDM_CLKi_REF | I D | C3            | TDM port reference clock input for backplane operation                                                                                                                                                                                                                                                                                                                                                                                                    |
| TDM_CLKo_REF | O   | E6            | TDM port reference clock output for backplane operation                                                                                                                                                                                                                                                                                                                                                                                                   |
| TDM_FRMi_REF | I D | C2            | <p>TDM port reference frame input. For different standards this pin is given a different identity:</p> <p>ST-BUS: TDM_F0i</p> <p>H.110: TDM_FRAME</p> <p>H-MVIP: TDM_F0</p> <p>Signal is normally active low, but can be active high depending on standard. Indicates the start of a TDM frame by pulsing every 125 <math>\mu</math>s. Normally will straddle rising edge or falling edge of clock pulse, depending on standard and clock frequency.</p>  |
| TDM_FRMo_REF | O   | B1            | <p>TDM port reference frame output. For different standards this pin is given a different identity:</p> <p>ST-BUS: TDM_F0o</p> <p>H.110: TDM_FRAME</p> <p>H-MVIP: TDM_F0</p> <p>Signal is normally active low, but can be active high depending on standard. Indicates the start of a TDM frame by pulsing every 125 <math>\mu</math>s. Normally will straddle rising edge or falling edge of clock pulse, depending on standard and clock frequency.</p> |

**Table 6 - TDM Interface Common Pin Definition**

### 3.2 PAC Interface

All PAC Interface signals are 5 V tolerant

All PAC Interface outputs are high impedance while System Reset is LOW.

| Signal    | I/O | Package Balls | Description                                                                                                                                                                                                                                                                                                                                           |
|-----------|-----|---------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TDM_CLKiP | I D | C1            | Primary reference clock input. Should be driven by external clock source to provide locking reference to internal / optional external DPLL in TDM master mode. Also provides PRS clock for RTP timestamps in synchronous modes.<br>Acceptable frequency range: 8 kHz - 34.368 MHz (generally should be between 10 MHz and 25 MHz as per ITU-T Y.1413. |
| TDM_CLKiS | I D | D3            | Secondary reference clock input. Backup external reference for automatic switch-over in case of failure of TDM_CLKiP source.                                                                                                                                                                                                                          |
| PLL_PRI   | OT  | U1            | Primary reference output to optional external DPLL.<br>Multiplexed & frequency divided reference output for support of optional external DPLL.<br>Expected frequency range:<br>8 kHz - 16.384 MHz.                                                                                                                                                    |
| PLL_SEC   | OT  | V1            | Secondary reference output to optional external DPLL Multiplexed & frequency divided reference output for support of optional external DPLL.<br>Expected frequency range:<br>8 kHz - 16.384 MHz.                                                                                                                                                      |

**Table 7 - PAC Interface Package Ball Definition**

### 3.3 Packet Interfaces

For the ZL50111 and ZL50112 variants the packet interface is capable of either 3 MII interfaces, 2 redundant GMII interfaces or 2 redundant TBI (1000 Mbps) interfaces. The TBI interface is a PCS interface supported by an integrated 1000BASE-X PCS module. The ZL50110 and ZL50114 variants have either 2 MII interfaces, 2 redundant GMII interfaces or 2 redundant TBI (1000 Mbps) interfaces. When the packet interface is programmed for PCS/TBI mode, by default the hardware will not enable auto-negotiation. The TBI auto-negotiation must be done by application software. Ports 2 and 3 are not available on the ZL50110 and ZL50114 devices.

**NOTE:** In GMII/TBI mode only 1 GMAC port may be used to receive data. The second GMAC port is for redundancy purposes only.

Data for all three types of packet switching is based on Specification IEEE Std. 802.3 - 2000. The table below highlights the valid Ethernet interface combinations:

| MII Port 0                                                                     | MII Port 1 | MII Port 2* | MII Port 3** |
|--------------------------------------------------------------------------------|------------|-------------|--------------|
| GE                                                                             | GE***      | --          | --           |
| GE                                                                             | --         | FE          | --           |
| GE                                                                             | --         | --          | FE           |
| FE                                                                             | FE         | --          | --           |
| FE                                                                             | FE         | FE          | --           |
| FE                                                                             | FE         | --          | FE           |
| Note 1: *ZL50111/112 only<br>Note 2: **ZL50111 only<br>Note 3: ***Standby only |            |             |              |

**Note:** Port 2 and Port 3 can not be used to receive data simultaneously, they are mutually exclusive for packet reception. They may both be used for packet transmission if required.

The ZL50110/11/12/14 will not take action when receiving a PAUSE frame. It will not pause the transmission of traffic. It is normally not required to stop CESoP traffic because it is generally constant bit rate and time sensitive. If necessary, the limiting of egress non-CESoP traffic may be done external to the ZL50110/11/12/14 (e.g. in an Ethernet switch).

Table 8 maps the signal pins used in the MII interface to those used in the GMII and TBI interface. Table 9 shows MII Management Interface Package Ball Definition. Table 10, Table 11, Table 12, and Table 13 show respectively the MII Port 0, Port 1, Port 2 and Port 3 Interface Package Ball Definition.

All Packet Interface signals are 5 V tolerant, and all outputs are high impedance while System Reset is LOW.

| MII           | GMII           | TBI (PCS)      |
|---------------|----------------|----------------|
| Mn_LINKUP_LED | Mn_LINKUP_LED  | Mn_LINKUP_LED  |
| Mn_ACTIVE_LED | Mn_ACTIVE_LED  | Mn_ACTIVE_LED  |
| -             | Mn_GIGABIT_LED | Mn_GIGABIT_LED |
| -             | Mn_REFCLK      | Mn_REFCLK      |
| Mn_RXCLK      | Mn_RXCLK       | Mn_RBC0        |

**Table 8 - Packet Interface Signal Mapping - MII to GMII/TBI**

| MII         | GMII        | TBI (PCS)        |
|-------------|-------------|------------------|
| Mn_COL      | Mn_COL      | Mn_RBC1          |
| Mn_RXD[3:0] | Mn_RXD[7:0] | Mn_RXD[7:0]      |
| Mn_RXDV     | Mn_RXDV     | Mn_RXD[8]        |
| Mn_RXER     | Mn_RXER     | Mn_RXD[9]        |
| Mn_CRS      | Mn_CRS      | Mn_Signal_Detect |
| Mn_TXCLK    | -           | -                |
| Mn_TXD[3:0] | Mn_TXD[7:0] | Mn_TXD[7:0]      |
| Mn_TXEN     | Mn_TXEN     | Mn_TXD[8]        |
| Mn_TXER     | Mn_TXER     | Mn_TXD[9]        |
| -           | Mn_GTX_CLK  | Mn_GTX_CLK       |

**Table 8 - Packet Interface Signal Mapping - MII to GMII/TBI**

Note: Mn can be either M0, M1, M2, or M3 for ZL50111 and ZL50112 variants; and M0 or M1 for ZL50110 variant.

| Signal | I/O       | Package Balls | Description                                                                                                                                                                                                                |
|--------|-----------|---------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| M_MDC  | O         | H23           | MII management data clock. Common for all four MII ports. It has a minimum period of 400 ns (maximum freq. 2.5 MHz), and is independent of the TXCLK and RXCLK.                                                            |
| M_MDIO | ID/<br>OT | G26           | MII management data I/O. Common for all four MII ports at up to 2.5 MHz. It is bi-directional between the ZL50110/11/12/14 and the Ethernet station management entity. Data is passed synchronously with respect to M_MDC. |

**Table 9 - MII Management Interface Package Ball Definition**

| MII Port 0     |     |                                       |                                                                                                                                                                                                                                                                                                                        |
|----------------|-----|---------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Signal         | I/O | Package Balls                         | Description                                                                                                                                                                                                                                                                                                            |
| M0_LINKUP_LED  | O   | G24 on ZL50110/4<br>AB23 on ZL50111/2 | LED drive for MAC 0 to indicate port is linked up.<br>Logic 0 output = LED on<br>Logic 1 output = LED off                                                                                                                                                                                                              |
| M0_ACTIVE_LED  | O   | AC26                                  | LED drive for MAC 0 to indicate port is transmitting or receiving packet data.<br>Logic 0 output = LED on<br>Logic 1 output = LED off                                                                                                                                                                                  |
| M0_GIGABIT_LED | O   | H22                                   | LED drive for MAC 0 to indicate operation at Gbps<br>Logic 0 output = LED on<br>Logic 1 output = LED off                                                                                                                                                                                                               |
| M0_REFCLK      | I D | AA24                                  | <b>GMII/TBI</b> - Reference Clock input at 125 MHz. Can be used to lock receive circuitry (RX) to M0_GTXCLK rather than recovering the RXCLK (or RBC0 and RBC1). Useful, for example, in the absence of valid serial data.<br><b>NOTE:</b> In <b>MII</b> mode this pin must be driven with the same clock as M0_RXCLK. |
| M0_RXCLK       | I U | AB22                                  | GMII/MII - M0_RXCLK.<br>Accepts the following frequencies:<br>25.0 MHz     MII 100 Mbps<br>125.0 MHz    GMII 1 Gbps                                                                                                                                                                                                    |
| M0_RBC0        | I U | Y24                                   | TBI - M0_RBC0.<br>Used as a clock when in TBI mode. Accepts 62.5 MHz, and is 180° out of phase with M0_RBC1. Receive data is clocked at each rising edge of M1_RBC1 and M1_RBC0, resulting in 125 MHz sample rate.                                                                                                     |
| M0_RBC1        | I U | AA25                                  | TBI - M0_RBC1<br>Used as a clock when in TBI mode. Accepts 62.5 MHz, and is 180° out of phase with M0_RBC0. Receive data is clocked at each rising edge of M0_RBC1 and M0_RBC0, resulting in 125 MHz sample rate.                                                                                                      |

Table 10 - MII Port 0 Interface Package Ball Definition

| MII Port 0                   |     |               |     |     |      |                                                                                                                                                                                                                                                                                                                                        |
|------------------------------|-----|---------------|-----|-----|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Signal                       | I/O | Package Balls |     |     |      | Description                                                                                                                                                                                                                                                                                                                            |
| M0_COL                       | I D | Y25           |     |     |      | GMII/MII - M0_COL.<br>Collision Detection. This signal is independent of M0_TXCLK and M0_RXCLK, and is asserted when a collision is detected on an attempted transmission. It is active high, and only specified for half-duplex operation.                                                                                            |
| M0_RXD[7:0]                  | I U | [7]           | W25 | [3] | W26  | Receive Data. Only half the bus (bits [3:0]) are used in MII mode. Clocked on rising edge of M0_RXCLK (GMII/MII) or the rising edges of M0_RBC0 and M0_RBC1 (TBI).                                                                                                                                                                     |
|                              |     | [6]           | W24 | [2] | U22  |                                                                                                                                                                                                                                                                                                                                        |
|                              |     | [5]           | U23 | [1] | Y26  |                                                                                                                                                                                                                                                                                                                                        |
|                              |     | [4]           | V24 | [0] | AA26 |                                                                                                                                                                                                                                                                                                                                        |
| M0_RXDV /<br>M0_RXD[8]       | I D | V25           |     |     |      | GMII/MII - M0_RXDV<br>Receive Data Valid. Active high. This signal is clocked on the rising edge of M0_RXCLK. It is asserted when valid data is on the M0_RXD bus.<br>TBI - M0_RXD[8]<br>Receive Data. Clocked on the rising edges of M0_RBC0 and M0_RBC1.                                                                             |
| M0_RXER /<br>M0_RXD[9]       | I D | V26           |     |     |      | GMII/MII - M0_RXER<br>Receive Error. Active high signal indicating an error has been detected. Normally valid when M0_RXDV is asserted. Can be used in conjunction with M0_RXD when M0_RXDV signal is de-asserted to indicate a False Carrier.<br>TBI - M0_RXD[9]<br>Receive Data. Clocked on the rising edges of M0_RBC0 and M0_RBC1. |
| M0_CRS /<br>M0_Signal_Detect | I D | U25           |     |     |      | GMII/MII - M0_CRS<br>Carrier Sense. This asynchronous signal is asserted when either the transmission or reception device is non-idle. It is active high.<br>TBI - M0_Signal Detect<br>Similar function to M0_CRS.                                                                                                                     |
| M0_TXCLK                     | I U | U24           |     |     |      | <b>MII only</b> - Transmit Clock<br>Accepts the following frequencies:<br>25.0 MHz    MII    100 Mbps                                                                                                                                                                                                                                  |
| M0_TXD[7:0]                  | O   | [7]           | V21 | [3] | AA23 | Transmit Data. Only half the bus (bits [3:0]) are used in MII mode. Clocked on rising edge of M0_TXCLK (MII) or the rising edge of M0_GTXCLK (GMII/TBI).                                                                                                                                                                               |
|                              |     | [6]           | W23 | [2] | W21  |                                                                                                                                                                                                                                                                                                                                        |
|                              |     | [5]           | W22 | [1] | Y22  |                                                                                                                                                                                                                                                                                                                                        |
|                              |     | [4]           | Y23 | [0] | AA22 |                                                                                                                                                                                                                                                                                                                                        |

Table 10 - MII Port 0 Interface Package Ball Definition (continued)

| MII Port 0             |     |               |                                                                                                                                                                                                                                                                                                                            |
|------------------------|-----|---------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Signal                 | I/O | Package Balls | Description                                                                                                                                                                                                                                                                                                                |
| M0_TXEN /<br>M0_TXD[8] | O   | V23           | GMII/MII - M0_TXEN<br>Transmit Enable. Asserted when the MAC has data to transmit, synchronously to M0_TXCLK with the first pre-amble of the packet to be sent. Remains asserted until the end of the packet transmission. Active high.<br>TBI - M0_TXD[8]<br>Transmit Data. Clocked on rising edge of M0_GTXCLK.          |
| M0_TXER /<br>M0_TXD[9] | O   | V22           | GMII/MII - M0_TXER<br>Transmit Error. Transmitted synchronously with respect to M0_TXCLK, and active high. When asserted (with M0_TXEN also asserted) the ZL50110/11/12/14 will transmit a non-valid symbol, somewhere in the transmitted frame.<br>TBI - M0_TXD[9]<br>Transmit Data. Clocked on rising edge of M0_GTXCLK. |
| M0_GTX_CLK             | O   | U21           | <b>GMII/TBI only</b> - Gigabit Transmit Clock<br>Output of a clock for Gigabit operation at 125 MHz.                                                                                                                                                                                                                       |

Table 10 - MII Port 0 Interface Package Ball Definition (continued)

| MII Port 1     |     |                                      |                                                                                                                                                                                                                                                                                                                        |
|----------------|-----|--------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Signal         | I/O | Package Balls                        | Description                                                                                                                                                                                                                                                                                                            |
| M1_LINKUP_LED  | O   | G23 on ZL50110/4<br>F26 on ZL50111/2 | LED drive for MAC 1 to indicate port is linked up.<br>Logic 0 output = LED on<br>Logic 1 output = LED off                                                                                                                                                                                                              |
| M1_ACTIVE_LED  | O   | AB25                                 | LED drive for MAC 1 to indicate port is transmitting or receiving packet data.<br>Logic 0 output = LED on<br>Logic 1 output = LED off                                                                                                                                                                                  |
| M1_GIGABIT_LED | O   | G25                                  | LED drive for MAC 1 to indicate operation at Gbps.<br>Logic 0 output = LED on<br>Logic 1 output = LED off                                                                                                                                                                                                              |
| M1_REFCLK      | I D | M22                                  | <b>GMII/TBI</b> - Reference Clock input at 125 MHz. Can be used to lock receive circuitry (RX) to M1_GTXCLK rather than recovering the RXCLK (or RBC0 and RBC1). Useful, for example, in the absence of valid serial data.<br><b>NOTE:</b> In <b>MII</b> mode this pin must be driven with the same clock as M1_RXCLK. |
| M1_RXCLK       | I U | M23                                  | GMII/MII - M1_RXCLK.<br>Accepts the following frequencies:<br>25.0 MHz     MII   100 Mbps<br>125.0 MHz    GMII 1 Gbps                                                                                                                                                                                                  |
| M1_RBC0        | I U | U26                                  | TBI - M1_RBC0.<br>Used as a clock when in TBI mode. Accepts 62.5 MHz and is 180° out of phase with M1_RBC1. Receive data is clocked at each rising edge of M1_RBC1 and M1_RBC0, resulting in 125 MHz sample rate.                                                                                                      |
| M1_RBC1        | I U | T25                                  | TBI - M1_RBC1<br>Used as a clock when in TBI mode. Accepts 62.5 MHz, and is 180° out of phase with M1_RBC0. Receive data is clocked at each rising edge of M1_RBC1 and M1_RBC0, resulting in 125 MHz sample rate.                                                                                                      |
| M1_COL         | I D | R25                                  | GMII/MII - M1_COL.<br>Collision Detection. This signal is independent of M1_TXCLK and M1_RXCLK, and is asserted when a collision is detected on an attempted transmission. It is active high, and only specified for half-duplex operation.                                                                            |

Table 11 - MII Port 1 Interface Package Ball Definition

| MII Port 1                   |     |               |     |     |     |                                                                                                                                                                                                                                                                                                                                        |
|------------------------------|-----|---------------|-----|-----|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Signal                       | I/O | Package Balls |     |     |     | Description                                                                                                                                                                                                                                                                                                                            |
| M1_RXD[7:0]                  | I U | [7]           | M25 | [3] | N25 | Receive Data. Only half the bus (bits [3:0]) are used in MII mode. Clocked on rising edge of M1_RXCLK (GMII/MII) or the rising edges of M1_RBC0 and M1_RBC1 (TBI).                                                                                                                                                                     |
|                              |     | [6]           | P26 | [2] | N24 |                                                                                                                                                                                                                                                                                                                                        |
|                              |     | [5]           | M24 | [1] | R26 |                                                                                                                                                                                                                                                                                                                                        |
|                              |     | [4]           | P25 | [0] | T26 |                                                                                                                                                                                                                                                                                                                                        |
| M1_RXDV /<br>M1_RXD[8]       | I D | M26           |     |     |     | GMII/MII - M1_RXDV<br>Receive Data Valid. Active high. This signal is clocked on the rising edge of M1_RXCLK. It is asserted when valid data is on the M1_RXD bus.<br>TBI - M1_RXD[8]<br>Receive Data. Clocked on the rising edges of M1_RBC0 and M1_RBC1.                                                                             |
| M1_RXER /<br>M1_RXD[9]       | I D | L21           |     |     |     | GMII/MII - M1_RXER<br>Receive Error. Active high signal indicating an error has been detected. Normally valid when M1_RXDV is asserted. Can be used in conjunction with M1_RXD when M1_RXDV signal is de-asserted to indicate a False Carrier.<br>TBI - M1_RXD[9]<br>Receive Data. Clocked on the rising edges of M1_RBC0 and M1_RBC1. |
| M1_CRS /<br>M1_Signal_Detect | I D | L23           |     |     |     | GMII/MII - M1_CRS<br>Carrier Sense. This asynchronous signal is asserted when either the transmission or reception device is non-idle. It is active high.<br>TBI - M1_Signal Detect<br>Similar function to M1_CRS.                                                                                                                     |
| M1_TXCLK                     | I U | L22           |     |     |     | <b>MII only</b> - Transmit Clock<br>Accepts the following frequencies:<br>25.0 MHz    MII    100 Mbps                                                                                                                                                                                                                                  |
| M1_TXD[7:0]                  | O   | [7]           | R24 | [3] | R22 | Transmit Data. Only half the bus (bits [3:0]) are used in MII mode. Clocked on rising edge of M1_TXCLK (MII) or the rising edge of M1_GTXCLK (GMII/TBI).                                                                                                                                                                               |
|                              |     | [6]           | P22 | [2] | P21 |                                                                                                                                                                                                                                                                                                                                        |
|                              |     | [5]           | R23 | [1] | T22 |                                                                                                                                                                                                                                                                                                                                        |
|                              |     | [4]           | T23 | [0] | R21 |                                                                                                                                                                                                                                                                                                                                        |
| M1_TXEN /<br>M1_TXD[8]       | O   | P23           |     |     |     | GMII/MII - M1_TXEN<br>Transmit Enable. Asserted when the MAC has data to transmit, synchronously to M1_TXCLK with the first pre-amble of the packet to be sent. Remains asserted until the end of the packet transmission. Active high.<br>TBI - M1_TXD[8]<br>Transmit Data. Clocked on rising edge of M1_GTXCLK.                      |

Table 11 - MII Port 1 Interface Package Ball Definition (continued)

| MII Port 1             |     |               |                                                                                                                                                                                                                                                                                                                            |
|------------------------|-----|---------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Signal                 | I/O | Package Balls | Description                                                                                                                                                                                                                                                                                                                |
| M1_TXER /<br>M1_TXD[9] | O   | N23           | GMII/MII - M1_TXER<br>Transmit Error. Transmitted synchronously with respect to M1_TXCLK, and active high. When asserted (with M1_TXEN also asserted) the ZL50110/11/12/14 will transmit a non-valid symbol, somewhere in the transmitted frame.<br>TBI - M1_TXD[9]<br>Transmit Data. Clocked on rising edge of M1_GTXCLK. |
| M1_GTX_CLK             | O   | N21           | <b>GMII/TBI only</b> - Gigabit Transmit Clock<br>Output of a clock for Gigabit operation at 125 MHz.                                                                                                                                                                                                                       |

Table 11 - MII Port 1 Interface Package Ball Definition (continued)

| MII Port 2 - ZL50111 and ZL50112 variants only.<br>Note: This port must not be used to receive data at the same time as port 3, they are mutually exclusive. |     |                                              |                                                                                                                                                                                                                       |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|----------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Signal                                                                                                                                                       | I/O | Package Balls                                | Description                                                                                                                                                                                                           |
| M2_LINKUP_LED                                                                                                                                                | O   | G23                                          | LED drive for MAC 2 to indicate port is linked up.<br>Logic 0 output = LED on<br>Logic 1 output = LED off                                                                                                             |
| M2_ACTIVE_LED                                                                                                                                                | O   | AB24                                         | LED drive for MAC 2 to indicate port is transmitting or receiving packet data.<br>Logic 0 output = LED on<br>Logic 1 output = LED off                                                                                 |
| M2_RXCLK                                                                                                                                                     | I U | AA19                                         | MII only - Receive Clock.<br>Accepts the following frequencies:<br>25.0 MHz    MII    100 Mbps                                                                                                                        |
| M2_COL                                                                                                                                                       | I D | AE26                                         | Collision Detection. This signal is independent of M2_TXCLK and M2_RXCLK, and is asserted when a collision is detected on an attempted transmission. It is active high, and only specified for half-duplex operation. |
| M2_RXD[3:0]                                                                                                                                                  | I U | [3] AD25    [1] AB21<br>[2] AC23    [0] AD24 | Receive Data. Clocked on rising edge of M2_RXCLK.                                                                                                                                                                     |
| M2_RXDV                                                                                                                                                      | I D | AA20                                         | Receive Data Valid. Active high. This signal is clocked on the rising edge of M2_RXCLK. It is asserted when valid data is on the M2_RXD bus.                                                                          |

Table 12 - MII Port 2 Interface Package Ball Definition

| <b>MII Port 2 - ZL50111 and ZL50112 variants only.</b><br><b>Note: This port must not be used to receive data at the same time as port 3, they are mutually exclusive.</b> |     |                                              |                                                                                                                                                                                                                          |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|----------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Signal                                                                                                                                                                     | I/O | Package Balls                                | Description                                                                                                                                                                                                              |
| M2_RXER                                                                                                                                                                    | I D | AC24                                         | Receive Error. Active high signal indicating an error has been detected. Normally valid when M2_RXDV is asserted. Can be used in conjunction with M2_RXD when M2_RXDV signal is de-asserted to indicate a False Carrier. |
| M2_CRS                                                                                                                                                                     | I D | AC25                                         | Carrier Sense. This asynchronous signal is asserted when either the transmission or reception device is non-idle. It is active high.                                                                                     |
| M2_TXCLK                                                                                                                                                                   | I U | AD26                                         | MII only - Transmit Clock<br>Accepts the following frequencies:<br>25.0 MHz    MII    100 Mbps                                                                                                                           |
| M2_TXD[3:0]                                                                                                                                                                | O   | [3] AE25    [1] AC21<br>[2] AD23    [0] AE24 | Transmit Data. Clocked on rising edge of M2_TXCLK.                                                                                                                                                                       |
| M2_TXEN                                                                                                                                                                    | O   | AC22                                         | Transmit Enable. Asserted when the MAC has data to transmit, synchronously to M2_TXCLK with the first pre-amble of the packet to be sent. Remains asserted until the end of the packet transmission. Active high.        |
| M2_TXER                                                                                                                                                                    | O   | AB20                                         | Transmit Error. Transmitted synchronously with respect to M2_TXCLK, and active high. When asserted (with M2_TXEN also asserted) the ZL50110/12 will transmit a non-valid symbol, somewhere in the transmitted frame.     |

Table 12 - MII Port 2 Interface Package Ball Definition (continued)

| <b>MII Port 3 - ZL50111 variant only</b><br><b>Note: This port must not be used to receive data at the same time as port 2, they are mutually exclusive.</b> |     |               |                                                                                                                                       |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|---------------|---------------------------------------------------------------------------------------------------------------------------------------|
| Signal                                                                                                                                                       | I/O | Package Balls | Description                                                                                                                           |
| M3_LINKUP_LED                                                                                                                                                | O   | G24           | LED drive for MAC 3 to indicate port is linked up.<br>Logic 0 output = LED on<br>Logic 1 output = LED off                             |
| M3_ACTIVE_LED                                                                                                                                                | O   | AB26          | LED drive for MAC 3 to indicate port is transmitting or receiving packet data.<br>Logic 0 output = LED on<br>Logic 1 output = LED off |

Table 13 - MII Port 3 Interface Package Ball Definition

| <b>MII Port 3 - ZL50111 variant only</b><br><b>Note: This port must not be used to receive data at the same time as port 2, they are mutually exclusive.</b> |     |                                              |                                                                                                                                                                                                                          |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|----------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Signal                                                                                                                                                       | I/O | Package Balls                                | Description                                                                                                                                                                                                              |
| M3_RXCLK                                                                                                                                                     | I U | K26                                          | MII only - Receive Clock.<br>Accepts the following frequencies:<br>25.0 MHz    MII    100 Mbps                                                                                                                           |
| M3_COL                                                                                                                                                       | I D | J26                                          | Collision Detection. This signal is independent of M3_TXCLK and M3_RXCLK, and is asserted when a collision is detected on an attempted transmission. It is active high, and only specified for half-duplex operation.    |
| M3_RXD[3:0]                                                                                                                                                  | I U | [3] J22      [1] J24<br>[2] J23      [0] J25 | Receive Data. Clocked on rising edge of M3_RXCLK.                                                                                                                                                                        |
| M3_RXDV                                                                                                                                                      | I D | J21                                          | Receive Data Valid. Active high. This signal is clocked on the rising edge of M3_RXCLK. It is asserted when valid data is on the M3_RXD bus.                                                                             |
| M3_RXER                                                                                                                                                      | I D | H26                                          | Receive Error. Active high signal indicating an error has been detected. Normally valid when M3_RXDV is asserted. Can be used in conjunction with M3_RXD when M3_RXDV signal is de-asserted to indicate a False Carrier. |
| M3_CRS                                                                                                                                                       | I D | H24                                          | Carrier Sense. This asynchronous signal is asserted when either the transmission or reception device is non-idle. It is active high.                                                                                     |
| M3_TXCLK                                                                                                                                                     | I U | H25                                          | MII only - Transmit Clock<br>Accepts the following frequencies:<br>25.0 MHz    MII    100 Mbps                                                                                                                           |
| M3_TXD[3:0]                                                                                                                                                  | O   | [3] K23      [1] L25<br>[2] L26      [0] L24 | Transmit Data. Clocked on rising edge of M3_TXCLK.                                                                                                                                                                       |
| M3_TXEN                                                                                                                                                      | O   | K24                                          | Transmit Enable. Asserted when the MAC has data to transmit, synchronously to M3_TXCLK with the first pre-amble of the packet to be sent. Remains asserted until the end of the packet transmission. Active high.        |
| M3_TXER                                                                                                                                                      | O   | K25                                          | Transmit Error. Transmitted synchronously with respect to M3_TXCLK, and active high. When asserted (with M3_TXEN also asserted) the ZL50111 will transmit a non-valid symbol, somewhere in the transmitted frame.        |

Table 13 - MII Port 3 Interface Package Ball Definition (continued)

### 3.4 External Memory Interface

All External Memory Interface outputs are high impedance while System Reset is LOW.

If the External Memory Interface is unused, all input pins may be left unconnected.

Active low signals are designated by a # suffix, in accordance with the convention used in common memory data sheets.

| Signal          | I/O       | Package Balls |     |      |    | Description                                                                                                                                     |
|-----------------|-----------|---------------|-----|------|----|-------------------------------------------------------------------------------------------------------------------------------------------------|
| RAM_DATA[63:0]  | IU/<br>OT | [63]          | AD7 | [31] | K3 | Buffer memory data. Synchronous to rising edge of SYSTEM_CLK.                                                                                   |
|                 |           | [62]          | AE6 | [30] | K4 |                                                                                                                                                 |
|                 |           | [61]          | AF5 | [29] | J1 |                                                                                                                                                 |
|                 |           | [60]          | AB8 | [28] | J2 |                                                                                                                                                 |
|                 |           | [59]          | AC7 | [27] | J3 |                                                                                                                                                 |
|                 |           | [58]          | AD6 | [26] | J4 |                                                                                                                                                 |
|                 |           | [57]          | AE5 | [25] | H1 |                                                                                                                                                 |
|                 |           | [56]          | AF4 | [24] | H2 |                                                                                                                                                 |
|                 |           | [55]          | AF3 | [23] | H3 |                                                                                                                                                 |
|                 |           | [54]          | AE4 | [22] | J5 |                                                                                                                                                 |
|                 |           | [53]          | AD5 | [21] | G1 |                                                                                                                                                 |
|                 |           | [52]          | AA8 | [20] | J6 |                                                                                                                                                 |
|                 |           | [51]          | AB7 | [19] | H4 |                                                                                                                                                 |
|                 |           | [50]          | AF2 | [18] | G2 |                                                                                                                                                 |
|                 |           | [49]          | AC6 | [17] | H5 |                                                                                                                                                 |
|                 |           | [48]          | AE3 | [16] | G3 |                                                                                                                                                 |
|                 |           | [47]          | AD4 | [15] | F1 |                                                                                                                                                 |
|                 |           | [46]          | AC5 | [14] | G4 |                                                                                                                                                 |
|                 |           | [45]          | AA7 | [13] | F2 |                                                                                                                                                 |
|                 |           | [44]          | AB6 | [12] | F3 |                                                                                                                                                 |
|                 |           | [43]          | AB5 | [11] | G5 |                                                                                                                                                 |
|                 |           | [42]          | AC4 | [10] | E1 |                                                                                                                                                 |
|                 |           | [41]          | AD3 | [9]  | E2 |                                                                                                                                                 |
|                 |           | [40]          | AE2 | [8]  | G6 |                                                                                                                                                 |
|                 |           | [39]          | AA5 | [7]  | F5 |                                                                                                                                                 |
|                 |           | [38]          | AB4 | [6]  | F4 |                                                                                                                                                 |
|                 |           | [37]          | AC3 | [5]  | E3 |                                                                                                                                                 |
|                 |           | [36]          | AD2 | [4]  | E4 |                                                                                                                                                 |
|                 |           | [35]          | AE1 | [3]  | D1 |                                                                                                                                                 |
|                 |           | [34]          | AD1 | [2]  | E5 |                                                                                                                                                 |
|                 |           | [33]          | W6  | [1]  | D2 |                                                                                                                                                 |
|                 |           | [32]          | Y5  | [0]  | D4 |                                                                                                                                                 |
| RAM_PARITY[7:0] | IU/<br>OT | [7]           | L1  | [3]  | L5 | Buffer memory parity. Synchronous to rising edge of SYSTEM_CLK. Bit [7] is parity for data byte [63:56], bit [0] is parity for data byte [7:0]. |
|                 |           | [6]           | L2  | [2]  | L6 |                                                                                                                                                 |
|                 |           | [5]           | L3  | [1]  | K1 |                                                                                                                                                 |
|                 |           | [4]           | L4  | [0]  | K2 |                                                                                                                                                 |

**Table 14 - External Memory Interface Package Ball Definition**

| Signal         | I/O | Package Balls                                                                                                                                                                                                                      | Description                                                                                                           |
|----------------|-----|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------|
| RAM_ADDR[19:0] | O   | [19] R4      [9] P1<br>[18] T2      [8] N4<br>[17] T1      [7] N3<br>[16] P5      [6] N2<br>[15] R3      [5] M1<br>[14] R2      [4] M2<br>[13] P4      [3] M4<br>[12] R1      [2] M3<br>[11] P3      [1] M6<br>[10] P2      [0] M5 | Buffer memory address output.<br>Synchronous to rising edge of<br>SYSTEM_CLK.                                         |
| RAM_BW_A#      | O   | U2                                                                                                                                                                                                                                 | Synchronous Byte Write Enable A (Active Low). Must be asserted same clock cycle as RAM_ADDR. Enables RAM_DATA[7:0].   |
| RAM_BW_B#      | O   | T3                                                                                                                                                                                                                                 | Synchronous Byte Write Enable B (Active Low). Must be asserted same clock cycle as RAM_ADDR. Enables RAM_DATA[15:8].  |
| RAM_BW_C#      | O   | U3                                                                                                                                                                                                                                 | Synchronous Byte Write Enable C (Active Low). Must be asserted same clock cycle as RAM_ADDR. Enables RAM_DATA[23:16]. |
| RAM_BW_D#      | O   | V2                                                                                                                                                                                                                                 | Synchronous Byte Write Enable D (Active Low). Must be asserted same clock cycle as RAM_ADDR. Enables RAM_DATA[31:24]. |
| RAM_BW_E#      | O   | W1                                                                                                                                                                                                                                 | Synchronous Byte Write Enable E (Active Low). Must be asserted same clock cycle as RAM_ADDR. Enables RAM_DATA[39:32]. |
| RAM_BW_F#      | O   | V3                                                                                                                                                                                                                                 | Synchronous Byte Write Enable F (Active Low). Must be asserted same clock cycle as RAM_ADDR. Enables RAM_DATA[47:40]. |
| RAM_BW_G#      | O   | W2                                                                                                                                                                                                                                 | Synchronous Byte Write Enable G (Active Low). Must be asserted same clock cycle as RAM_ADDR. Enables RAM_DATA[55:48]. |
| RAM_BW_H#      | O   | Y1                                                                                                                                                                                                                                 | Synchronous Byte Write Enable H (Active Low). Must be asserted same clock cycle as RAM_ADDR. Enables RAM_DATA[63:56]. |
| RAM_RW#        | O   | U4                                                                                                                                                                                                                                 | Read/Write Enable output<br>Read = high<br>Write = low                                                                |

Table 14 - External Memory Interface Package Ball Definition (continued)

### 3.5 CPU Interface

All CPU Interface signals are 5 V tolerant.

All CPU Interface outputs are high impedance while System Reset is LOW.

| Signal         | I/O  | Package Balls                                                                                                                                                                                                                                                                                                                                                      | Description                                                                                                                                                                                                                           |
|----------------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| CPU_DATA[31:0] | I/OT | [31] AF25 [15] AA16<br>[30] AB19 [14] AD19<br>[29] AD22 [13] AE20<br>[28] AE23 [12] AB17<br>[27] AC20 [11] AF21<br>[26] AF24 [10] AC17<br>[25] AE22 [9] AE19<br>[24] AD21 [8] AA15<br>[23] AA17 [7] AB16<br>[22] AB18 [6] AD18<br>[21] AC19 [5] AF19<br>[20] AD20 [4] AE18<br>[19] AF23 [3] AD17<br>[18] AE21 [2] AF20<br>[17] AF22 [1] AB15<br>[16] AC18 [0] AF18 | CPU Data Bus. Bi-directional data bus, synchronously transmitted with CPU_CLK rising edge.<br><br>NOTE: as with all ports in the ZL50110/11/12/14 device, CPU_DATA[0] is the least significant bit (lsb).                             |
| CPU_ADDR[23:2] | I    | [23] AB13 [11] AD11<br>[22] AC13 [10] AF10<br>[21] AD13 [9] AC11<br>[20] AE13 [8] AE10<br>[19] AF12 [7] AD10<br>[18] AE12 [6] AB11<br>[17] AD12 [5] AF9<br>[16] AC12 [4] AC10<br>[15] AF11 [3] AE9<br>[14] AB12 [2] AA11<br>[13] AE11<br>[12] AA12                                                                                                                 | CPU Address Bus. Address input from processor to ZL50110/11/12/14, synchronously transmitted with CPU_CLK rising edge.<br><br>NOTE: as with all ports in the ZL50110/11/12/14 device, CPU_ADDR[2] is the least significant bit (lsb). |
| CPU_CS         | I U  | AF14                                                                                                                                                                                                                                                                                                                                                               | CPU Chip Select. Synchronous to rising edge of CPU_CLK and active low. Is asserted with CPU_TS_ALE. Must be asserted with CPU_OE to asynchronously enable the CPU_DATA output during a read, including DMA read.                      |
| CPU_WE         | I    | AD14                                                                                                                                                                                                                                                                                                                                                               | CPU Write Enable. Synchronously asserted with respect to CPU_CLK rising edge, and active low. Used for CPU writes from the processor to registers within the ZL50110/11/12/14. Asserted one clock cycle after CPU_TS_ALE.             |

**Table 15 - CPU Interface Package Ball Definition**

| Signal     | I/O | Package Balls | Description                                                                                                                                                                                                                                                                                                                               |
|------------|-----|---------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| CPU_OE     | I   | AE14          | CPU Output Enable.<br>Synchronously asserted with respect to CPU_CLK rising edge, and active low. Used for CPU reads from the processor to registers within the ZL50110/11/12/14. Asserted one clock cycle after CPU_TS_ALE. Must be asserted with CPU_CS to asynchronously enable the CPU_DATA output during a read, including DMA read. |
| CPU_TS_ALE | I   | AE15          | Synchronous input with rising edge of CPU_CLK.<br>Latch Enable (ALE), active high signal. Asserted with CPU_CS, for a single clock cycle.                                                                                                                                                                                                 |
| CPU_SDACK1 | I   | AF15          | CPU/DMA 1 Acknowledge Input. Active low synchronous to CPU_CLK rising edge. Used to acknowledge request from ZL50110/11/12/14 for a DMA write transaction. Only used for DMA transfers, not for normal register access.                                                                                                                   |
| CPU_SDACK2 | I   | AD15          | CPU/DMA 2 Acknowledge Input Active low synchronous to CPU_CLK rising edge. Used to acknowledge request from ZL50110/11/12/14 for a DMA read transaction. Only used for DMA transfers, not for normal register access.                                                                                                                     |
| CPU_CLK    | I   | AC14          | CPU PowerQUICC™ II Bus Interface clock input. 66 MHz clock, with minimum of 6 ns high/low time. Used to time all host interface signals into and out of ZL50110/11/12/14 device.                                                                                                                                                          |

Table 15 - CPU Interface Package Ball Definition (continued)

| Signal                         | I/O | Package Balls | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|--------------------------------|-----|---------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| $\overline{\text{CPU\_TA}}$    | OT  | AB14          | CPU Transfer Acknowledge. Driven from tri-state condition on the negative clock edge of CPU_CLK following the assertion of CPU_CS. Active low, asserted from the rising edge of CPU_CLK. For a read, asserted when valid data is available at CPU_DATA. The data is then read by the host on the following rising edge of CPU_CLK. For a write, is asserted when the ZL50110/11/12/14 is ready to accept data from the host. The data is written on the rising edge of CPU_CLK following the assertion. Returns to tri-state from the negative clock edge of CPU_CLK following the de-assertion of CPU_CS. |
| $\overline{\text{CPU\_DREQ0}}$ | OT  | AC15          | CPU DMA 0 Request Output Active low synchronous to CPU_CLK rising edge. Asserted by ZL50110/11/12/14 to request the host initiates a DMA write. Only used for DMA transfers, not for normal register access.                                                                                                                                                                                                                                                                                                                                                                                               |
| $\overline{\text{CPU\_DREQ1}}$ | OT  | AE16          | CPU DMA 1 Request<br>Active low synchronous to CPU_CLK rising edge. Asserted by ZL50110/11/12/14 to indicate packet data is ready for transmission to the CPU, and request the host initiates a DMA read. Only used for DMA transfers, not for normal register access.                                                                                                                                                                                                                                                                                                                                     |
| $\overline{\text{CPU\_IREQ0}}$ | O   | AF17          | CPU Interrupt 0 Request (Active Low)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| $\overline{\text{CPU\_IREQ1}}$ | O   | AD16          | CPU Interrupt 1 Request (Active Low)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |

Table 15 - CPU Interface Package Ball Definition (continued)

### 3.6 System Function Interface

All System Function Interface signals are 5 V tolerant.

The core of the chip will be held in reset for 16383 SYSTEM\_CLK cycles after SYSTEM\_RST has gone HIGH to allow the PLL's to lock. No chip access should occur at this time.

| Signal       | I/O | Package Balls | Description                                                                                                                                                                                                                                                 |
|--------------|-----|---------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SYSTEM_CLK   | I   | U6            | System Clock Input. The system clock frequency is 100 MHz. The quality of SYSTEM_CLK, or the oscillator that drives SYSTEM_CLK directly impacts the adaptive clock recovery performance. See Section 6.3.                                                   |
| SYSTEM_RST   | I   | V4            | System Reset Input. Active low. The system reset is asynchronous, and causes all registers within the ZL50110/11/12/14 to be reset to their default state. Recommend external pull-up.                                                                      |
| SYSTEM_DEBUG | I   | U5            | System Debug Enable. This is an asynchronous signal that, when de-asserted, prevents the software assertion of the debug-freeze command, regardless of the internal state of registers, or any error conditions. Active high. Recommend external pull-down. |

**Table 16 - System Function Interface Package Ball Definition**

### 3.7 Test Facilities

#### 3.7.1 Administration, Control and Test Interface

All Administration, Control and Test Interface signals are 5 V tolerant.

| Signal         | I/O   | Package Balls                                                                                                                                       | Description                                                                                                                                                                                                                                                                                          |
|----------------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| GPIO[15:0]     | ID/OT | [15] AA4 [7] AA2<br>[14] AB3 [6] Y3<br>[13] AC2 [5] AB1<br>[12] AC1 [4] Y2<br>[11] AB2 [3] W4<br>[10] Y4 [2] V5<br>[9] W5 [1] AA1<br>[8] AA3 [0] W3 | General Purpose I/O pins. Connected to an internal register, so customer can set user-defined parameters. Bits [4:0] reserved at startup or reset for memory Tapped Delay Line (TDL) setup. See the ZL50110/11/12/14 Programmers Model for more details. Recommend 5 kohm pulldown on these signals. |
| TEST_MODE[2:0] | ID    | [2] AF6<br>[1] AB9<br>[0] AC8                                                                                                                       | Test Mode input - ensure these pins are tied to ground for normal operation.<br>000 SYS_NORMAL_MODE<br>001-010 RESERVED<br>011 SYS_TRISTATE_MODE<br>100-111 RESERVED                                                                                                                                 |

**Table 17 - Administration/Control Interface Package Ball Definition**

#### 3.7.2 JTAG Interface

All JTAG Interface signals are 5 V tolerant, and conform to the requirements of IEEE1149.1 (2001).

| Signal    | I/O | Package Balls | Description                                                                                                                                                        |
|-----------|-----|---------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| JTAG_TRST | I U | AE7           | JTAG Reset. Asynchronous reset. In normal operation this pin should be pulled low. Recommend external pull-down.                                                   |
| JTAG_TCK  | I   | AD8           | JTAG Clock - maximum frequency is 25 MHz, typically run at 10 MHz. In normal operation this pin should be pulled either high or low. Recommend external pull-down. |
| JTAG_TMS  | I U | AA10          | JTAG test mode select. Synchronous to JTAG_TCK rising edge. Used by the Test Access Port controller to set certain test modes.                                     |
| JTAG_TDI  | I U | AF7           | JTAG test data input. Synchronous to JTAG_TCK.                                                                                                                     |
| JTAG_TDO  | O   | AC9           | JTAG test data output. Synchronous to JTAG_TCK.                                                                                                                    |

**Table 18 - JTAG Interface Package Ball Definition**

The ZL50111 and ZL50112 share a common JTAG ID. They also share a common CHIP\_ID register value.

### 3.8 Miscellaneous Inputs

| Signal    | Package Balls         | Description                          |
|-----------|-----------------------|--------------------------------------|
| IC_GND    | AD9, AF8, R5, T4, AE8 | Internally Connected. Tie to GND.    |
| IC_VDD_IO | AF16                  | Internally Connected. Tie to VDD_IO. |

**Table 19 - Miscellaneous Inputs Package Ball Definitions**

### 3.9 Power and Ground Connections

| Signal   | Package Balls                                                                                      |                                                                                                        |                                                                                               |                                                                                                | Description                            |
|----------|----------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------|----------------------------------------|
| VDD_IO   | J9<br>J13<br>J17<br>L9<br>N9<br>R9<br>U9<br>V11<br>V15                                             | J10<br>J14<br>J18<br>L18<br>N18<br>R18<br>U18<br>V12<br>V16                                            | J11<br>J15<br>K9<br>M9<br>P9<br>T9<br>V9<br>V13<br>V17                                        | J12<br>J16<br>K18<br>M18<br>P18<br>T18<br>V10<br>V14<br>V18                                    | 3.3 V VDD Power Supply for IO Ring     |
| GND      | A1<br>F6<br>L11<br>L15<br>M13<br>N1<br>N13<br>N22<br>P12<br>P16<br>R13<br>T5<br>T14<br>AA6<br>AF13 | A13<br>F21<br>L12<br>L16<br>M14<br>N5<br>N14<br>N26<br>P13<br>P24<br>R14<br>T11<br>T15<br>AA21<br>AF26 | A26<br>K5<br>L13<br>M11<br>M15<br>N11<br>N15<br>P6<br>P14<br>R11<br>R15<br>T12<br>T16<br>AB10 | E22<br>K22<br>L14<br>M12<br>M16<br>N12<br>N16<br>P11<br>P15<br>R12<br>R16<br>T13<br>T24<br>AF1 | 0 V Ground Supply                      |
| VDD_CORE | F7<br>F20<br>K6<br>N6<br>Y6<br>AA13                                                                | F12<br>H6<br>K21<br>T21<br>Y21<br>AA14                                                                 | F15<br>H21<br>M21<br>V6<br>AA9<br>AA18                                                        |                                                                                                | 1.8 V VDD Power Supply for Core Region |
| A1VDD    | T6                                                                                                 |                                                                                                        |                                                                                               |                                                                                                | 1.8 V PLL Power Supply                 |

**Table 20 - Power and Ground Package Ball Definition**

### 3.10 ZL50111, ZL50112, ZL50110 and ZA50114 Internal Connections

| Signal | Package Balls  | Description                                    |
|--------|----------------|------------------------------------------------|
| IC     | R6, AC16, AE17 | Internally Connected. Must leave open circuit. |

**Table 21 - No Connection Ball Definition**

### 3.11 ZL50112 Internal Connections

| Signal | Package Balls      | Description                                    |
|--------|--------------------|------------------------------------------------|
| IC     | G21, F25, E26, G22 | Internally Connected. Must leave open circuit. |

**Table 22 - No Connection Ball Definition**

### 3.12 ZL50112 Auxiliary Clocks

| Signal         | Package Balls | Description                                                                                                                                            |
|----------------|---------------|--------------------------------------------------------------------------------------------------------------------------------------------------------|
| AUX2_CLKo[1:0] | C17, C15      | Auxiliary clock output. Typically AUX2_CLKo[1] is connected to AUX2_CLKi[1] and AUX2_CLKo[0] is connected to AUX2_CLKi[0] through a zero ohm resistor. |
| AUX2_CLKi[1:0] | E15, D15      | Auxiliary clock input. Typically AUX2_CLKi[1] is connected to AUX2_CLKo[1] and AUX2_CLKi[0] is connected to AUX2_CLKo[0] through a zero ohm resistor.  |
| AUX1_CLKo[1:0] | D16, A18      | Auxiliary clock output. Typically AUX1_CLKo[1] is connected to AUX1_CLKi[1] and AUX1_CLKo[0] is connected to AUX1_CLKi[0]                              |
| AUX1_CLKi[1:0] | E16, B18      | Auxiliary clock input. Typically AUX1_CLKi[1] is connected to AUX1_CLKo[1] and AUX1_CLKi[0] is connected to AUX1_CLKo[0]                               |

**Table 23 - Auxiliary clock Ball Definition**

## 4.0 Typical Applications

### 4.1 Leased Line Provision

Circuit emulation is typically used to support the provision of leased line services to customers using legacy TDM equipment. For example, Figure 6 shows a leased line TDM service being carried across a packet network. The advantages are that a carrier can upgrade to a packet switched network, whilst still maintaining their existing TDM business.

The ZL50110/11/12/14 is capable of handling circuit emulation of both structured T1, E1, and J2 links (e.g., for support of fractional circuits) and unstructured (or clear channel) T1, E1, J2, T3 and E3 links. The device handles the data-plane requirements of the provider edge inter-working function (with the exception of the physical interfaces and line interface units). Control plane functions are forwarded to the host processor controlling the ZL50110/11/12/14 device.

The ZL50110/11/12/14 provides a per-stream clock recovery function, in unstructured mode, to reproduce the TDM service frequency at the egress of the packet network. This is required otherwise the queue at the egress of the packet network will either fill up or empty, depending on whether the regenerated clock is slower or faster than the original.

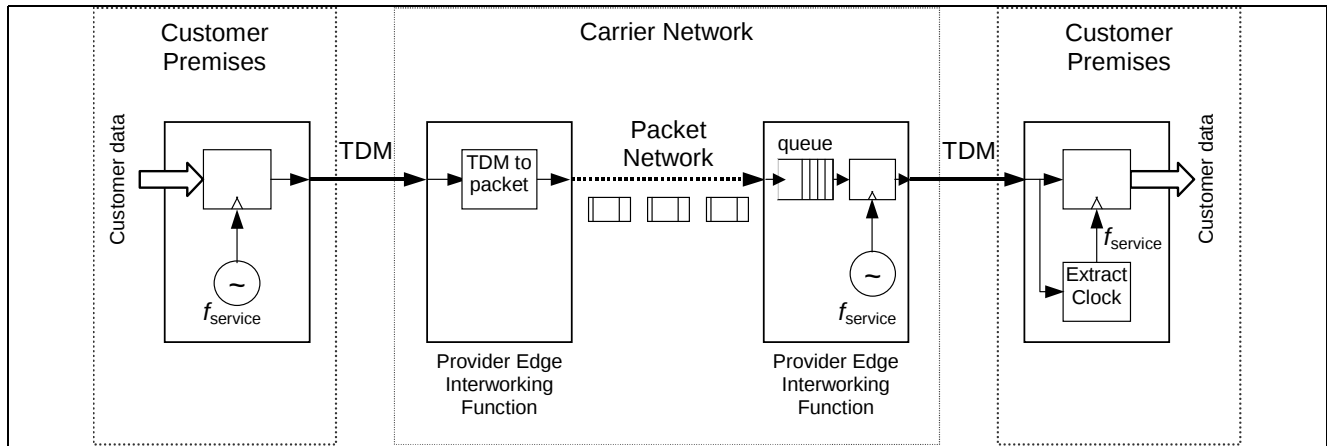


Figure 6 - Leased Line Services Over a Circuit Emulation Link

## 4.2 Metropolitan Area Network Aggregation

The metro Ethernet application, shown in Figure 7, consists of the metro Ethernet service modules sitting on the edge of the Metro Ethernet ring. The modules will connect Ethernet circuits and TDM circuits to the metro ring.

The ZL50110/11/12/14 is used to emulate leased line TDM circuits over Ethernet by establishing CESoP connections over the Metro Ethernet ring between the MTUs/MDUs and the PSTN. The use of CESoP eliminates the need for a separate TDM network in the metro core, thereby enabling convergence on a unified Ethernet network.

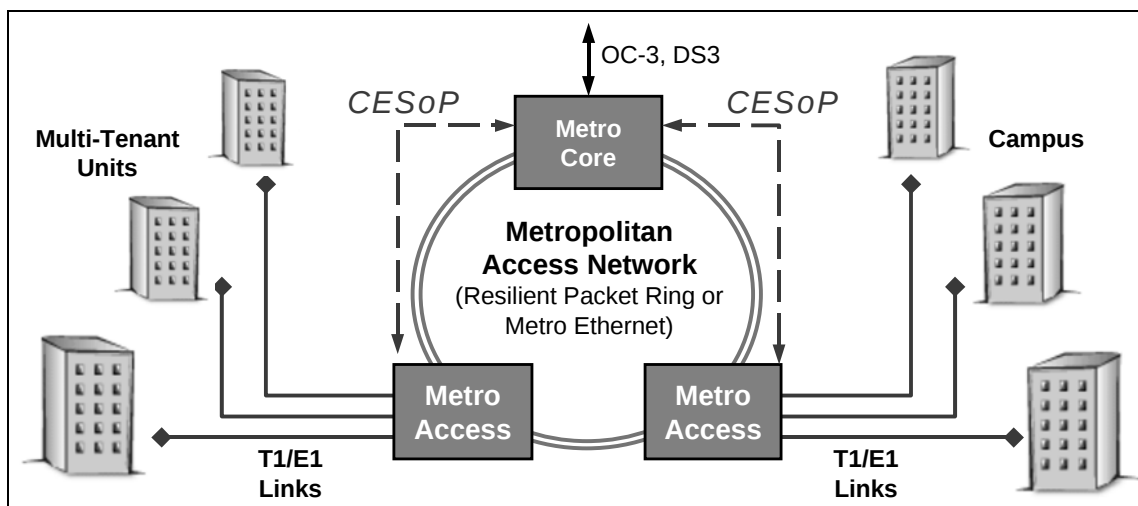


Figure 7 - Metropolitan Area Network Aggregation using CESoP

### 4.3 Digital Loop Carrier

The Broadband Digital Loop Carrier (BBDLC) application, shown in Figure 8, consists of a BBDLC connected to the Central Office (CO) by a dedicated fiber link running Gigabit Ethernet (GE) rather than by NxT1/E1 or DS3/E3.

The ZL50110/11/12/14 is used to emulate TDM circuits over Ethernet by establishing CESoP connections between the BBDLC and the CO. At the CO the native IP or Ethernet traffic is split from the CESoP connections and sent towards the packet network. Multiple T1/E1 CESoP connections from several BBDLC are aggregated in the CO using a larger ZL50110/11/12/14 variant, converted back to TDM circuits, and connected to a class 5 switch destined towards the PSTN.

In this configuration T3/E3 services can also be provided. Using CESoP allows voice and data traffic to be converged onto a single link.

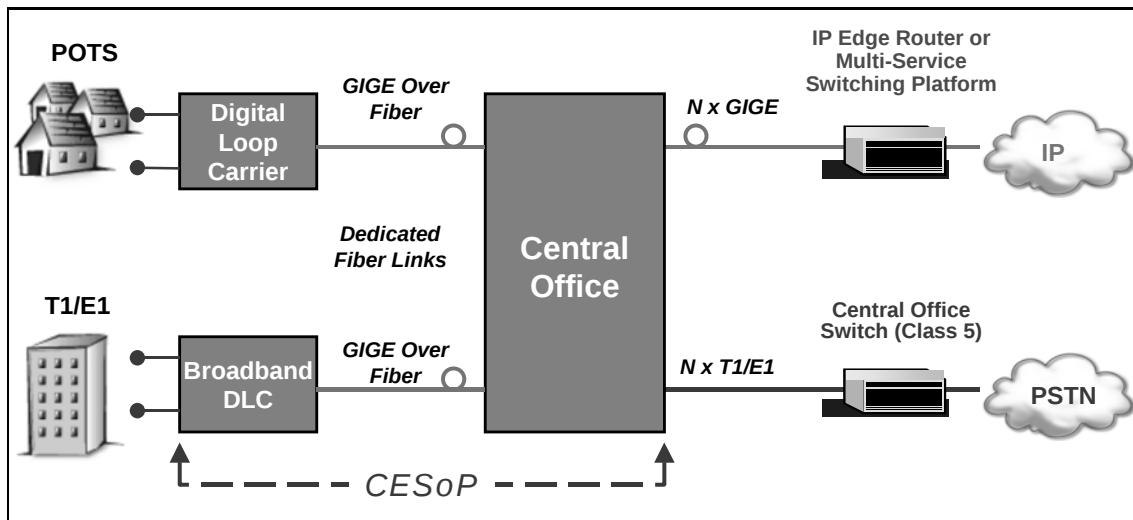


Figure 8 - Digital Loop Carrier using CESoP

#### 4.4 Remote Concentrator

The remote concentrator application, shown in Figure 9, consists of a remote concentrators connected to the Central Office (CO) by a dedicated fiber link running Gigabit Ethernet (GE) or Ethernet over SONET (EoS) rather than by NxT1/E1 or DS3/E3. The remote concentrators provide both TDM service and native Ethernet service to the MTU/MDU.

The ZL50110/11/12/14 is used to emulate TDM circuits over Ethernet by establishing CESoP connections between the remote concentrator and the CO. The native IP or Ethernet traffic is multiplexed with the CESoP traffic inside the remote concentrator and sent across the same GE connection to the CO. At the CO the native IP or Ethernet traffic is split from the CESoP connections at sent towards the packet network. Multiple T1/E1 CESoP connections from several remote concentrators are aggregated in the CO using a larger ZL50110/11/12/14 variant, converted back to TDM circuits, and connected to the PSTN through a higher bandwidth TDM circuit such as OC-3 or STM-1.

The use of CESoP here allows the convergence of voice and data on a single access network based on Ethernet. This convergence on Ethernet, a packet technology, rather than SONET/SDH, a switched circuit technology, provides cost and operational savings.

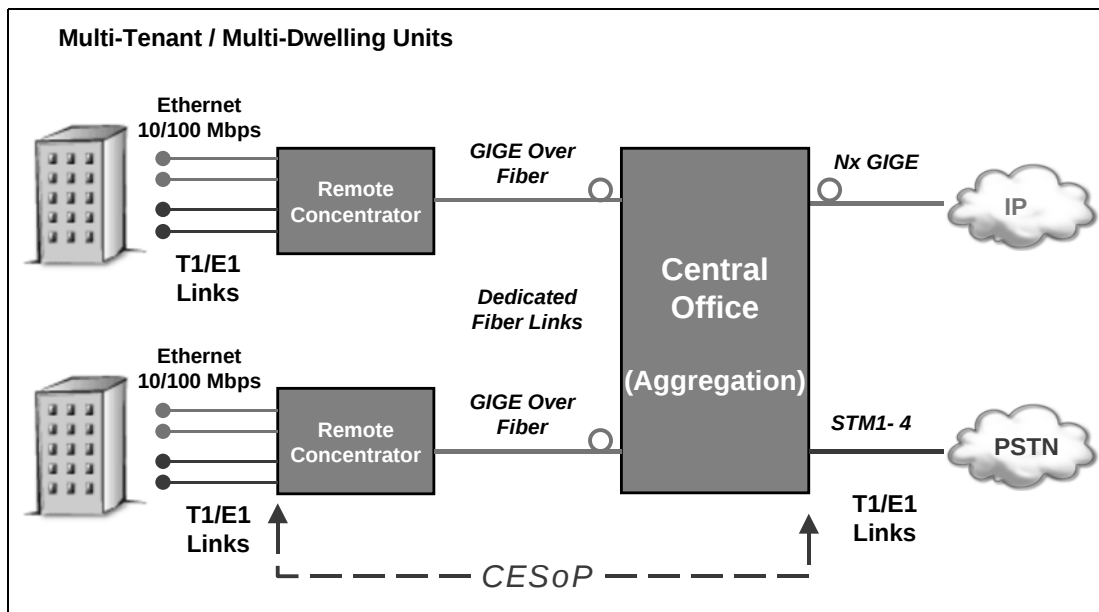


Figure 9 - Remote Concentrator using CESoP

#### 4.5 Cell Site Backhaul

The cell site backhaul application, shown in Figure 10, consists of 2G, 2.5G and 3G base stations, co-located at a cell site, connected to their respective 2G, 2.5G base station controllers and 3G radio network controller. The traditional leased T1/E1 lines between the cell site and the base station controllers is now replaced by a packet network such as fixed wireless or Gigabit Ethernet (GE) fiber, that may be owned by the carrier or accessed through a service provider.

The ZL50110/11/12/14 would sit in a box either external to the base stations, or integrated in them, and would transparently carry multiple T1/E1s to the Base Station controllers/Radio Network controllers using CESoP connections. At the base station controller location another ZL50110/11/12/14 would terminate the CESoP connection and provide the T1/E1 line to the controllers.

The use of the ZL50110/11/12/14 would allow for lower cost transport between the two locations, due to the replacement of the leased T1/E1 line cost. The CESoP connection would allow the T1/E1 to meet the strict timing requirements for 3G base stations. Each T1/E1 may be asynchronous should a service provider be backhauling T1/E1s from multiple carriers.

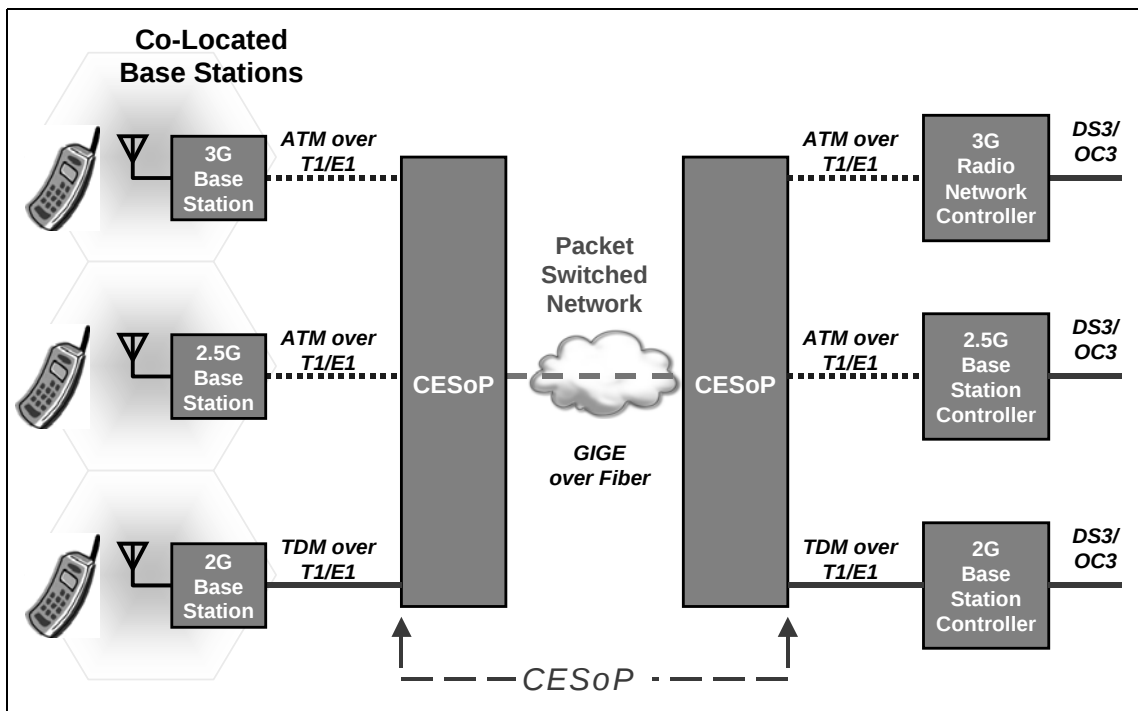


Figure 10 - Cell Site Backhaul using CESoP

#### 4.6 Equipment Architecture Example

An equipment architecture example is shown in Figure 11, supporting T1/E1 ports is shown at the board level using Zarlink's CESoP processors. In this example, the equipment consists of three line cards and an uplink card connected to a packet backplane.

The first line card supports up to 32 T1/E1 lines, containing up to 1024 DS0, for Nx64 kbps structured data transfer (SDT) CESoP connections. The T1/E1 lines are broken down into DS0 channels on an H.110 bus. The ZL50110/11/12/14 establishes CESoP connections, with each connection taking a number of DS0 channels from the H.110 bus.

The third line card support up to 32 T1/E1 or 2 T3/E3 lines for private line unstructured data transfer (UDT) CESoP connections. The T1/E1 lines are not terminated on the card but are transparently packetized into individual CESoP connections by the ZL50110/11/12/14.

The second line card supports multiple 10/100/1000 Mbps Ethernet ports for native Internet, video and data service.

The uplink card multiplexes the Ethernet traffic from the three cards, and uplinks the CESoP, Internet, video and data traffic to the packet switched network (PSN.)

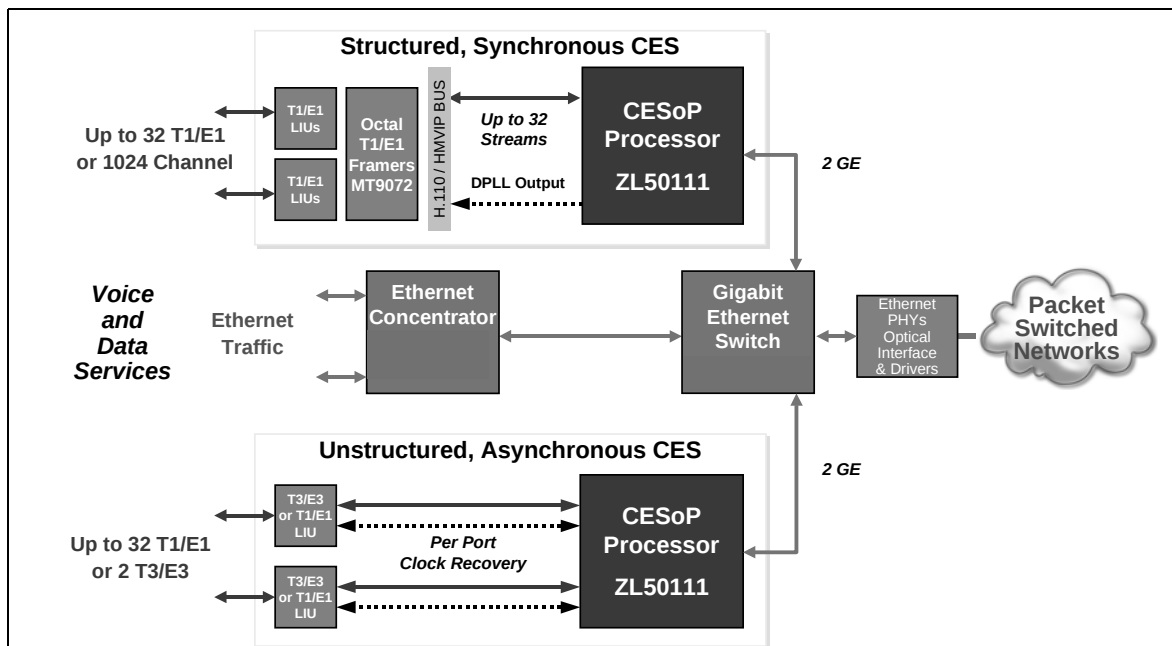
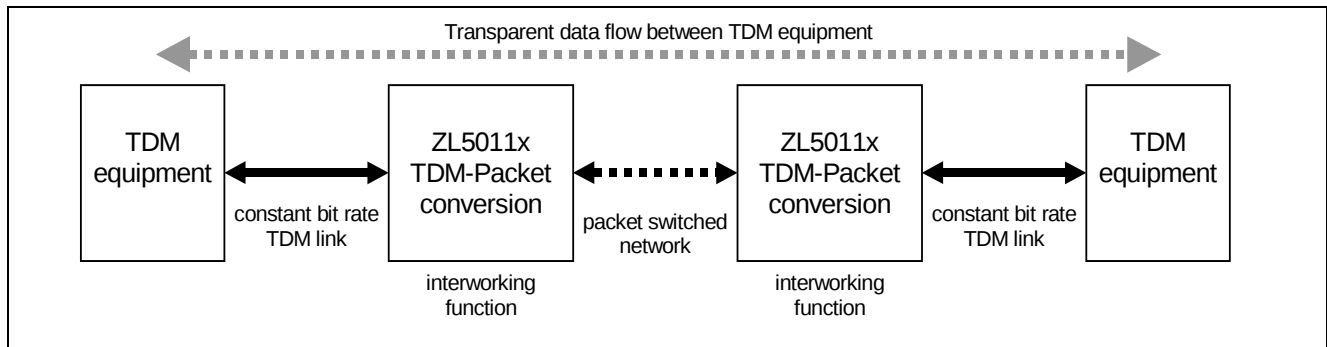


Figure 11 - Equipment example using CESoP

## 5.0 Functional Description

The ZL50110/11/12/14 family provides the data-plane processing to enable constant bit rate TDM services to be carried over a packet switched network, such as an Ethernet, IP or MPLS network. The device segments the TDM data into user-defined packets, and passes it transparently over the packet network to be reconstructed at the far end. This has a number of applications, including emulation of TDM circuits and packet backplanes for TDM-based equipment.

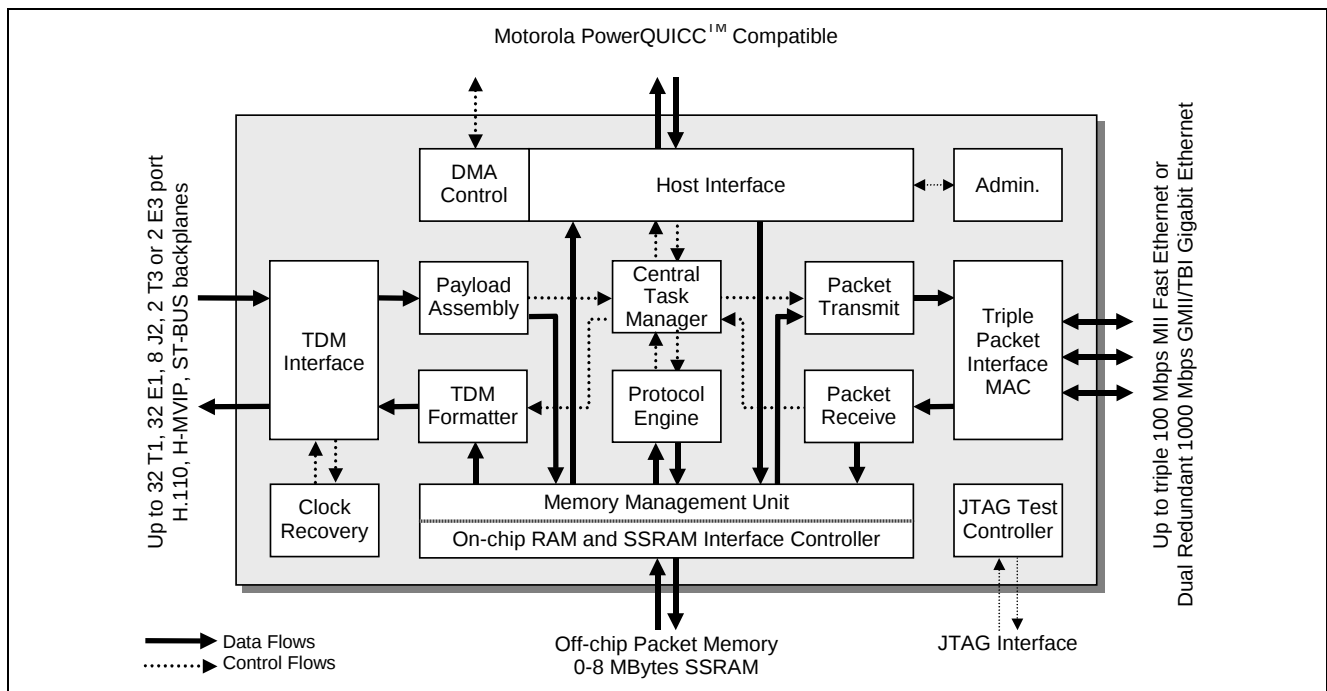


**Figure 12 - ZL50110/11/12/14 Family Operation**

Note: The ZL50110/11/12/14 does not support the transmission or reception of jumbo packets, or packet sizes larger than 1522 bytes.

## 5.1 Block Diagram

A diagram of the ZL50110/11/12/14 device is given in Figure 13, which shows the major data flows between functional components.



**Figure 13 - ZL50110/11/12/14 Data and Control Flows**

## 5.2 Data and Control Flows

There are numerous combinations that can be implemented to pass data through the ZL50110/11/12/14 device depending on the application requirements. The Task Manager can be considered the central pivot, through which all flows must operate.

The flow is determined by the Type field in the Task Message (see ZL50110/11/12/14 Programmers Model).

| Flow Number     | Flow Through Device              |
|-----------------|----------------------------------|
| 1               | TDM to (TM) to PE to (TM) to PKT |
| 2               | PKT to (TM) to PE to (TM) to TDM |
| 3               | TDM to (TM) to PKT               |
| 4               | PKT to (TM) to TDM               |
| 5               | TDM to (TM) to CPU               |
| 6               | TDM to (TM) to PE to (TM) to CPU |
| 7               | CPU to (TM) to TDM               |
| 8               | PKT to (TM) to CPU               |
| 9               | CPU to (TM) to PKT               |
| 10 <sup>1</sup> | TDM to (TM) to TDM               |
| 11 <sup>1</sup> | PKT to (TM) to PKT               |

**Table 24 - Standard Device Flows**

1. This flow is for loopback test purposes only

Each of the 11 data flows uses the Task Manager to route packet information to the next block or interface for onward transmission. This section describes the flows between the TDM interface, the packet interface and the Task Manager which are the main flow routes used in the ZL50110/11/12/14 family. For example, the TDM->TM flow is used in flow types 1, 3, 5, and 6, and the TM->PKT flow is used in flow types 1, 3, and 9.

### 5.3 TDM Interface

The ZL50110/11/12/14 family offers the following types of TDM service across the packet network:

| Service type                            | TDM interface                                                       | Interface type                                      | Interfaces to                     |
|-----------------------------------------|---------------------------------------------------------------------|-----------------------------------------------------|-----------------------------------|
| Unstructured asynchronous               | T1, E1, J2, E3 and T3                                               | Bit clock in and out<br>Data in and out             | Line interface unit               |
| Structured synchronous<br>(N x 64 Kbps) | T1, E1 and J2<br>Framed TDM data streams at<br>2.048 and 8.192 Mbps | Bit clock out<br>Frame pulse out<br>Data in and out | Framers<br>TDM backplane (master) |
|                                         |                                                                     | Bit clock in<br>Frame in<br>Data in and out         | Framers<br>TDM backplane (slave)  |

**Table 25 - TDM Services Offered by the ZL50110/11/12/14 Family**

Unstructured services are fully asynchronous, and include full support for clock recovery on a per stream basis. Both adaptive and differential clock recovery mechanisms can be used. Structured services are synchronous, with all streams driven by a common clock and frame reference. These services can be offered in two ways:

- **Synchronous master mode** - the ZL50110/11/12/14 provides a common clock and frame pulse to all streams, which may be locked to an incoming clock or frame reference
- **Synchronous slave mode** - the ZL50110/11/12/14 accepts a common external clock and frame pulse to be used by all streams

In either mode, N x 64 Kbps trunking is supported as detailed in “Structured Payload Order” on page 63.

The ZL50110/11/12/14 supports structured mode or unstructured mode, however it does not support structured mode and unstructured mode at the same time, all ports are either structured or unstructured. In structured mode, all TDM inputs must be synchronous.

In addition, it can be used with a variety of different protocols. It includes full support for the IETF RFCs for CESoPSN (Circuit Emulation Services over Packet Switched Networks) and SAToP (Structure-Agnostic Transport over Packet) protocols.

#### 5.3.1 TDM Interface Block

The TDM Access Interface consists of up to 32 streams (depending on variant), each with an input and an output data stream operating at either 1.544 Mbps or 2.048 Mbps. It contains two basic types of interface: unstructured clock and data, for interfacing directly to a line interface unit; or structured, framed data, for interfacing to a framer or TDM backplane.

Unstructured data is treated asynchronously, with every stream using its own clock. Clock recovery is provided on each output stream, to reproduce the TDM service frequency at the egress of the packet network. Structured data is treated synchronously, i.e., all data streams are timed by the same clock and frame references. These can either be supplied from an external source (slave mode) or generated internally using the on-chip stratum 4/4E DPLL (master mode).

### 5.3.2 Structured TDM Port Data Formats

The ZL50110/11/12/14 is programmable such that the frame/clock polarity and clock alignment can be set to any desired combination. Table 26 shows a brief summary of four different TDM formats; ST-BUS, H.110, H-MVIP, and Generic (synchronous mode only), for more information see the relevant specifications shown. There are many additional formats for TDM transmission not depicted in Table 26, but the flexibility of the port will cover almost any scenario. The overall data format is set for the entire TDM Interface device, rather than on a per stream basis. It is possible to control the polarity of the master clock and frame pulse outputs, independent of the chosen data format (used when operating in synchronous master mode).

| Data Format | Data Rate (Mbps) | Number of channels per frame | Clock Freq. (MHz) | Nominal Frame Pulse Width (ns) | Frame Pulse Polarity | Frame Boundary Alignment |                      | Standard                         |
|-------------|------------------|------------------------------|-------------------|--------------------------------|----------------------|--------------------------|----------------------|----------------------------------|
|             |                  |                              |                   |                                |                      | clock                    | frame pulse          |                                  |
| ST-bus      | 2.048            | 32                           | 2.048             | 244                            | Negative             | Rising Edge              | Straddles boundary   | MSAN-126 Rev B (Issue 4) Zarlink |
|             | 2.048            | 32                           | 4.096             | 244                            | Negative             | Falling Edge             | Straddles boundary   |                                  |
|             | 8.192            | 128                          | 16.384            | 61                             | Negative             | Falling Edge             | Straddles boundary   |                                  |
| H.110       | 8.192            | 128                          | 8.192             | 122                            | Negative             | Rising edge              | Straddles boundary   | ECTF H.110                       |
| H-MVIP      | 2.048            | 32                           | 2.048             | 244                            | Negative             | Rising Edge              | Straddles boundary   | H-MVIP Release 1.1a              |
|             | 2.048            | 32                           | 4.096             | 244                            | Negative             | Falling Edge             | Straddles boundary   |                                  |
|             | 8.192            | 128                          | 16.384            | 244                            | Negative             | Falling Edge             | Straddles boundary   |                                  |
| Generic     | 2.048            | 32                           | 2.048             | 488                            | Positive             | Rising Edge              | Rising edge of clock |                                  |
|             | 8.192            | 128                          | 8.192             | 122                            | Positive             | Rising Edge              | Rising edge of clock |                                  |

**Table 26 - Some of the TDM Port Formats Accepted by the ZL50110/11/12/14 Family**

### 5.3.3 TDM Clock Structure

The TDM interface can operate in two modes, synchronous for structured TDM data, and asynchronous for unstructured TDM data. The ZL50110/11/12/14 is capable of providing the TDM clock for either of the modes. The ZL50110/11/12/14 supports clock recovery in both synchronous and asynchronous modes of operation. In asynchronous operation each stream may have independent clock recovery.

#### 5.3.3.1 Synchronous TDM Clock Generation

In synchronous mode all 32 streams will be driven by a common clock source. When the ZL50110/11/12/14 is acting as a master device, the source can either be the internal DPLL or an external PLL. In both cases, the primary and secondary reference clocks are taken from either two TDM input clocks, or two external clock sources driven to the chip. The input clocks are then divided down where necessary and sent either to the internal DPLL or to the output pins for connection to an external DPLL. The DPLL then provides the common clock and frame pulse required to drive the TDM streams. See “DPLL Specification” on page 75 for further details.

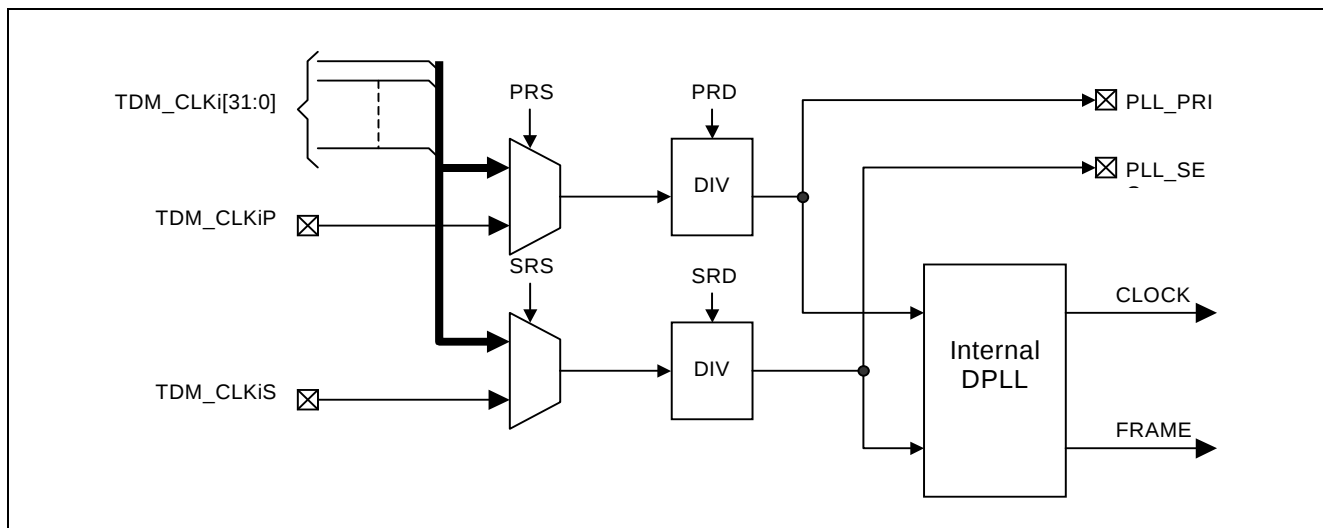


Figure 14 - Synchronous TDM Clock Generation

When the ZL50110/11/12/14 is acting as a slave device, the common clock and frame pulse signals are taken from an external device providing the TDM master function.

#### 5.3.3.2 Asynchronous TDM Clock Generation

Each stream uses a separate internal DCO to provide an asynchronous TDM clock output. The DCO can be controlled to recover the clock from the original TDM source depending on the timing algorithm used.

### 5.4 Payload Assembly

Data traffic received on the TDM Access Interface is sampled in the TDM Interface block, and synchronized to the internal clock. It is then forwarded to the payload assembly process. The ZL50110/11/12/14 Payload Assembler can handle up to 128 active packet streams or “contexts” simultaneously. Packet payloads are assembled in the format shown in Figure 15 - on page 62. This meets the requirements of the IETF CESoPSN standard (RFC 5086). Alternatively, packet payloads are assembled in the format shown in Figure 17 - on page 64. This meets the requirements of the IETF SAToP standard (RFC 4553).

The Packet Transmit (PTX) circuit adds Layer 2 and Layer 3 protocol headers. The chosen protocol header combination for addition by the PTX must not exceed 64 bytes. The exception is context 127 (the 128th context), which must not exceed 56 bytes.

Contexts in the TDM to PKT direction are placed in the UPDATE state when they are opened, pending the local clock source generation. If there is no local clock source to generate packets, the context will remain in the UPDATE state and cannot be closed. ZL5011x Design Manual section “13.1 Understanding forceDelete” describes the procedure to close transmit contexts in the UPDATE state.

When the payload has been assembled it is written into the centrally managed memory, and a task message is passed to the Task Manager.

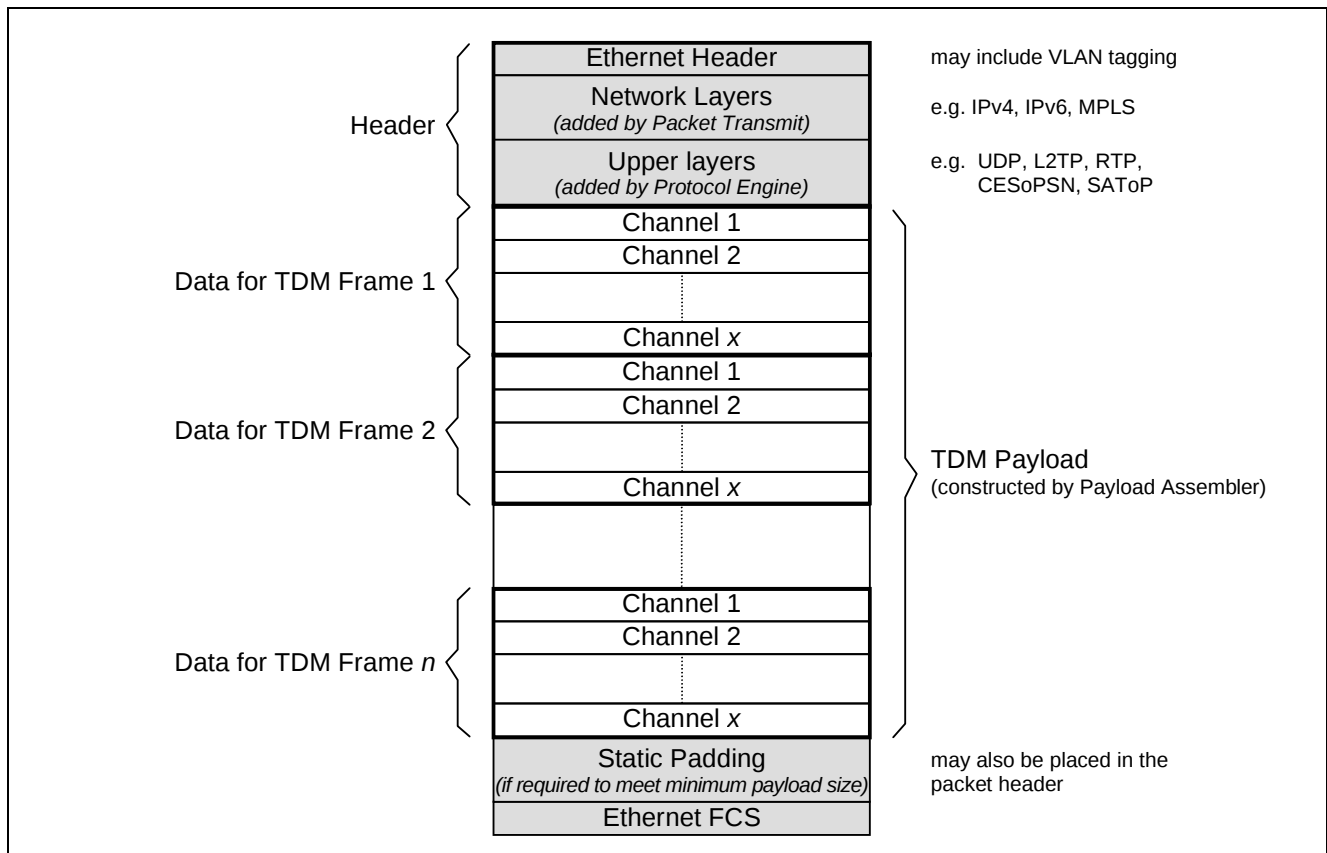
#### 5.4.1 Structured Payload Operation

In structured mode a context may contain any number of 64 kbps channels. These channels need not be contiguous and they may be selected from any input stream.

Channels may be added or deleted dynamically from a context. This feature can be used to optimize bandwidth utilisation. Modifications to the context are synchronised with the start of a new packet.

The fixed header at the start of each packet is added by the Packet Transmit block. This consists of up to 64 bytes, containing the Ethernet header, any upper layer protocol headers, and the two byte context descriptor field (see section below). The header is entirely user programmable, enabling the use of any protocol.

The payload header and size must be chosen so that the overall packet size is not less than 64 bytes, the Ethernet standard minimum packet size. Where this is likely to be the case, the header or data must be padded (as shown in Figure 15 and Figure 17) to ensure the packet is large enough. This padding is added by the ZL50110/11/12/14 for most applications.



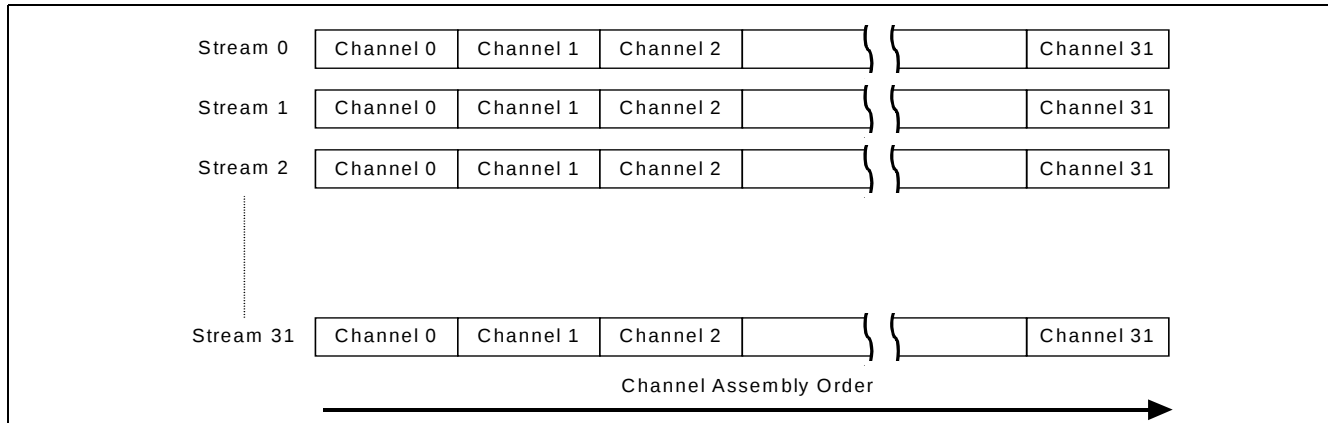
**Figure 15 - ZL50110/11/12/14 Packet Format - Structured Mode**

In applications where large payloads are being used, the payload size must be chosen such that the overall packet size does not exceed the maximum Ethernet packet size of 1518 bytes (1522 bytes with VLAN tags). Figure 15

shows the packet format for structured TDM data, where the payload is split into frames, and each frame concatenated to form the packet.

#### 5.4.1.1 Structured Payload Order

Packets are assembled sequentially, with each channel placed into the packet as it arrives at the TDM Access Interface. A fixed order of channels is maintained (see Figure 16), with channel 0 placed before channel 1, which is placed before channel 2. It is this order that allows the packet to be correctly disassembled at the far end. A context must contain only unique channel numbers. As such a context that contains the same channel from different streams, for example channel 1 from stream 2 and channel 1 from stream 5, would not be permitted.

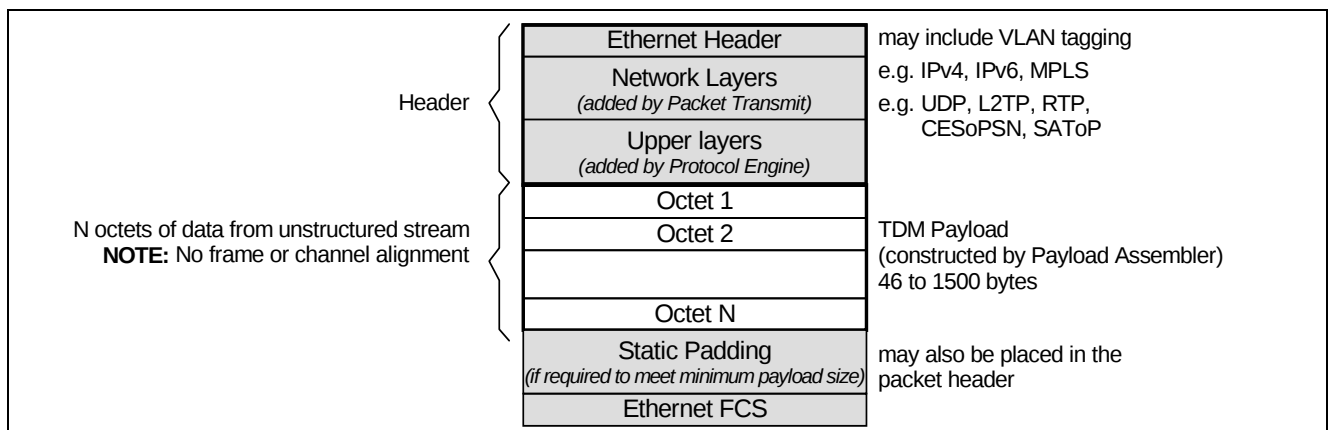


**Figure 16 - Channel Order for Packet Formation**

Each packet contains one or more frames of TDM data, in sequential order. This groups the selected channels for the first frame, followed by the same set of channels for the subsequent frame, and so on.

#### 5.4.2 Unstructured Payload Operation

In unstructured mode, the payload is not split by defined frames or timeslots, so the packet consists of a continuous stream of data. Each packet contains a programmable number of octets, as shown in Figure 17. The number of octets in a packet need not be an integer number of frames. A typical value for N may be 192, as defined in the IETF PWE3 RFC. For example, consider mapping the unstructured data of a 25 timeslot DS0 stream. The data for each T1 frame would normally consist of 193 bits, 192 data bits and 1 framing bit. If the payload consists of 24 octets it will be 1 bit short of a complete frames worth of data, if the payload consists of 25 octets it will be 7 bits over a complete frames worth of data. **NOTE:** No alignment of the octets with the T1 framing structure can be assumed.



**Figure 17 - ZL50110/11/12/14 Packet Format - Unstructured Mode**

Note: To change the packet size of a context, first close the context and then re-open the context with a new packet size.

## 5.5 Protocol Engine

In general, the next processing block for TDM packets is the Protocol Engine. This handles the data-plane requirements of the main higher level protocols (layers 4 and 5) expected to be used in typical applications of the ZL50110/11/12/14 family: UDP, RTP, L2TP, CESoPSN and SAToP. The Protocol Engine can add a header to the datagram containing up to 24 bytes. This header is largely static information, and is programmed directly by the CPU. It may contain a number of dynamic fields, including a length field, checksum, sequence number and a timestamp. The location, and in some cases the length of these fields is also programmable, allowing the various protocols to be placed at variable locations within the header.

## 5.6 Packet Transmission

Packets ready for transmission are queued to the switch fabric interface by the Queue Manager. Four classes of service are provided, allowing some packet streams to be prioritized over others. On transmission, the Packet Transmit block appends a programmable header, which has been set up in advance by the control processor. Typically this contains the data-link and network layer headers (layers 2 and 3), such as Ethernet, IP (versions 4 and 6) and MPLS.

## 5.7 Packet Reception

Incoming data traffic on the packet interface is received by the MACs. The well-formed packets are forwarded to a packet classifier to determine the destination. When a packet is successfully classified the destination can be the TDM interface, the LAN interface or the host interface. TDM traffic is then further classified to determine the context it is intended for.

Each TDM interface context has an individual queue, and the TDM re-formatting process re-creates the TDM streams from the incoming packet streams. This queue is used as a jitter buffer, to absorb variation in packet delay across the network. The size of the jitter buffer can be programmed in units of TDM frames (i.e., steps of 125  $\mu$ s).

There is also a queue to the host interface, allowing a traffic flow to the host CPU for processing. Again the host's DMA controller can be used to retrieve packet data and write it out into the CPU's own memory.

## 5.8 TDM Formatter

At the receiving end of the packet network, the original TDM data must be re-constructed from the packets received. This is known as re-formatting, and follows the reverse process from the Payload Assembler. The TDM Formatter plays out the packets in the correct sequence, directing each octet to the selected timeslot on the output TDM interface.

When lost or late packets are detected, the TDM Formatter plays out underrun data for the same number of TDM frames as were included in the missing packet. Underrun data can either be the last value played out on that timeslot, or a pre-programmed value (e.g., 0xFF). If the packet subsequently turns up it is discarded. In this way, the end-to-end latency through the system is maintained at a constant value.

Contexts in the Packet to TDM direction are placed in the UPDATE state when they are opened, pending first packet arrival. If a packet never arrives the context will remain in the UPDATE state. ZL5011x Design Manual section "13.1 Understanding forceDelete" describes the procedure to close receive contexts in the UPDATE state.

## 6.0 Clock Recovery

One of the main issues with circuit emulation is that the clock used to drive the TDM link is not necessarily linked into the central office reference clock, and hence may be any value within the tolerance defined for that service. The reverse link may also be independently timed, and operating at a slightly different frequency. In the plesiochronous digital hierarchy the difference in clock frequencies between TDM links is compensated for using bit stuffing techniques, allowing the clock to be accurately regenerated at the remote end of the carrier network.

With a packet network, that connection between the ingress and egress frequency is broken, since packets are discontinuous in time. From Figure 6, the TDM service frequency  $f_{service}$  at the customer premises must be exactly reproduced at the egress of the packet network. The consequence of a long-term mismatch in frequency is that the queue at the egress of the packet network will either fill up or empty, depending on whether the regenerated clock is slower or faster than the original. This will cause loss of data and degradation of the service.

The ZL50110/11/12/14 provides clock recovery function to reproduce the TDM service frequency at the egress of the packet network for structured and unstructured mode. Two schemes are employed, depending on the availability of a common reference clock at each provider edge unit, differential and adaptive.

The adaptive and differential algorithms assume that there are no bit errors in the received packet header sequence number or timestamp fields. If there are bit errors in the sequence number or timestamp fields, especially in the most significant bits, then it is likely to cause a temporary degradation of the recovered clock performance. It is advised to protect packets end-to-end (e.g., by using Ethernet FCS) such that packets with bit errors are discarded and do not impact the recovered clock performance.

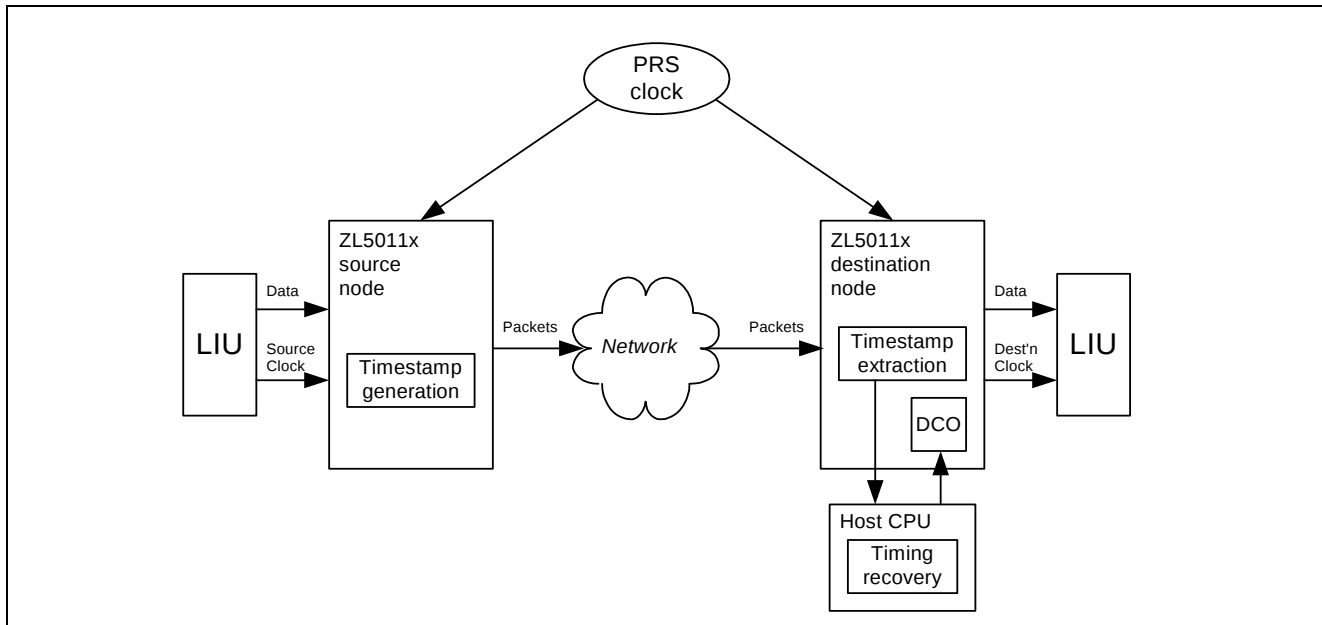
The clock recovery itself is performed by software in the host processor, with support from on-chip hardware to gather the required statistics.

### 6.1 Differential Clock Recovery

For applications where the wander characteristics of the recovered clock are very important, such as when the emulated circuit must be connected into the plesiochronous digital hierarchy (PDH), the ZL50110/11/12/14 also offers a differential clock recovery technique. This relies on having a common reference clock available at each provider edge point.

The differential algorithm assumes that the common clock is always present. There is no internal holdover capability for the common clock source (e.g. TDM\_CLKIP). If the availability of the common clock can not be guaranteed, then it is recommended to use an external DPLL with holdover capability to provide a clock source at all times. The external DPLL may enter holdover while the common clock is absent to maintain a relatively close frequency to the original common clock.

In a differential technique, the timing of data packet formation is sent relative to the common reference clock. Since the same reference is available at the packet egress point and the packet size is fixed, the original service clock frequency can be recovered. This technique is unaffected by any low frequency components in the packet delay variation. The disadvantage is the requirement for a common reference clock at each end of the packet network, which could either be the central office TDM clock, or provided by a global position system (GPS) receiver.



**Figure 18 - Differential Clock Recovery**

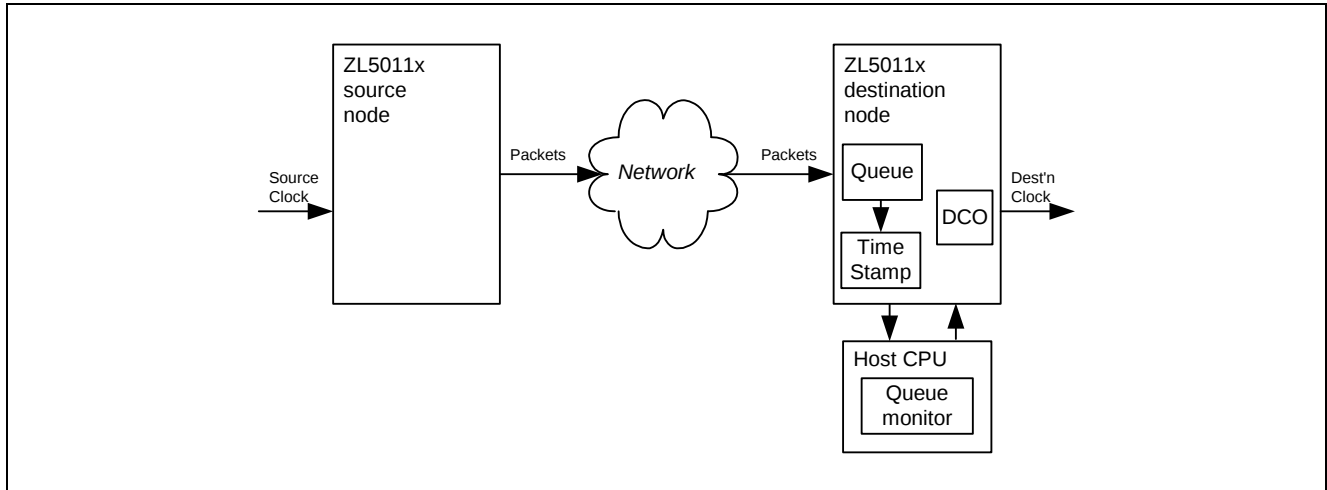
For in-band differential algorithm, the ZL50110/11/12/14 inserts the timestamp after the packet payload is fully assembled. The insertion-time may be in error by up to 8 UI of the nominal service clock (for example  $8 * 488 \text{ ns}$  of an E1 interface). This variable error will occur in unstructured mode only, and result in degradation of performance at the remote end, which uses the timestamps to recover a clock frequency. This error is most likely to occur when there are many asynchronous (PDH) clocks that are close in frequency. In this case it is recommended to use the Zarlink proprietary in-band differential.

Also, for in-band differential clock recovery, the frequency must be the same as the common clock frequency.

## 6.2 Adaptive Clock Recovery

For applications where there is no common reference clock between provider edge units, an adaptive clock recovery technique is provided. The Adaptive clock recovery solution provided in the Zarlink CESoP products is a combination hardware and software. The chip contains a DCO per TDM port in unstructured mode, that enables the recovery of up to 32 independent clocks. The timing algorithm resides in the API and runs out of the host processor. The basic information is transmitted using timestamps. Current CES standards allow for using of timestamps. Timestamps may be implied by the value of the sequence numbers, or it can be formatted as RTP timestamps. When a packet containing TDM data is sent, an RTP timestamp and/or sequence number is placed into the packet header. On arrival at the receiving device, the arrival time is noted in the form of a local timestamp, driven by the output clock of the TDM port it is destined for.

The recovered clock at the egress point of the ZL50110/11/12/14 is based on non-linear filtering of the timestamps that are carried in the CESoP packets. The performance of the clock recovery is greatly improved by applying these non-linear filtering techniques. The adaptive clock recovery performance is dependent on the network configuration and operation, if the loading of the network is constrained, then the wander of the recovered clock will not exceed the specified limits.

**Figure 19 - Adaptive Clock Recovery**

### 6.3 SYSTEM\_CLK Considerations

The quality of the 100 MHz SYSTEM\_CLK or the oscillator that drives SYSTEM\_CLK directly impacts the adaptive clock recovery performance. Zarlink has a recommended oscillator and guidelines for the selection of an oscillator. Please refer to ZL5011x Design Manual section “3.6 System Clock Block” before choosing an oscillator.

## 7.0 System Features

### 7.1 Latency

The following lists the intrinsic processing latency of the ZL50110/11/12/14, regardless of the number of active channels or contexts.

- TDM to Packet transmission processing latency less than 125  $\mu$ s
- Packet to TDM transmission processing latency less than 250  $\mu$ s (unstructured)
- Packet to TDM transmission processing latency less than 250  $\mu$ s (structured, more than 16 channels in context)
- Packet to TDM transmission processing latency less than 375  $\mu$ s (structured, 16 or less channels in context)

End-to-end latency may be estimated as the transmit latency + packet network latency + receive latency. The transmit latency is the sum of the transmit processing and the number of frames per packet x 125  $\mu$ s. The receive latency is the sum of the receive processing and the delay through the jitter buffer which is programmed to compensate for packet network PDV.

The ZL50110/11/12/14 is capable of creating an extremely low latency connection, with end to end delays of less than 0.5 ms, depending on user configuration.

### 7.2 Loopback Modes

The ZL50110/11/12/14 devices support loopback of the TDM circuits and the circuit emulation packets.

TDM loopback is achieved by first packetizing the TDM circuit as normal via the TDM Interface and Payload Assembly blocks. The packetized data is then routed by the Task Manager back to the same TDM port via the TDM Formatter and TDM Interface.

Loopback of the emulated services is achieved by redirecting classified packets from the Packet Receive blocks, back to the packet network. The Packet Transmit blocks are setup to strip the original header and add a new header directing the packets back to the source.

### 7.3 Host Packet Generation

The control processor can generate packets directly, allowing it to use the network for out-of-band communications. This can be used for transmission of control data or network setup information, e.g., routing information. The host interface can also be used by a local resource for network transmission of processed data.

The device supports dual address DMA transfers of packets to and from the CPU memory, using the host's own DMA controller. Table 27 illustrates the maximum bandwidths achievable by an external DMA master.

| DMA Path                     | Packet Size | Max Bandwidth Mbps <sup>1</sup> |
|------------------------------|-------------|---------------------------------|
| ZL50110/11/12/14 to CPU only | >1000 bytes | 50                              |
| ZL50110/11/12/14 to CPU only | 60 bytes    | 6.7                             |
| CPU to ZL50110/11/12/14 only | >1000 bytes | 60                              |
| CPU to ZL50110/11/12/14 only | 60 bytes    | 43                              |
| Combined <sup>2</sup>        | >1000 bytes | 58 (29 each way)                |
| Combined <sup>2</sup>        | 60 bytes    | 11 (5.5 each way)               |

**Table 27 - DMA Maximum Bandwidths**

Note 1: Maximum bandwidths are the maximum the ZL50110/11/12/14 devices can transfer under host control, and assumes only minimal packet processing by the host.

Note 2: Combined figures assume the same amount of data is to be transferred each way.

Note 3: DMA with external memory must use single packet mode. Refer to ZL5011x Design Manual for details.

## 7.4 Loss of Service (LOS)

During normal operation, a situation may arise where a Loss of Service occurs. This may be caused by a disruption in the transmission line due to engineering works or cable disconnection, for example. The locally detected LOS should be transferred across the emulated T1/E1 to the far end. The far end, in turn, should propagate AIS downstream.

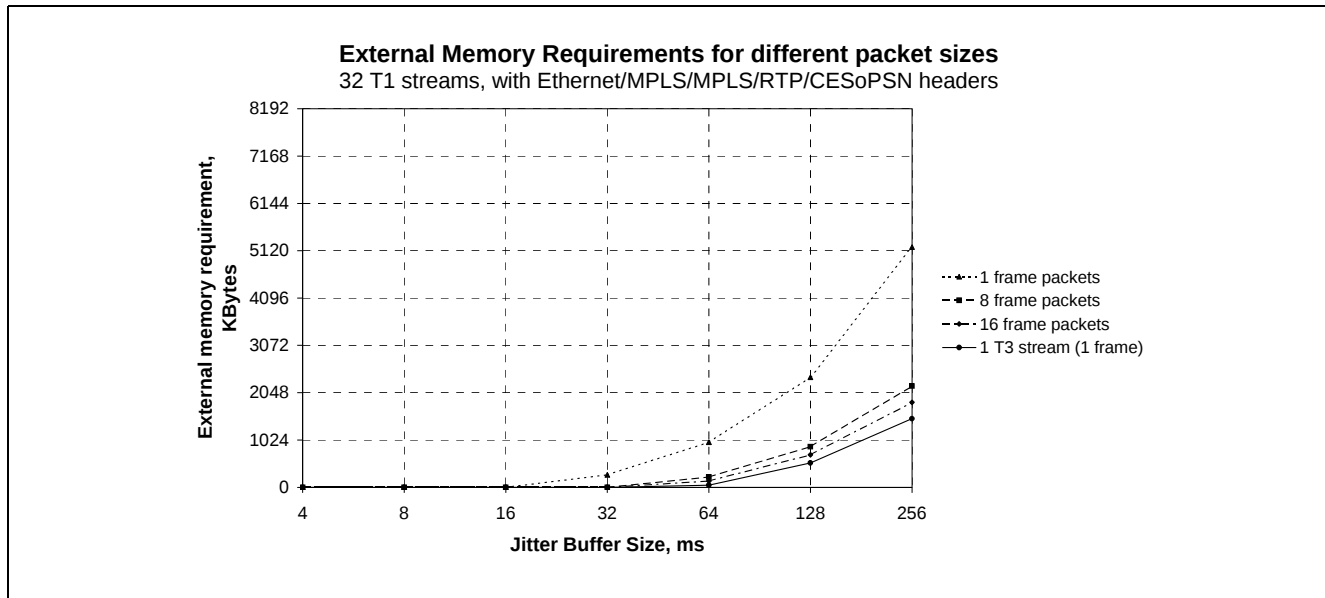
The handling of LOS over a CESoP connection is typically performed using (setting/clearing) the L bit in the CESoPSN or SAToP control word of the packet header.

Refer to ZL5011x Design Manual section “3.1.1 Connection to LIU” for details on a variety of different ways that LOS may be handled in an application.

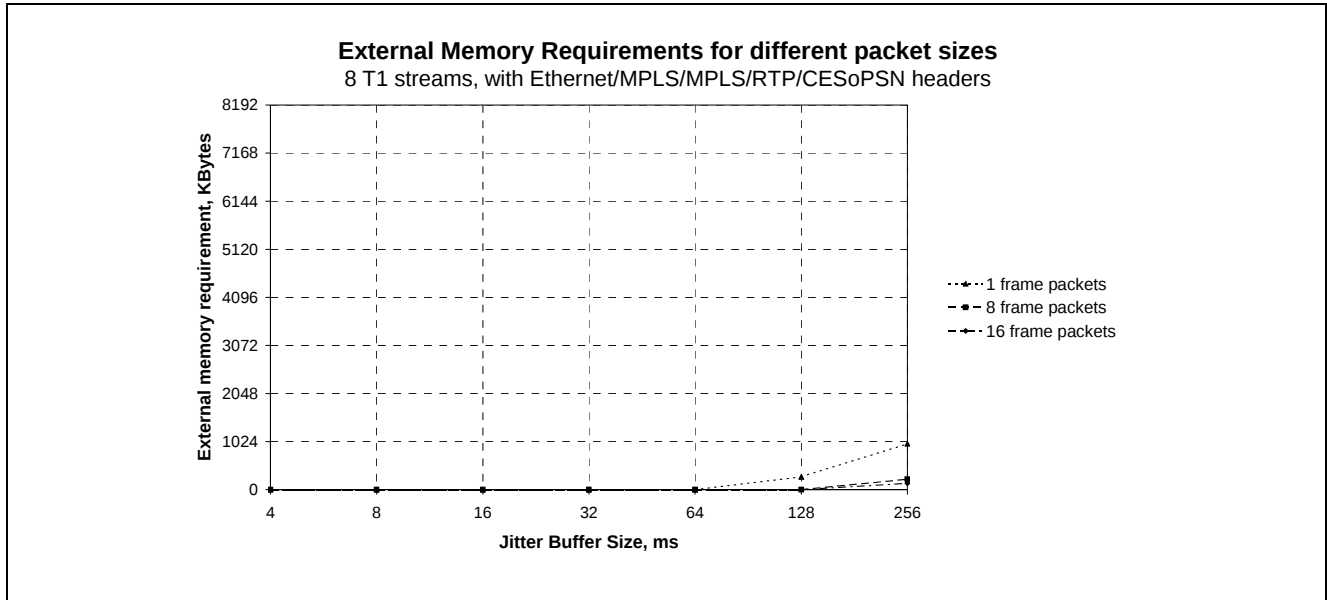
## 7.5 External Memory Requirement

The ZL50110/11/12/14 family includes a large amount of on-chip memory, such that for most applications, external memory will not be required. However, for certain combinations of header size, packet size and jitter buffer size, there may be a requirement for external memory. Therefore the device allows the connection of up to 8 Mbytes of synchronous ZBT-SRAM.

The following charts show how much memory is required by the ZL50111 (32 T1 streams) and the ZL50110 (8 T1 streams) for a variety of packet sizes (expressed in number of frames of TDM data) and jitter buffer sizes. It is assumed that each packet contains a full Ethernet/MPLS/MPLS/RTP/CESoPSN header.



**Figure 20 - External Memory Requirement for ZL50111**



**Figure 21 - External Memory Requirement for ZL50110**

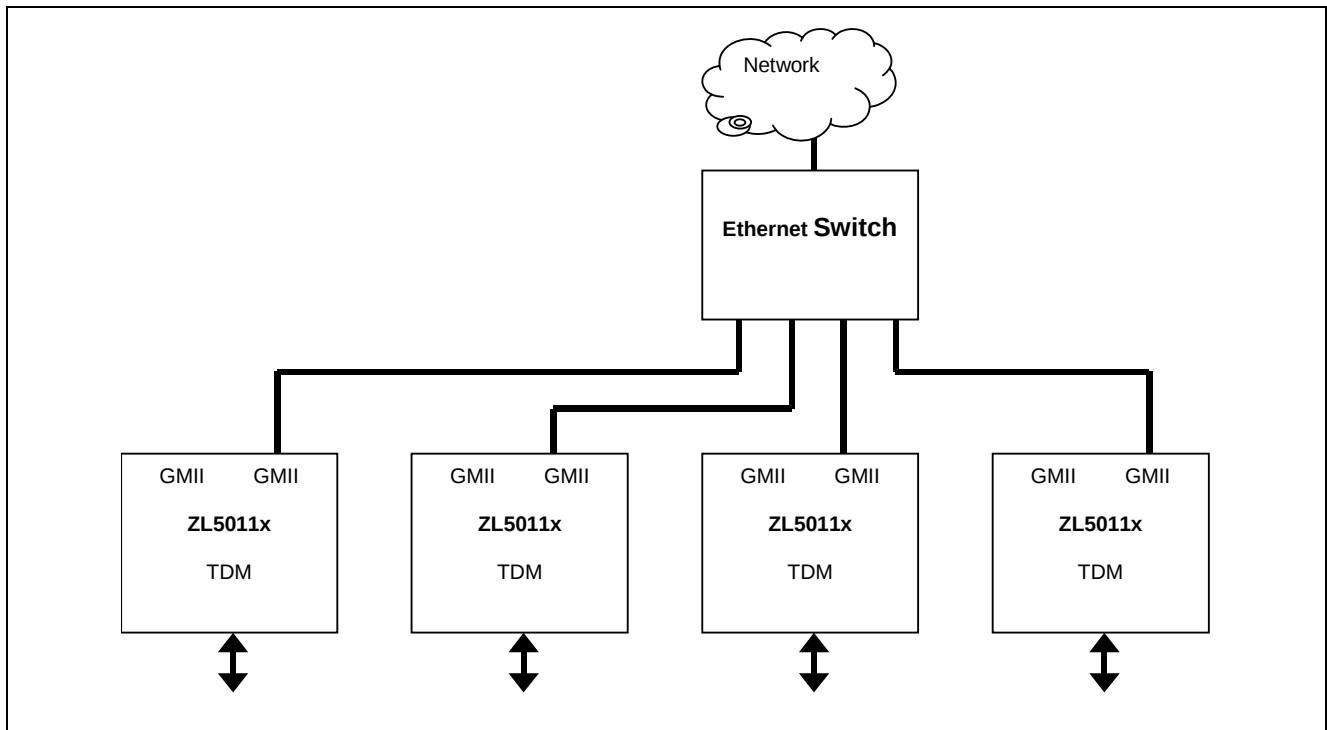
## 7.6 GIGABIT Ethernet - Recommended Configurations

**NOTE:** In GMII/TBI mode only 1 GMAC port may be used. The second GMAC port is for redundancy purposes only.

This section outlines connection methods for the ZL50110/11/12/14 in a Gigabit Ethernet environment recommended to ensure optimum performance. Two areas are covered:

- Central Ethernet Switch
- Redundant Ethernet Switch

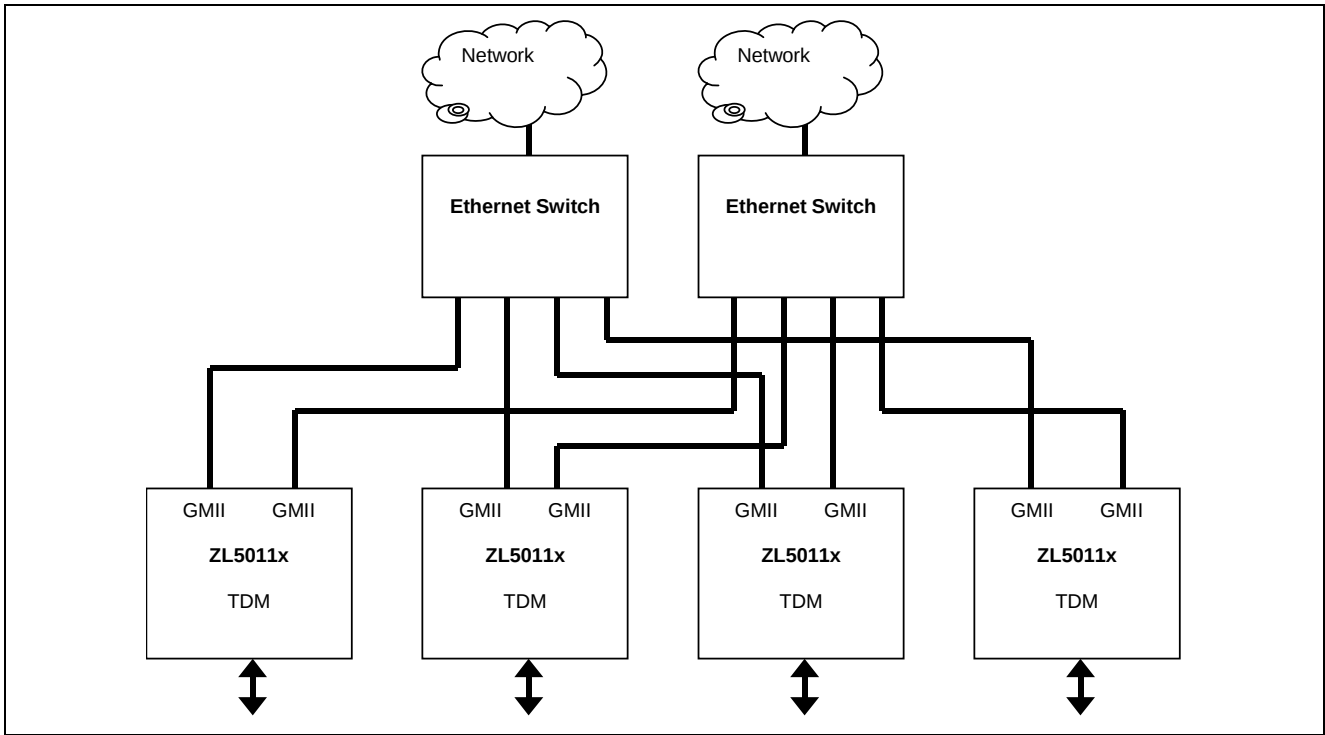
### 7.6.1 Central Ethernet Switch



**Figure 22 - Gigabit Ethernet Connection - Central Ethernet Switch**

TDM data and control packets are directed to the appropriate ZL50110/11/12/14 device through the Ethernet Switch. There is no limit on the number of ZL50110/11/12/14 devices that can be connected in this configuration.

### 7.6.2 Redundant Ethernet Switch



**Figure 23 - Gigabit Ethernet Connection - Redundant Ethernet Switch**

The central Ethernet Switch configuration can be extended to include a redundant switch connected to the second ZL50110/11/12/14 GMII port. One port should be used for all the TDM-to-Packet and Packet-to-TDM data with the other port idle. If the current port fails then data must be transferred to the spare port.

### 7.7 Power Up sequence

To power up the ZL50110/11/12/14 the following procedure must be used:

- The I/O supply should lead the Core supply, or both can be brought up together
- The I/O supply must never exceed the Core supply by more than 2.0VDC
- The Core supply must never exceed the I/O supply by more than 0.5VDC
- The System Reset and the JTAG Reset must remain low until at least 100  $\mu$ s after the 100 MHz system clock has stabilised. Note that if JTAG Reset is not used it must be tied low.

This is illustrated in the diagram shown in Figure 24.

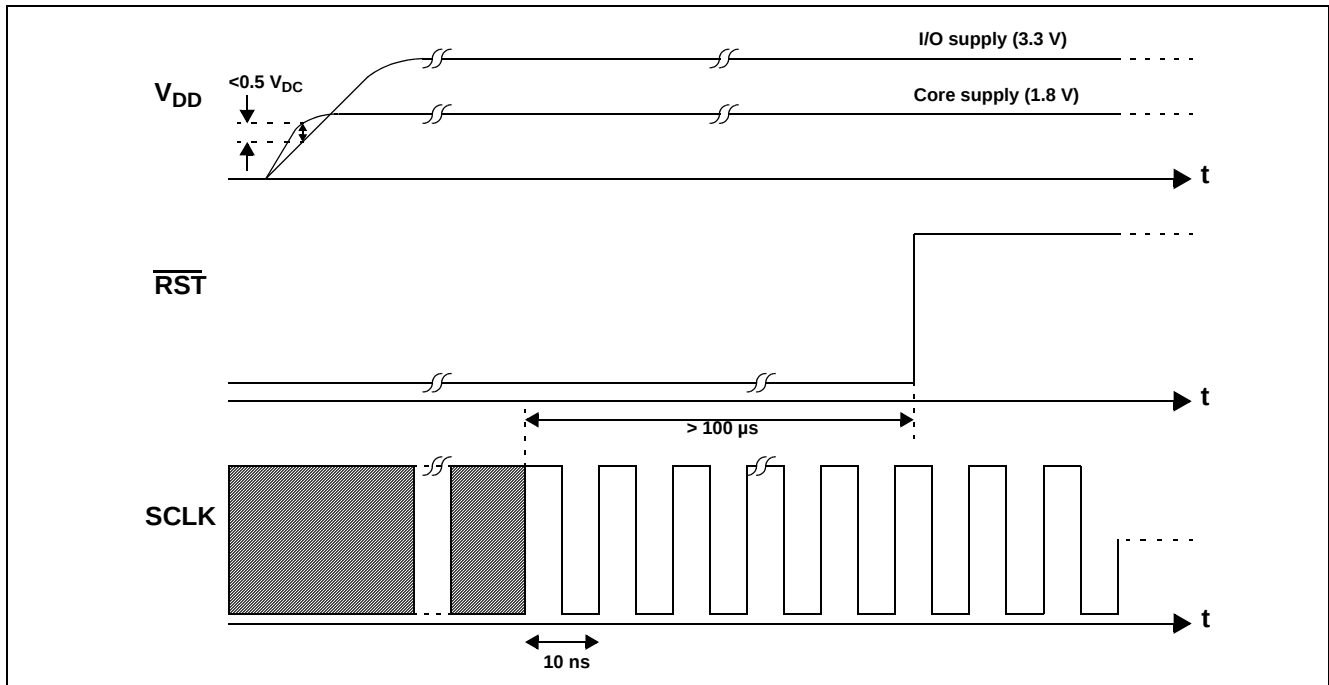


Figure 24 - Powering Up the ZL50110/11/12/14

## 7.8 JTAG Interface and Board Level Test Features

The JTAG interface is used to access the boundary scan logic for board level production testing.

## 7.9 External Component Requirements

### 7.9.1 Host Processor

ZL50110/11/12/14 family offers direct connection to PowerQUICC™ II (MPC8260) host processor and associated memory, but can support other processors with appropriate interface logic.

### 7.9.2 Other components

- TDM Framers and/or Line Interface Units
- Ethernet PHY for each MAC port
- Optional ZBT-SRAM for extended packet memory buffer depth

## 7.10 Miscellaneous Features

- System clock speed of 100 MHz
- Host clock speed of up to 66 MHz
- Debug option to freeze all internal state machines
- JTAG (IEEE1149) Test Access Port
- 3.3 V I/O Supply rail with 5 V tolerance
- 1.8 V Core Supply rail
- Fully compatible with the MT90880/1/2/3 Zarlink products

## 7.11 Test Modes Operation

### 7.11.1 Overview

The ZL50110/11/12/14 family supports the following modes of operation.

#### 7.11.1.1 System Normal Mode

This mode is the device's normal operating mode. Boundary scan testing of the peripheral ring is accessible in this mode via the dedicated JTAG pins. The JTAG interface is compliant with the IEEE Std. 1149.1-2001; Test Access Port and Boundary Scan Architecture.

Each variant has its own dedicated .bsdl file which fully describes its boundary scan architecture.

#### 7.11.1.2 System Tri-State Mode

All output and I/O output drivers are tri-stated allowing the device to be isolated when testing or debugging the development board.

### 7.11.2 Test Mode Control

The System Test Mode is selected using the dedicated device input bus TEST\_MODE[2:0] as follows in Table 28.

| System Test Mode   | test_mode[2:0] |
|--------------------|----------------|
| SYS_NORMAL_MODE    | 3'b000         |
| SYS_TRI_STATE_MODE | 3'b011         |

**Table 28 - Test Mode Control**

#### 7.11.3 System Normal Mode

Selected by TEST\_MODE[2:0] = 3'b000. As the test\_mode[2:0] inputs have internal pull-downs this is the default mode of operation if no external pull-up/downs are connected. The GPIO[15:0] bus is captured on the rising edge of the external reset to provide internal bootstrap options. After the internal reset has been de-asserted the GPIO pins may be configured by the ADM module as either inputs or outputs.

#### 7.11.4 System Tri-state Mode

Selected by TEST\_MODE[2:0] = 3'b011. All device output and I/O output drivers are tri-stated.

## 8.0 DPLL Specification

The ZL50110/11/12/14 family incorporates an internal DPLL that meets Telcordia GR-1244-CORE Stratum 4/4E requirements, assuming an appropriate clock oscillator is connected to the system clock pin. It will meet the jitter/wander tolerance, jitter/wander transfer, intrinsic jitter/wander, frequency accuracy, capture range, phase change slope, holdover frequency and MTIE requirements for these specifications. In structured mode with the ZL50110/11/12/14 device operating as a master the DPLL is used to provide clock and frame reference signals to the internal and external TDM infrastructure. In structured mode, with the ZL50110/11/12/14 device operating as a slave, the DPLL is not used. All TDM clock generation is performed externally and the input streams are synchronised to the system clock by the TDM interface. The DPLL is not required in unstructured mode (hence it is not available) because the TDM clocks and frame signals are generated by internal DCO's assigned to each individual stream.

### 8.1 Modes of Operation

It can be set into one of four operating modes: Locking mode, Holdover mode, Freerun mode and Powerdown mode.

#### 8.1.1 Locking Mode (normal operation)

The DPLL accepts a reference signal from either a primary or secondary source, providing redundancy in the event of a failure. These references should have the same nominal frequencies but do not need to be identical as long as their frequency offsets meet the appropriate Stratum requirements. Each source is selected from any one of the available TDM input stream clocks (up to 32 on the ZL50111 variant), or from the external TDM\_CLKiP (primary) or TDM\_CLKiS (secondary) input pins, as illustrated in Figure 14 - on page 61. It is possible to supply a range of input frequencies as the DPLL reference source, depicted in Table 29. The PRD register Value is the number (in hexadecimal) that must be programmed into the PRD register within the DPLL to obtain the divided down frequency at PLL\_PRI or PLL\_SEC.

| Source Input Frequency (MHz) | Tolerance ( $\pm$ ppm) | Divider Ratio | PRD/SRD Register Value (Hex) (Note 1) | Frequency at PLL_PRI or PLL_SEC (MHz) | Maximum Acceptable Input Wander tolerance (UI) (Note 2) |
|------------------------------|------------------------|---------------|---------------------------------------|---------------------------------------|---------------------------------------------------------|
| 0.008                        | 30                     | 1             | 1                                     | 0.008                                 | $\pm 1$                                                 |
| 1.544                        | 130                    | 1             | 1                                     | 1.544                                 | $\pm 1023$                                              |
| 2.048                        | 50                     | 1             | 1                                     | 2.048                                 | $\pm 1023$                                              |
| 4.096                        | 50                     | 1             | 1                                     | 4.096                                 | $\pm 1023$                                              |
| 8.192                        | 50                     | 1             | 1                                     | 8.192                                 | $\pm 1023$                                              |
| 16.384                       | 50                     | 1             | 1                                     | 16.384                                | $\pm 1023$                                              |
| 6.312                        | 30                     | 1             | 1                                     | 6.312                                 | $\pm 1023$                                              |
| 22.368                       | 20                     | 2796          | AEC                                   | 0.008                                 | $\pm 1$ (on 64k Hz)                                     |
| 34.368                       | 20                     | 537           | 219                                   | 0.064                                 | $\pm 1$ (on 64 kHz)                                     |
| 44.736 (Note 3)              | 20                     | 699           | 2BB                                   | 0.064                                 | $\pm 1$ (on 64 kHz)                                     |

**Table 29 - DPLL Input Reference Frequencies**

Note 1: A PRD/SRD value of 0 will suppress the clock, and prevent it from reaching the DPLL.

Note 2: UI means Unit Interval - in this case periods of the time signal. So  $\pm 1$ UI on a 64 kHz signal means  $\pm 15.625 \mu\text{s}$ , the period of the reference frequency. Similarly  $\pm 1023$ UI on a 4.096 MHz signal means  $\pm 250 \mu\text{s}$ .

Note 3: This input frequency is supported with the use of an external divide by 2.

The maximum lock-in range can be programmed up to  $\pm 372$  ppm regardless of the input frequency. The DPLL will fail to lock if the source input frequency is absent, if it is not of approximately the correct frequency or if it is too jittery. See Section 8.7 for further details. The Application Program Interface (API) software that accompanies the ZL50110/11/12/14 family can be used to automatically set up the DPLL for the appropriate standard requirement.

The DPLL lock-in range can be programmed using the Lock Range register (see ZL50110/11/12/14 Programmers Model document) in order to extend or reduce the capture envelope. The DPLL provides bit-error-free reference switching, meeting the specification limits in the Telcordia GR-1244-CORE standard. If Stratum 4/4E accuracy is not required, it is possible to use a more relaxed system clock tolerance.

The DPLL output consists of three signals; a common clock (comclk), a double-rate common clock (comclkx2), and a frame reference (8 kHz). These are used to time the internal TDM Interface, and hence the corresponding TDM infrastructure attached to the interface. The output clock options are either 2.048 Mbps (comclkx2 at 4.096 Mbps) or 8.192 Mbps (comclkx2 at 16.384 Mbps), determined by setup in the DPLL control register. The frame pulse is programmable for polarity and width.

### 8.1.2 Holdover Mode

In the event of a reference failure resulting in an absence of both the primary and secondary source, the DPLL automatically reverts to Holdover mode. The last valid frequency value recorded before failure can be maintained within the Stratum 3 limits of  $\pm 0.05$  ppm. The hold value is wholly dependent on the drift and temperature performance of the system clock. For example, a  $\pm 32$  ppm oscillator may have a temperature coefficient of  $\pm 0.1$  ppm/ $^{\circ}\text{C}$ . Thus a  $10^{\circ}\text{C}$  ambient change since the DPLL was last in the Locking mode will change the holdover frequency by an additional  $\pm 1$  ppm, which is much greater than the  $\pm 0.05$  ppm Stratum 3 specification. If the strict target of Stratum 3 holdover accuracy is not required, a less restrictive oscillator can be used for the system clock.

Holdover mode is typically used for a short period of time until network synchronisation is re-established.

### 8.1.3 Freerun Mode

In freerun mode the DPLL is programmed with a centre frequency, and can output that frequency within the Stratum 3 limits of  $\pm 4.6$  ppm. To achieve this the 100 MHz system clock must have an absolute frequency accuracy of  $\pm 4.6$  ppm. The centre frequency is programmed as a fraction of the system clock frequency.

### 8.1.4 Powerdown Mode

It is possible to “power down” the DPLL when it is not in use. For example, an unstructured TDM system, or use of an external DPLL would mean the internal DPLL could be switched off, saving power. The internal registers can still be accessed while the DPLL is powered down.

## 8.2 Reference Monitor Circuit

There are two identical reference monitor circuits, one for the primary and one for the secondary source. Each circuit will continually monitor its reference, and report the references validity. The validity criteria depends on the frequency programmed for the reference. A reference must meet all the following criteria to maintain validity:

- The “period in specified range” check is performed regardless of the programmed frequency. Each period must be within a range, which is programmable for the application. Refer to the ZL50110/11/12/14 programmers model for details.
- If the programmed frequency is 1.544 MHz or 2.048 MHz, the “n periods in specified range” check will be performed. The time taken for n cycles must be within a programmed range, typically with n at 64, the time taken for consecutive cycles must be between 62 and 66 periods of the programmed frequency.

The fail flags are independent of the preferred option for primary or secondary operation, will be asserted in the event of an invalid signal regardless of mode.

### 8.3 Locking Mode Reference Switching

When the reference source the DPLL is currently locking to becomes invalid, the DPLL's response depends on which one of the failure detect modes has been chosen: autodetect, forced primary, or forced secondary. One of these failure detect modes must be chosen via the FDM1:0 bits of the DOM register. After a device reset via the SYSTEM\_RESET pin, the autodetect mode is selected.

In autodetect mode (automatic reference switching) if both references are valid the DPLL will synchronise to the preferred reference. If the preferred reference becomes unreliable, the DPLL continues driving its output clock in a stable holdover state until it makes a switch to the backup reference. If the preferred reference recovers, the DPLL makes a switch back to the preferred reference. If necessary, the switch back can be prevented by changing the preferred reference using the REFSEL bit in the DOM register, after the switch to the backup reference has occurred.

If both references are unreliable, the DPLL will drive its output clock using the stable holdover values until one of the references becomes valid.

In forced primary mode, the DPLL will synchronise to the primary reference only. The DPLL will not switch to the secondary reference under any circumstances including the loss of the primary reference. In this condition, the DPLL remains in holdover mode until the primary reference recovers. Similarly in forced secondary mode, the DPLL will synchronise to the secondary reference only, and will not switch to the primary reference. Again, a failure of the secondary reference will cause the DPLL to enter holdover mode, until such time as the secondary reference recovers. The choice of preferred reference has no effect in these modes.

When a conventional PLL is locked to its reference, there is no phase difference between the input reference and the PLL output. For the DPLL, the input references can have any phase relationship between them. During a reference switch, if the DPLL output follows the phase of the new reference, a large phase jump could occur. The phase jump would be transferred to the TDM outputs. The DPLL's MTIE (Maximum Time Interval Error) feature preserves the continuity of the DPLL output so that it appears no reference switch had occurred. The MTIE circuit is not perfect however, and a small Time Interval Error is still incurred per reference switch. To align the DPLL output clock to the nearest edge of the selected input reference, the MTIE reset bit (MRST bit in the DOM register) can be used.

Unlike some designs, switching between references which are at different nominal frequencies do not require intervention such as a system reset.

### 8.4 Locking Range

The locking range is the input frequency range over which the DPLL must be able to pull into synchronization and to maintain the synchronization. The locking range is programmable up to  $\pm 372$  ppm.

Note that the locking range relates to the system clock frequency. If the external oscillator has a tolerance of -100 ppm, and the locking range is programmed to  $\pm 200$  ppm, the actual locking range is the programmed value shifted by the system clock tolerance to become -300 ppm to +100 ppm.

### 8.5 Locking Time

The Locking Time is the time it takes the synchroniser to phase lock to the input signal. Phase lock occurs when the input and output signals are not changing in phase with respect to each other (not including jitter).

Locking time is very difficult to determine because it is affected by many factors including:

- initial input to output phase difference
- initial input to output frequency difference
- DPLL Loop Filter
- DPLL Limiter (phase slope)

Although a short phase lock time is desirable, it is not always achievable due to other synchroniser requirements. For instance, better jitter transfer performance is obtained with a lower frequency loop filter which increases locking time; and a better (smaller) phase slope performance will increase locking time. Additionally, the locking time is dependent on the `p_shift` value.

The DPLL Loop Filter and Limiter have been optimised to meet the Telcordia GR-1244-CORE jitter transfer and phase alignment speed requirements. The phase lock time is guaranteed to be no greater than 30 seconds when using the recommended Stratum 3 and Stratum 4/4E register settings.

## 8.6 Lock Status

The DPLL has a Lock Status Indicator and a corresponding Lock Change Interrupt. The response of the Lock Status Indicator is a function of the programmed Lock Detect Interval (LDI) and Lock Detect Threshold (LDT) values in the `dpll_idetect` register. The LDT register can be programmed to set the jitter tolerance level of the Lock Status Indicator. To determine if the DPLL has achieved lock the Lock Status Indicator must be high for a period of at least 30 seconds. When the DPLL loses lock the Lock Status Indicator will go low after  $LDI \times 125 \mu s$ .

## 8.7 Jitter

The DPLL is designed to withstand, and improve inherent jitter in the TDM clock domain.

### 8.7.1 Acceptance of Input Wander

For T1(1.544 MHz), E1(2.048 MHz) and J2(6.312 MHz) input frequencies, the DPLL will accept a wander of up to  $\pm 1023 UI_{pp}$  at 0.1 Hz to conform with the relevant specifications. For the 8 kHz (frame rate) and 64 kHz (the divided down output for T3/E3) input frequencies, the wander acceptance is limited to  $\pm 1 UI$  (0.1 Hz). This principle is illustrated in Table 29.

### 8.7.2 Intrinsic Jitter

Intrinsic jitter is the jitter produced by a synchronizer and measured at its output. It is measured by applying a jitter free reference signal to the input of the device, and measuring its output jitter. Intrinsic jitter may also be measured when the device is in a non synchronizing mode such as free running or holdover, by measuring the output jitter of the device. Intrinsic jitter is usually measured with various band-limiting filters, depending on the applicable standards.

The intrinsic jitter in the DPLL is reduced to less than 1 ns p-p<sup>1</sup> by an internal Tapped Delay Line (TDL).

### 8.7.3 Jitter Tolerance

Jitter tolerance is a measure of the ability of a PLL to operate properly without cycle slips (i.e. remain in lock and/or regain lock in the presence of large jitter magnitudes at various jitter frequencies) when jitter is applied to its reference. The applied jitter magnitude and the jitter frequency depends on the applicable standards.

The DPLL's jitter tolerance can be programmed to meet Telcordia GR-1244-CORE DS1 reference input jitter tolerance requirements.

### 8.7.4 Jitter Transfer

Jitter transfer or jitter attenuation refers to the magnitude of jitter at the output of a device for a given amount of jitter at the input of the device. Input jitter is applied at various amplitudes and frequencies, and output jitter is measured with various filters depending on the applicable standards.

---

1. There are 2 exceptions to this. a) When reference is 8 kHz, and reference frequency offset relative to the master is small, jitter up to 1 master clock period is possible, i.e. 10 ns p-p. b) In holdover mode, if a huge amount of jitter had been present prior to entering holdover, then an additional 2 ns p-p is possible.

---

Since intrinsic jitter is always present, jitter attenuation will appear to be lower for small input jitter signals than larger ones. Consequently, accurate jitter transfer function measurements are usually made with large input jitter signals (e.g., 75% of the specified maximum jitter tolerance).

The internal DPLL is a first order type 2 component, so a frequency offset doesn't result in a phase offset. Stratum 3 requires a -3 dB frequency of less than 3 Hz. The nature of the filter results in some peaking, resulting in a -3 dB frequency of 1.9 Hz and a 0.08 dB peak with a system clock frequency of 100 MHz assuming a p\_shift value of 2. The transfer function is illustrated in Figure 25 and in more detail in Figure 26. Increasing the p\_shift value increases the speed the DPLL will lock to the required frequency and reduces the peak, but also reduces the tolerance to jitter - so the p\_shift value must be programmed correctly to meet Stratum 3 or Stratum 4/4E jitter transfer characteristics. This is done automatically in the API.

## 8.8 Maximum Time Interval Error (MTIE)

In order to meet several standards requirements, the phase shift of the DPLL output must be controlled. A potential phase shift occurs every time the DPLL is re-arranged by changing reference source signal, or the mode. In order to meet the requirements of Stratum 3, the DPLL will shift phase by no more than 20 ns per re-arrangement.

Additionally the speed at which the change occurs is also critical. A large step change in output frequency is undesirable. The rate of change is programmable using the skew register, up to a maximum of 15.4 ns / 125  $\mu$ s (124 ppm).

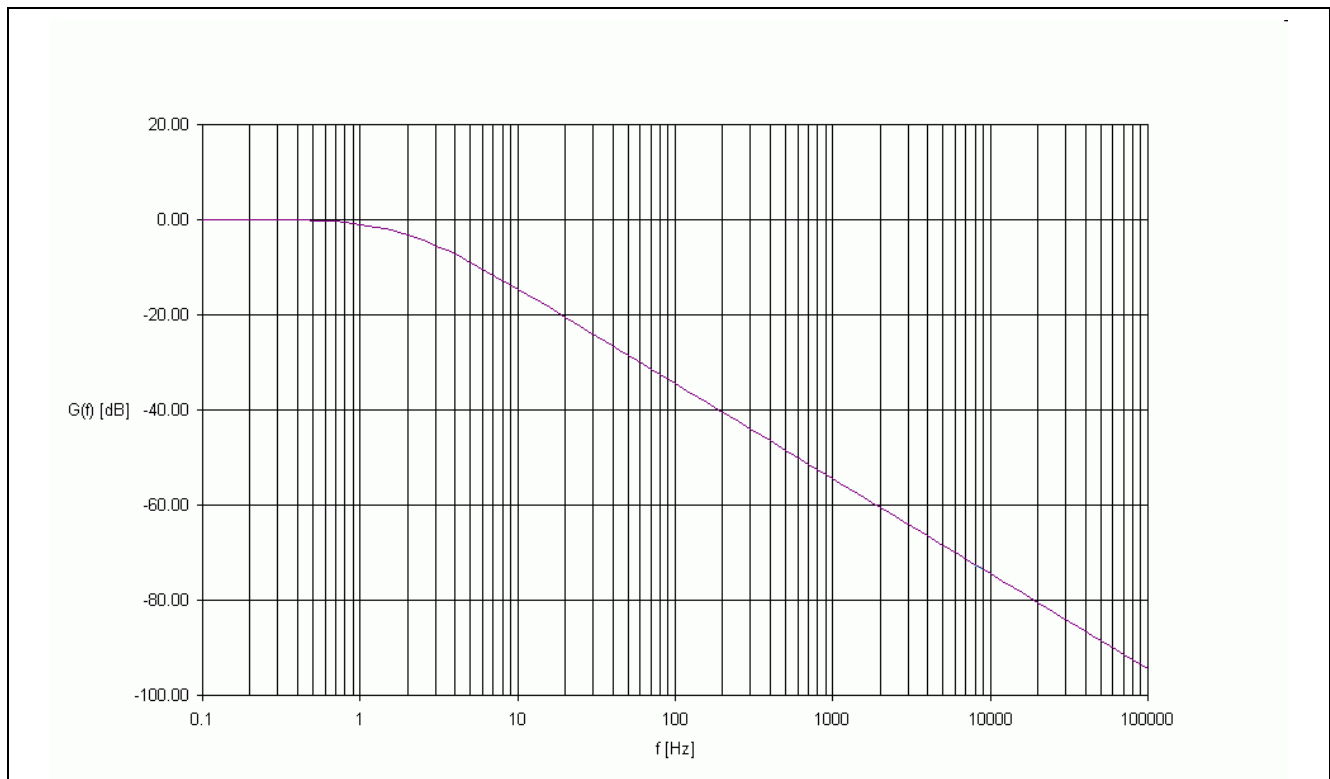
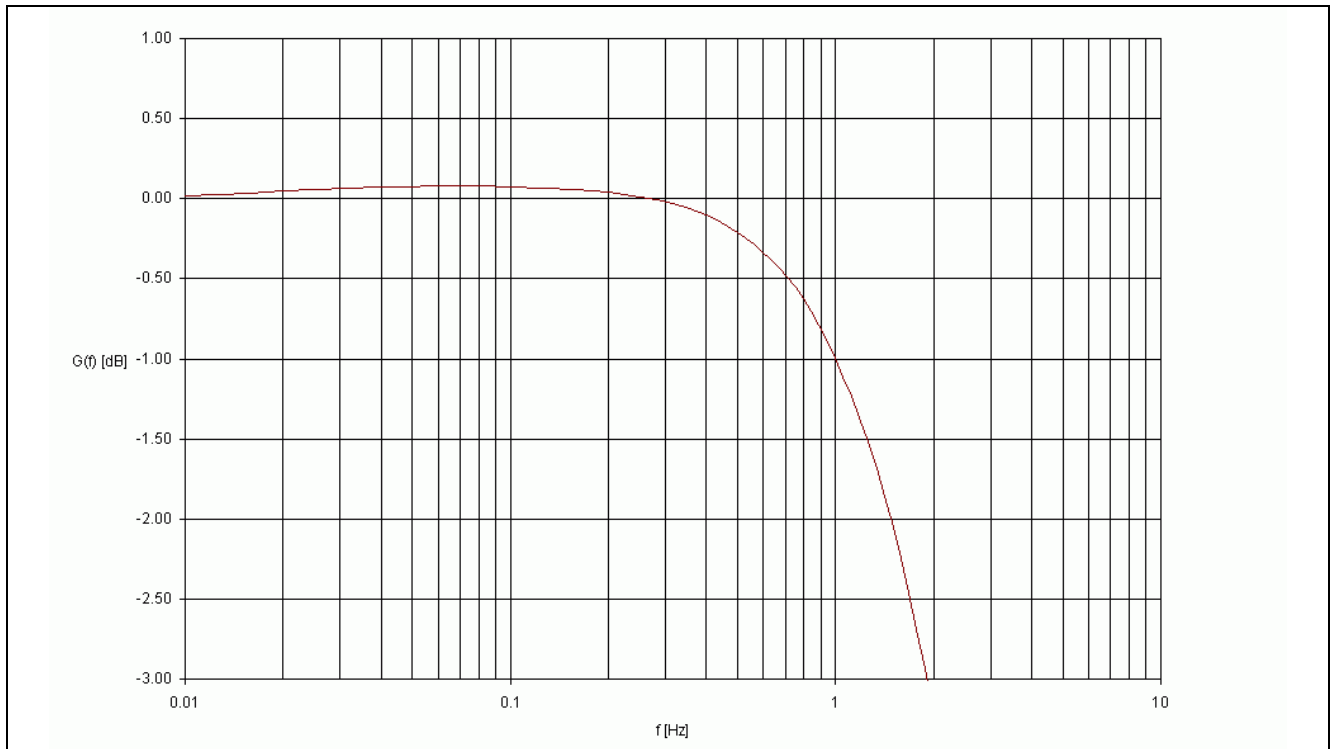


Figure 25 - Jitter Transfer Function



**Figure 26 - Jitter Transfer Function - Detail**

## 9.0 Memory Map and Register Definitions

All memory map and register definitions are included in the ZL50110/11/12/14 Programmers Model document.

## 10.0 DC Characteristics

### Absolute Maximum Ratings\*

| Parameter                             | Symbol         | Min. | Max.           | Units |
|---------------------------------------|----------------|------|----------------|-------|
| I/O Supply Voltage                    | $V_{DD\_IO}$   | -0.5 | 5.0            | V     |
| Core Supply Voltage                   | $V_{DD\_CORE}$ | -0.5 | 2.5            | V     |
| PLL Supply Voltage                    | $V_{DD\_PLL}$  | -0.5 | 2.5            | V     |
| Input Voltage                         | $V_I$          | -0.5 | $V_{DD} + 0.5$ | V     |
| Input Voltage (5 V tolerant inputs)   | $V_{I\_5V}$    | -0.5 | 7.0            | V     |
| Continuous current at digital inputs  | $I_{IN}$       | -    | $\pm 10$       | mA    |
| Continuous current at digital outputs | $I_O$          | -    | $\pm 15$       | mA    |
| Package power dissipation             | PD             | -    | 3              | W     |
| Storage Temperature                   | TS             | -55  | +125           | °C    |

\* Exceeding these figures may cause permanent damage. Functional operation under these conditions is not guaranteed. Voltage measurements are with respect to ground ( $V_{SS}$ ) unless otherwise stated.

\* The core and PLL supply voltages must never be allowed to exceed the I/O supply voltage by more than 0.5 V during power-up. Failure to observe this rule could lead to a high-current latch-up state, possibly leading to chip failure, if sufficient cross-supply current is available. To be safe ensure the I/O supply voltage supply always rises earlier than the core and PLL supply voltages.

### Recommended Operating Conditions

| Characteristics                        | Symbol         | Min. | Typ. | Max.         | Units | Test Condition |
|----------------------------------------|----------------|------|------|--------------|-------|----------------|
| Operating Temperature                  | $T_{OP}$       | -40  | 25   | +85          | °C    |                |
| Junction temperature                   | $T_J$          | -40  | -    | 125          | °C    |                |
| Positive Supply Voltage, I/O           | $V_{DD\_IO}$   | 3.0  | 3.3  | 3.6          | V     |                |
| Positive Supply Voltage, Core          | $V_{DD\_CORE}$ | 1.65 | 1.8  | 1.95         | V     |                |
| Positive Supply Voltage, Core          | $V_{DD\_PLL}$  | 1.65 | 1.8  | 1.95         | V     |                |
| Input Voltage Low - all inputs         | $V_{IL}$       | -    | -    | 0.8          | V     |                |
| Input Voltage High                     | $V_{IH}$       | 2.0  | -    | $V_{DD\_IO}$ | V     |                |
| Input Voltage High, 5V tolerant inputs | $V_{IH\_5V}$   | 2.0  | -    | 5.5          | V     |                |

Typical figures are at 25°C and are for design aid only, they are not guaranteed and not subject to production testing. Voltage measurements are with respect to ground ( $V_{SS}$ ) unless otherwise stated.

**DC Electrical Characteristics** - Typical characteristics are at 1.8 V core, 3.3 V I/O, 25°C and typical processing. The min. and max. values are defined over all process conditions, from -40 to 125°C junction temperature, core voltage 1.65 to 1.95 V and I/O voltage 3.0 and 3.6 V unless otherwise stated.

| Characteristics                       | Symbol         | Min. | Typ. | Max.    | Units.  | Test Condition                       |
|---------------------------------------|----------------|------|------|---------|---------|--------------------------------------|
| Input Leakage                         | $I_{LEIP}$     |      |      | $\pm 1$ | $\mu A$ | No pull up/down $V_{DD\_IO} = 3.6 V$ |
| Output (High impedance) Leakage       | $I_{LEOP}$     |      |      | 2       | $\mu A$ | No pull up/down $V_{DD\_IO} = 3.6 V$ |
| Input Capacitance                     | $C_{IP}$       |      | 1    |         | pF      |                                      |
| Output Capacitance                    | $C_{OP}$       |      | 4    |         | pF      |                                      |
| Pullup Current                        | $I_{PU}$       |      | -27  |         | $\mu A$ | Input at 0 V                         |
| Pullup Current, 5 V tolerant inputs   | $I_{PU\_5V}$   |      | -110 |         | $\mu A$ | Input at 0 V                         |
| Pulldown Current                      | $I_{PD}$       |      | 27   |         | $\mu A$ | Input at $V_{DD\_IO}$                |
| Pulldown Current, 5 V tolerant inputs | $I_{PD\_5V}$   |      | 110  |         | $\mu A$ | Input at $V_{DD\_IO}$                |
| Core 1.8 V supply current             | $I_{DD\_CORE}$ |      |      | 950     | mA      | Note 1,2                             |
| PLL 1.8 V supply current              | $I_{DD\_PLL}$  |      |      | 1.30    | mA      |                                      |
| I/O 3.3 V supply current              | $I_{DD\_IO}$   |      |      | 120     | mA      | Note 1,2                             |

Note 1: The IO and Core supply current worst case figures apply to different scenarios, e.g., internal or external memory and can not simply be summed for a total figure. For a clearer indication of power consumption, please refer to Section 12.0

Note 2: Worst case assumes the maximum number of active contexts and channels, i.e., 128 contexts/1024 channels. Figures are for the ZL50111. For an indication of power consumption by the ZL50110 and ZL50114, please refer to Section 12.0 and choose the appropriate memory configuration and number of contexts.

### Input Levels

| Characteristics            | Symbol   | Min. | Typ. | Max. | Units | Test Condition |
|----------------------------|----------|------|------|------|-------|----------------|
| Input Low Voltage          | $V_{IL}$ |      |      | 0.8  | V     |                |
| Input High Voltage         | $V_{IH}$ | 2.0  |      |      | V     |                |
| Positive Schmitt Threshold | $V_{T+}$ |      | 1.6  |      | V     |                |
| Negative Schmitt Threshold | $V_{T-}$ |      | 1.2  |      | V     |                |

### Output Levels

| Characteristics     | Symbol   | Min. | Typ. | Max. | Units | Test Condition                                                                                                                                |
|---------------------|----------|------|------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------|
| Output Low Voltage  | $V_{OL}$ |      |      | 0.4  | V     | $I_{OL} = 6 \text{ mA}$ .<br>$I_{OL} = 12 \text{ mA}$ for packet interface (m*) pins and GPIO pins.<br>$I_{OL} = 24 \text{ mA}$ for LED pins. |
| Output High Voltage | $V_{OH}$ | 2.4  |      |      | V     | $I_{OH} = 6 \text{ mA}$ .<br>$I_{OH} = 12 \text{ mA}$ for packet interface (m*) pins and GPIO pins.<br>$I_{OH} = 24 \text{ mA}$ for LED pins. |

## 11.0 AC Characteristics

### 11.1 TDM Interface Timing - ST-BUS

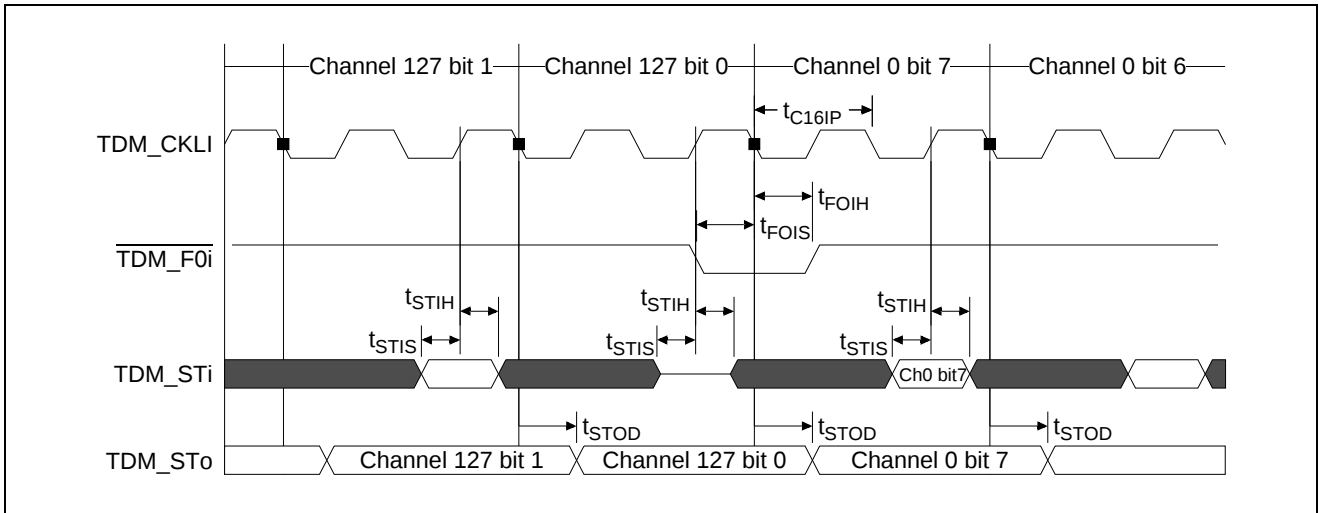
The TDM Bus either operates in Slave mode, where the TDM clocks for each stream are provided by the device sourcing the data, or Master mode, where the TDM clocks are generated from the ZL50110/11/12/14.

#### 11.1.1 ST-BUS Slave Clock Mode

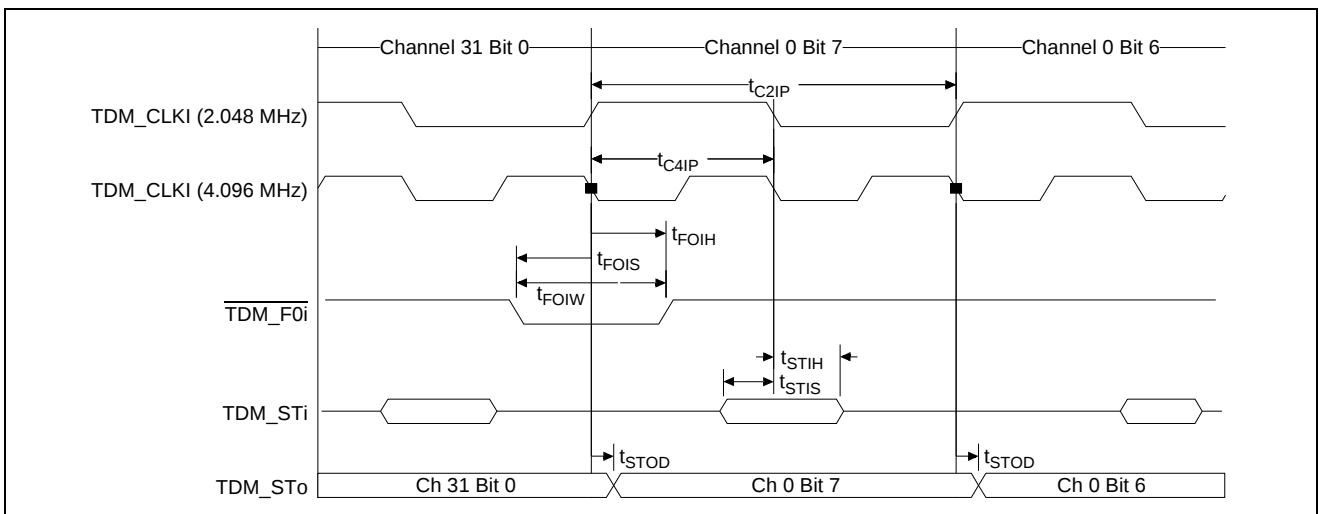
##### TDM ST-BUS Slave Timing Specification

| Data Format                  | Parameter                                 | Symbol      | Min.      | Typ.   | Max.     | Units | Notes                                             |
|------------------------------|-------------------------------------------|-------------|-----------|--------|----------|-------|---------------------------------------------------|
| ST-BUS<br>8.192 Mbps<br>mode | TDM_CLKi Period                           | $t_{C16IP}$ | 54        | 60     | 66       | ns    |                                                   |
|                              | TDM_CLKi High                             | $t_{C16IH}$ | 27        | -      | 33       | ns    |                                                   |
|                              | TDM_CLKi Low                              | $t_{C16IL}$ | 27        | -      | 33       | ns    |                                                   |
| ST-BUS<br>2.048 Mbps<br>mode | TDM_CLKi Period                           | $t_{C4IP}$  | -         | 244.1  | -        | ns    |                                                   |
|                              | TDM_CLKi High                             | $t_{C4IH}$  | 110       | -      | 134      | ns    |                                                   |
|                              | TDM_CLKi Low                              | $t_{C4IL}$  | 110       | -      | 134      | ns    |                                                   |
| All Modes                    | TDM_F0i Width<br>8.192 Mbps<br>2.048 Mbps | $t_{FOIW}$  | 50<br>200 | -<br>- | -<br>300 | ns    |                                                   |
|                              | TDM_F0i Setup Time                        | $t_{FOIS}$  | 5         | -      | -        | ns    | With respect to<br>TDM_CLKi<br>falling edge       |
|                              | TDM_F0i Hold Time                         | $t_{FOIH}$  | 5         | -      | -        | ns    | With respect to<br>TDM_CLKi<br>falling edge       |
|                              | TDM_STo Delay                             | $t_{STOD}$  | 1         | -      | 20       | ns    | With respect to<br>TDM_CLKi<br>Load $C_L = 50$ pF |
|                              | TDM_STi Setup Time                        | $t_{STIS}$  | 5         | -      | -        | ns    | With respect to<br>TDM_CLKi                       |
|                              | TDM_STi Hold Time                         | $t_{STIH}$  | 5         | -      | -        | ns    | With respect to<br>TDM_CLKi                       |

In synchronous mode the clock must be within the locking range of the DPLL to function correctly ( $\pm 245$  ppm). In asynchronous mode, the clock may be any frequency.



**Figure 27 - TDM ST-BUS Slave Mode Timing at 8.192 Mbps**



**Figure 28 - TDM ST-BUS Slave Mode Timing at 2.048 Mbps**

## 11.1.2 ST-BUS Master Clock Mode

| Data Format                  | Parameter                                     | Symbol           | Min.  | Typ.  | Max.  | Units | Notes                                 |
|------------------------------|-----------------------------------------------|------------------|-------|-------|-------|-------|---------------------------------------|
| ST-BUS<br>8.192 Mbps<br>mode | TDM_CLKo Period                               | $t_{C16OP}$      | 54.0  | 61.0  | 68.0  | ns    |                                       |
|                              | TDM_CLKo High                                 | $t_{C16OH}$      | 23.0  | -     | 37.0  | ns    |                                       |
|                              | TDM_CLKo Low                                  | $t_{C16OL}$      | 23.0  | -     | 37.0  | ns    |                                       |
| ST-BUS<br>2.048 Mbps<br>mode | TDM_CLKo Period                               | $t_{C40P}$       | 237.0 | 244.1 | 251.0 | ns    |                                       |
|                              | TDM_CLKo High                                 | $t_{C40H}$       | 115.0 | -     | 129.0 | ns    |                                       |
|                              | TDM_CLKo Low                                  | $t_{C40L}$       | 115.0 | -     | 129.0 | ns    |                                       |
| All Modes                    | TDM_F0o Delay                                 | $t_{FOD}$        | -     | -     | 25    | ns    | With respect to TDM_CLKo falling edge |
|                              | TDM_STo Delay Active-Active                   | $t_{STOD}$       | -     | -     | 5     | ns    | With respect to TDM_CLKo falling edge |
|                              | TDM_STo Delay Active to HiZ and HiZ to Active | $t_{DZ}, t_{ZD}$ | -     | -     | 33    | ns    | With respect to TDM_CLKo falling edge |
|                              | TDM_STi Setup Time                            | $t_{STIS}$       | 5     | -     | -     | ns    | With respect to TDM_CLKo              |
|                              | TDM_STi Hold Time                             | $t_{STIH}$       | 5     | -     | -     | ns    | With respect to TDM_CLKo              |

Table 30 - TDM ST-BUS Master Timing Specification

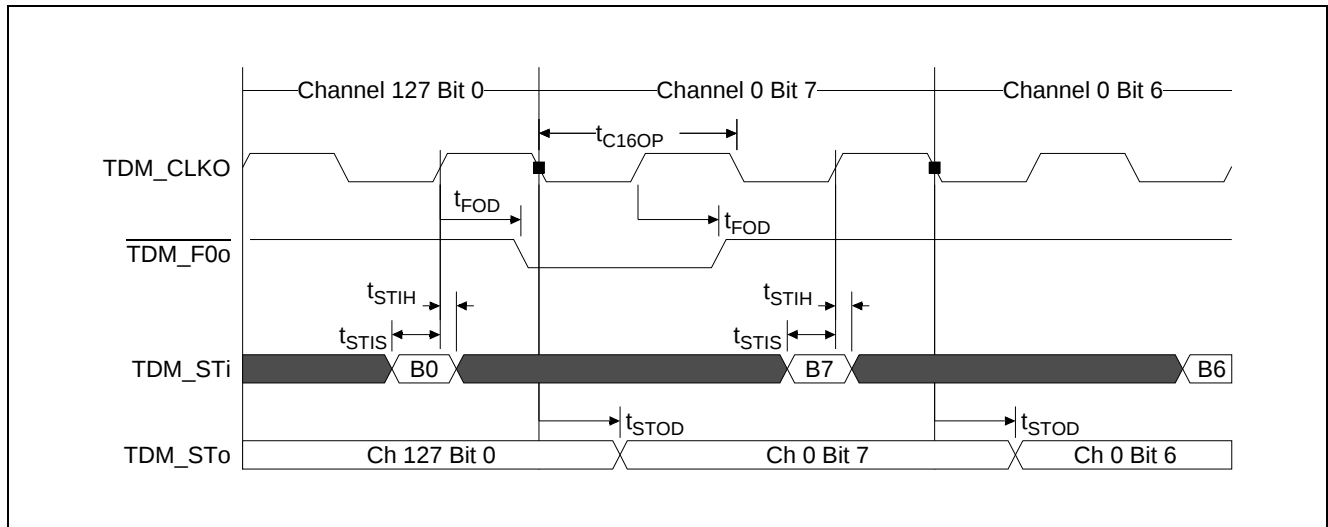


Figure 29 - TDM Bus Master Mode Timing at 8.192 Mbps

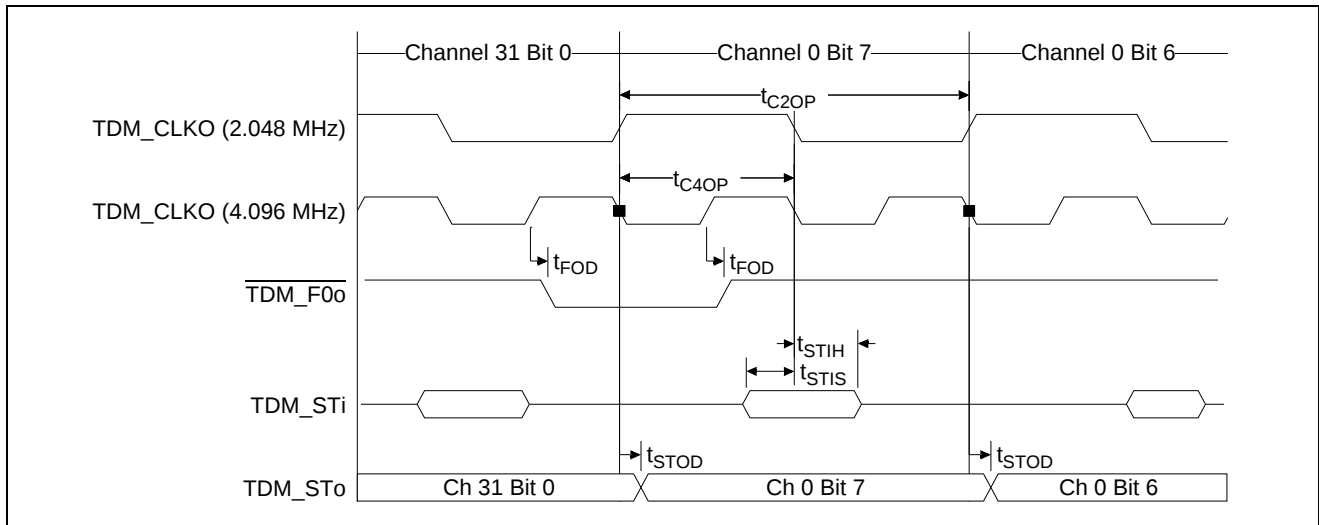


Figure 30 - TDM Bus Master Mode Timing at 2.048 Mbps

## 11.2 TDM Interface Timing - H.110 Mode

These parameters are based on the H.110 Specification from the Enterprise Computer Telephony Forum (ECTF) 1997.

| Parameter                    | Symbol    | Min.           | Typ. | Max.           | Units | Notes                  |
|------------------------------|-----------|----------------|------|----------------|-------|------------------------|
| TDM_C8 Period                | $t_{C8P}$ | $122.066-\Phi$ | 122  | $122.074+\Phi$ | ns    | Note 1<br>Note 2       |
| TDM_C8 High                  | $t_{C8H}$ | $63-\Phi$      | -    | $69+\Phi$      | ns    |                        |
| TDM_C8 Low                   | $t_{C8L}$ | $63-\Phi$      | -    | $69+\Phi$      | ns    |                        |
| TDM_D Output Delay           | $t_{DOD}$ | 0              | -    | 11             | ns    | Load - 12 pF           |
| TDM_D Output to HiZ          | $t_{DOZ}$ | -              | -    | 33             | ns    | Load - 12 pF<br>Note 3 |
| TDM_D HiZ to Output          | $t_{ZDO}$ | 0              | -    | 11             | ns    | Load - 12 pF<br>Note 3 |
| TDM_D Input Delay to Valid   | $t_{DV}$  | 0              | -    | 83             | ns    | Note 4                 |
| TDM_D Input Delay to Invalid | $t_{DIV}$ | 102            | -    | 112            | ns    | Note 4                 |
| TDM_FRAME width              | $t_{FP}$  | 90             | 122  | 180            | ns    | Note 5                 |
| TDM_FRAME setup              | $t_{FS}$  | 45             | -    | 90             | ns    |                        |
| TDM_FRAME hold               | $t_{FH}$  | 45             | -    | 90             | ns    |                        |
| Phase Correction             | F         | 0              | -    | 10             | ns    | Note 6                 |

Table 31 - TDM H.110 Timing Specification

Note 1: TDM\_C8 and TDM\_FRAME signals are required to meet the same timing standards and so are not defined independently.

Note 2: TDM\_C8 corresponds to pin TDM\_CLKi.

Note 3:  $t_{DOZ}$  and  $t_{ZDO}$  apply at every time-slot boundary.

Note 4: Refer to H.110 Standard from Enterprise Computer Telephony Forum (ECTF) for the source of these numbers.

Note 5: The TDM\_FRAME signal is centred on the rising edge of TDM\_C8. All timing measurements are based on this rising edge point; TDM\_FRAME corresponds to pin TDM\_F0i.

Note 6: Phase correction ( $\Phi$ ) results from DPLL timing corrections.

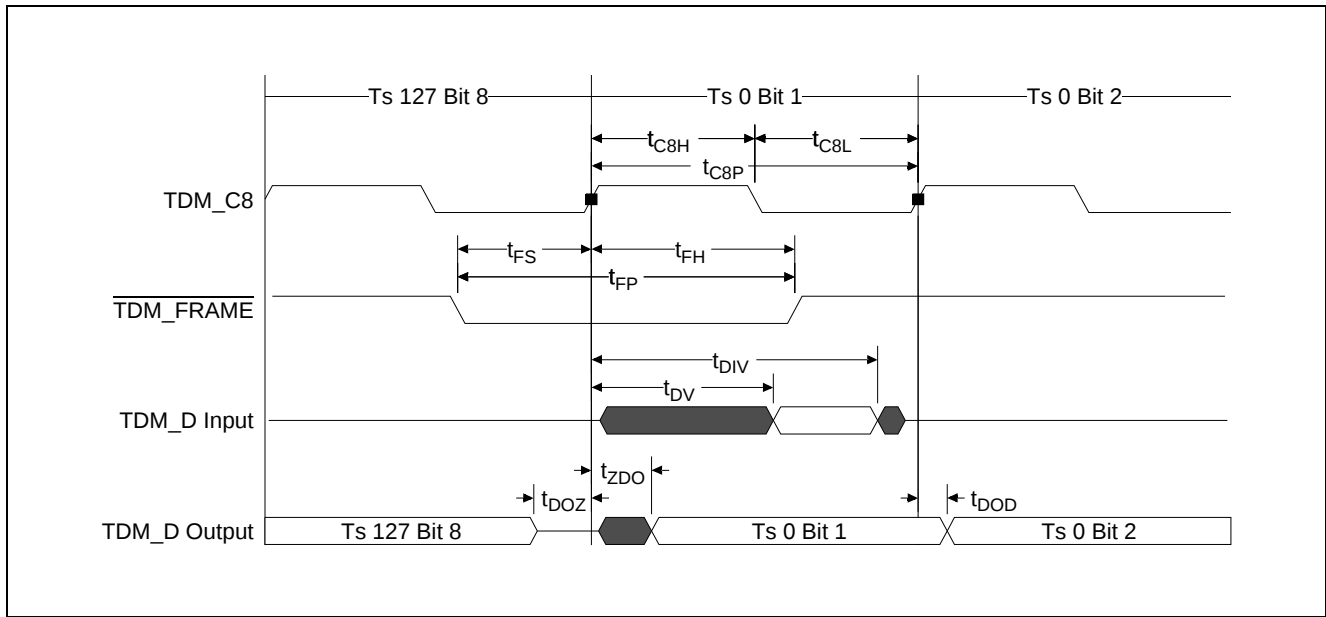


Figure 31 - H.110 Timing Diagram

### 11.3 TDM Interface Timing - H-MVIP

These parameters are based on the Multi-Vendor Integration Protocol (MVIP) specification for an H-MVIP Bus, Release 1.1a (1997).

Positive transitions of TDM\_C2 are synchronous with the falling edges of TDM\_C4 and TDM\_C16. The signals TDM\_C2, TDM\_C4 and TDM\_C16 correspond with pins TDM\_CLKi. The signals TDM\_F0 correspond with pins TDM\_F0i. The signals TDM\_HDS correspond with pins TDM\_STi and TDM\_STo.

| Parameter             | Symbol     | Min.  | Typ.  | Max.  | Units | Notes         |
|-----------------------|------------|-------|-------|-------|-------|---------------|
| TDM_C2 Period         | $t_{C2P}$  | 487.8 | 488.3 | 488.8 | ns    |               |
| TDM_C2 High           | $t_{C2H}$  | 220   | -     | 268   | ns    |               |
| TDM_C2 Low            | $t_{C2L}$  | 220   | -     | 268   | ns    |               |
| <u>TDM_C4</u> Period  | $t_{C4P}$  | 243.9 | 244.1 | 244.4 | ns    |               |
| <u>TDM_C4</u> High    | $t_{C4H}$  | 110   | -     | 134   | ns    |               |
| <u>TDM_C4</u> Low     | $t_{C4L}$  | 110   | -     | 134   | ns    |               |
| <u>TDM_C16</u> Period | $t_{C16P}$ | 60.9  | 61.0  | 61.1  | ns    |               |
| <u>TDM_C16</u> High   | $t_{C16H}$ | 30    | -     | 31    | ns    |               |
| <u>TDM_C16</u> Low    | $t_{C16L}$ | 30    | -     | 31    | ns    |               |
| TDM_HDS Output Delay  | $t_{PD}$   | -     | -     | 30    | ns    | At 8.192 Mbps |
| TDM_HDS Output Delay  | $t_{PD}$   | -     | -     | 100   | ns    | At 2.048 Mbps |
| TDM_HDS Output to HiZ | $t_{HZD}$  | -     | -     | 30    | ns    |               |

Table 32 - TDM H-MVIP Timing Specification

| Parameter           | Symbol   | Min. | Typ. | Max. | Units | Notes |
|---------------------|----------|------|------|------|-------|-------|
| TDM_HDS Input Setup | $t_S$    | 30   | -    | -    | ns    |       |
| TDM_HDS Input Hold  | $t_H$    | 30   | -    | -    | ns    |       |
| TDM_F0 width        | $t_{FW}$ | 200  | 244  | 300  | ns    |       |
| TDM_F0 setup        | $t_{FS}$ | 50   | -    | 150  | ns    |       |
| TDM_F0 hold         | $t_{FH}$ | 50   | -    | 150  | ns    |       |

Table 32 - TDM H-MVIP Timing Specification (continued)

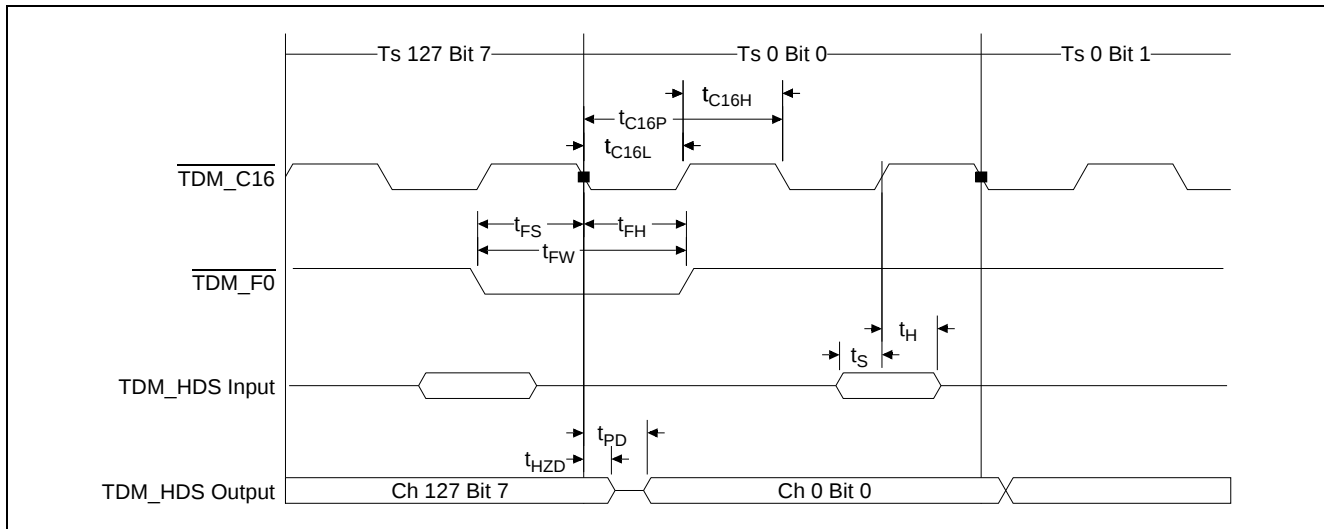


Figure 32 - TDM - H-MVIP Timing Diagram for 16 MHz Clock (8.192 Mbps)

#### 11.4 TDM LIU Interface Timing

The TDM Interface can be used to directly drive into a Line Interface Unit (LIU). The interface can work in this mode with E1, DS1, J2, E3 and DS3. The frame pulse is not present, just data and clock is transmitted and received. Table 30 shows timing for DS3, which would be the most stringent requirement.

| Parameter               | Symbol    | Min. | Typ.   | Max. | Units | Notes     |
|-------------------------|-----------|------|--------|------|-------|-----------|
| TDM_TXCLK Period        | $t_{CTP}$ |      | 22.353 |      | ns    | DS3 clock |
| TDM_TXCLK High          | $t_{CTH}$ | 6.7  |        |      | ns    |           |
| TDM_TXCLK Low           | $t_{CTL}$ | 6.7  |        |      | ns    |           |
| TDM_RXCLK Period        | $t_{CRP}$ |      | 22.353 |      | ns    | DS3 clock |
| TDM_RXCLK High          | $t_{CRH}$ | 9.0  |        |      | ns    |           |
| TDM_RXCLK Low           | $t_{CRL}$ | 9.0  |        |      | ns    |           |
| TDM_TXDATA Output Delay | $t_{PD}$  | 3    | -      | 10   | ns    |           |
| TDM_RXDATA Input Setup  | $t_S$     | 6    |        |      | ns    |           |
| TDM_RXDATA Input Hold   | $t_H$     | 3    |        |      | ns    |           |

Table 33 - TDM - LIU Structured Transmission/Reception

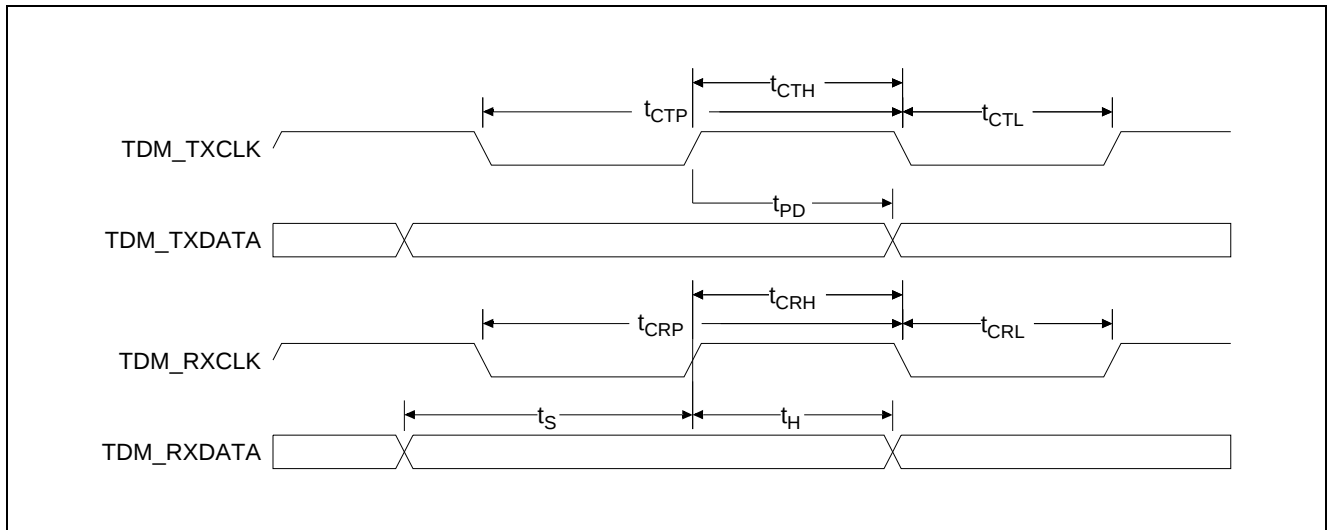


Figure 33 - TDM-LIU Structured Transmission/Reception

### 11.5 PAC Interface Timing

| Parameter                       | Symbol    | Min. | Typ. | Max. | Units | Notes |
|---------------------------------|-----------|------|------|------|-------|-------|
| TDM_CLKiP High / Low Pulsewidth | $t_{CPP}$ | 10   | -    | -    | ns    |       |
| TDM_CLKiS High / Low Pulsewidth | $t_{CSP}$ | 10   | -    | -    | ns    |       |

Table 34 - PAC Timing Specification

### 11.6 Packet Interface Timing

Data for the MII/GMII/TBI packet switching is based on Specification IEEE Std. 802.3 - 2000.

#### 11.6.1 MII Transmit Timing

| Parameter                                               | Symbol    | 100 Mbps |      |      | Units | Notes        |
|---------------------------------------------------------|-----------|----------|------|------|-------|--------------|
|                                                         |           | Min.     | Typ. | Max. |       |              |
| TXCLK period                                            | $t_{CC}$  | -        | 40   | -    | ns    |              |
| TXCLK high time                                         | $t_{CHI}$ | 14       | -    | 26   | ns    |              |
| TXCLK low time                                          | $t_{CLO}$ | 14       | -    | 26   | ns    |              |
| TXCLK rise time                                         | $t_{CR}$  | -        | -    | 5    | ns    |              |
| TXCLK fall time                                         | $t_{CF}$  | -        | -    | 5    | ns    |              |
| TXCLK rise to TXD[3:0] active delay (TXCLK rising edge) | $t_{DV}$  | 1        | -    | 25   | ns    | Load = 25 pF |
| TXCLK to TXEN active delay (TXCLK rising edge)          | $t_{EV}$  | 1        | -    | 25   | ns    | Load = 25 pF |

Table 35 - MII Transmit Timing - 100 Mbps

| Parameter                                      | Symbol   | 100 Mbps |      |      | Units | Notes        |
|------------------------------------------------|----------|----------|------|------|-------|--------------|
|                                                |          | Min.     | Typ. | Max. |       |              |
| TXCLK to TXER active delay (TXCLK rising edge) | $t_{ER}$ | 1        | -    | 25   | ns    | Load = 25 pF |

Table 35 - MII Transmit Timing - 100 Mbps

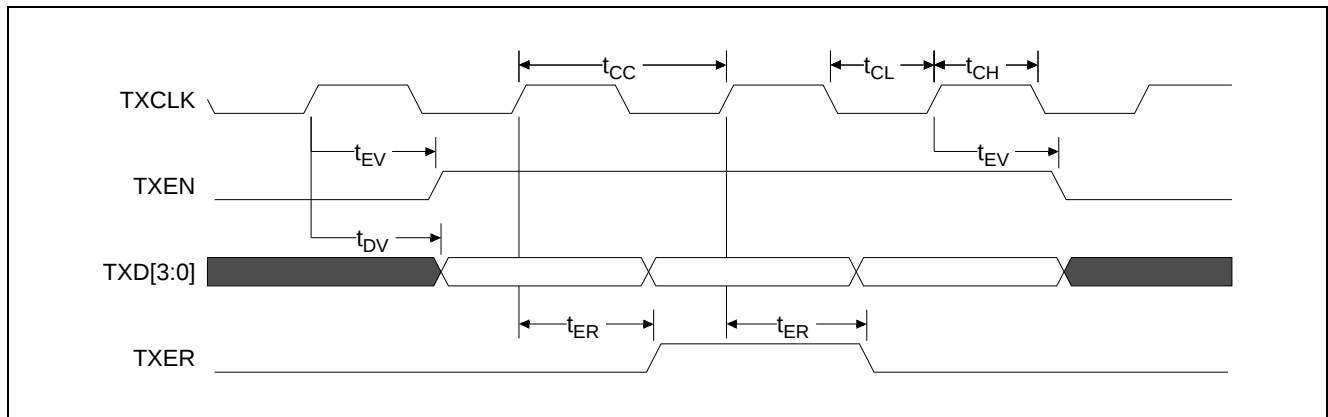
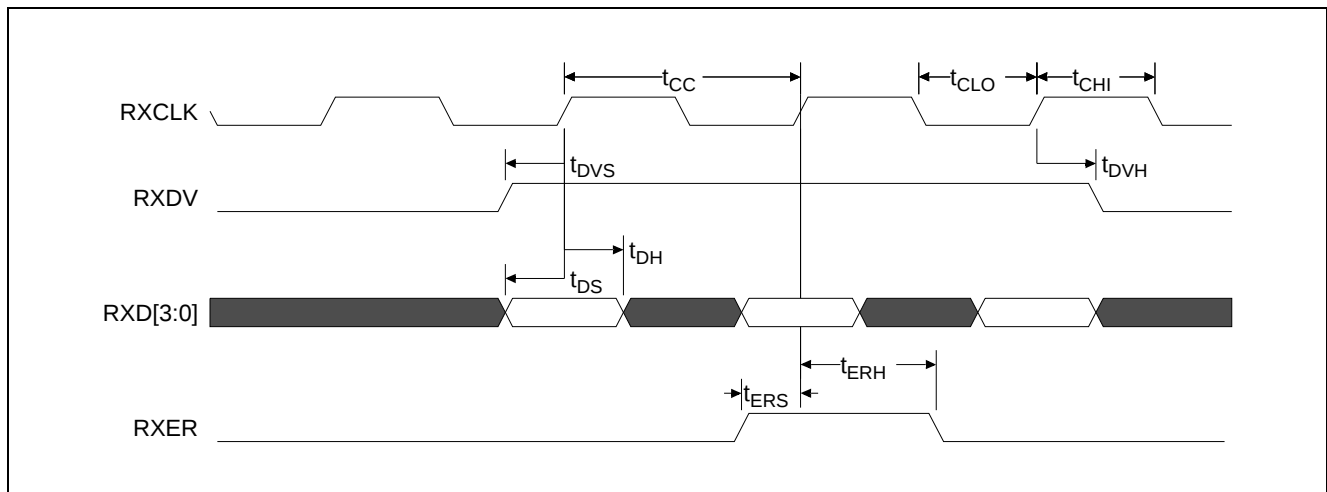


Figure 34 - MII Transmit Timing Diagram

### 11.6.2 MII Receive Timing

| Parameter                                 | Symbol    | 100 Mbps |      |      | Units | Notes |
|-------------------------------------------|-----------|----------|------|------|-------|-------|
|                                           |           | Min.     | Typ. | Max. |       |       |
| RXCLK period                              | $t_{CC}$  | -        | 40   | -    | ns    |       |
| RXCLK high wide time                      | $t_{CH}$  | 14       | 20   | 26   | ns    |       |
| RXCLK low wide time                       | $t_{CL}$  | 14       | 20   | 26   | ns    |       |
| RXCLK rise time                           | $t_{CR}$  | -        | -    | 5    | ns    |       |
| RXCLK fall time                           | $t_{CF}$  | -        | -    | 5    | ns    |       |
| RXD[3:0] setup time (RXCLK rising edge)   | $t_{DS}$  | 10       | -    | -    | ns    |       |
| RXD[3:0] hold time (RXCLK rising edge)    | $t_{DH}$  | 5        | -    | -    | ns    |       |
| RXDV input setup time (RXCLK rising edge) | $t_{DVS}$ | 10       | -    | -    | ns    |       |
| RXDV input hold time (RXCLK rising edge)  | $t_{DVH}$ | 5        | -    | -    | ns    |       |
| RXER input setup time (RXCLK rising edge) | $t_{ERS}$ | 10       | -    | -    | ns    |       |
| RXER input hold time (RXCLK rising edge)  | $t_{ERH}$ | 5        | -    | -    | ns    |       |

**Table 36 - MII Receive Timing - 100 Mbps**



**Figure 35 - MII Receive Timing Diagram**

### 11.6.3 GMII Transmit Timing

| Parameter                            | Symbol    | 1000 Mbps |      |      | Units | Notes        |
|--------------------------------------|-----------|-----------|------|------|-------|--------------|
|                                      |           | Min.      | Typ. | Max. |       |              |
| GTXCLK period                        | $t_{GC}$  | 7.5       | -    | 8.5  | ns    |              |
| GTXCLK high time                     | $t_{GCH}$ | 2.5       | -    | -    | ns    |              |
| GTXCLK low time                      | $t_{GCL}$ | 2.5       | -    | -    | ns    |              |
| GTXCLK rise time                     | $t_{GCR}$ | -         | -    | 1    | ns    |              |
| GTXCLK fall time                     | $t_{GCF}$ | -         | -    | 1    | ns    |              |
| GTXCLK rise to TXD[7:0] active delay | $t_{DV}$  | 1.5       | -    | 6    | ns    | Load = 25 pF |
| GTXCLK rise to TXEN active delay     | $t_{EV}$  | 2         | -    | 6    | ns    | Load = 25 pF |
| GTXCLK rise to TXER active delay     | $t_{ER}$  | 1         | -    | 6    | ns    | Load = 25 pF |

Table 37 - GMII Transmit Timing - 1000 Mbps

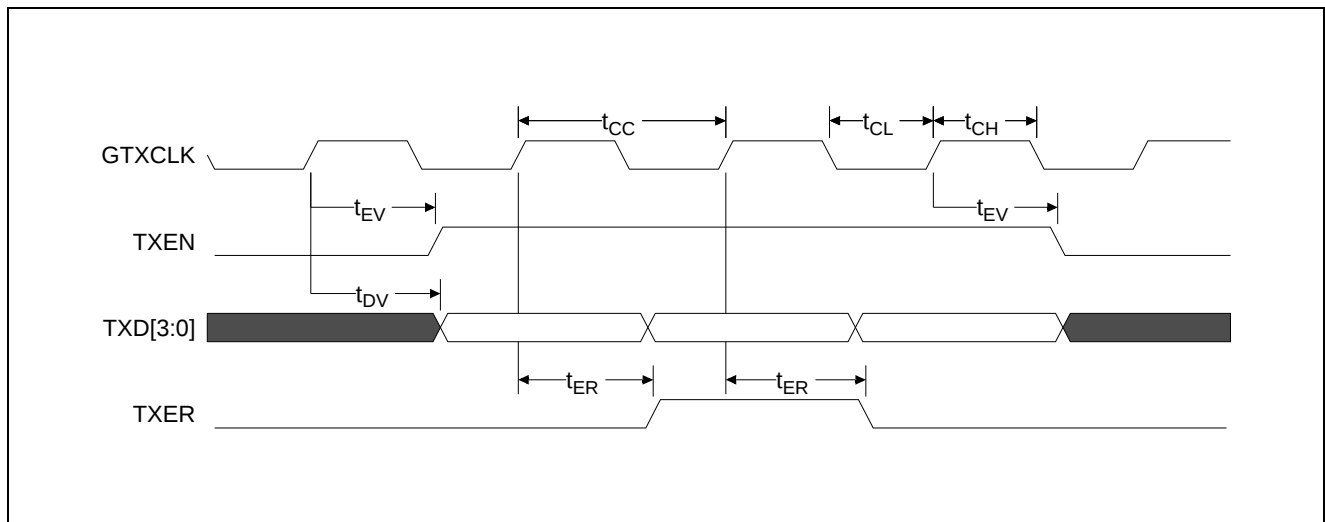


Figure 36 - GMII Transmit Timing Diagram

### 11.6.4 GMII Receive Timing

| Parameter                               | Symbol    | 1000 Mbps |      |      | Units | Notes |
|-----------------------------------------|-----------|-----------|------|------|-------|-------|
|                                         |           | Min.      | Typ. | Max. |       |       |
| RXCLK period                            | $t_{CC}$  | 7.5       | -    | 8.5  | ns    |       |
| RXCLK high wide time                    | $t_{CH}$  | 2.5       | -    | -    | ns    |       |
| RXCLK low wide time                     | $t_{CL}$  | 2.5       | -    | -    | ns    |       |
| RXCLK rise time                         | $t_{CR}$  | -         | -    | 1    | ns    |       |
| RXCLK fall time                         | $t_{CF}$  | -         | -    | 1    | ns    |       |
| RXD[7:0] setup time (RXCLK rising edge) | $t_{DS}$  | 2         | -    | -    | ns    |       |
| RXD[7:0] hold time (RXCLK rising edge)  | $t_{DH}$  | 1         | -    | -    | ns    |       |
| RXDV setup time (RXCLK rising edge)     | $t_{DVS}$ | 2         | -    | -    | ns    |       |
| RXDV hold time (RXCLK rising edge)      | $t_{DVH}$ | 1         | -    | -    | ns    |       |
| RXER setup time (RXCLK rising edge)     | $t_{ERS}$ | 2         | -    | -    | ns    |       |
| RXER hold time (RXCLK rising edge)      | $t_{ERH}$ | 1         | -    | -    | ns    |       |

Table 38 - GMII Receive Timing - 1000 Mbps

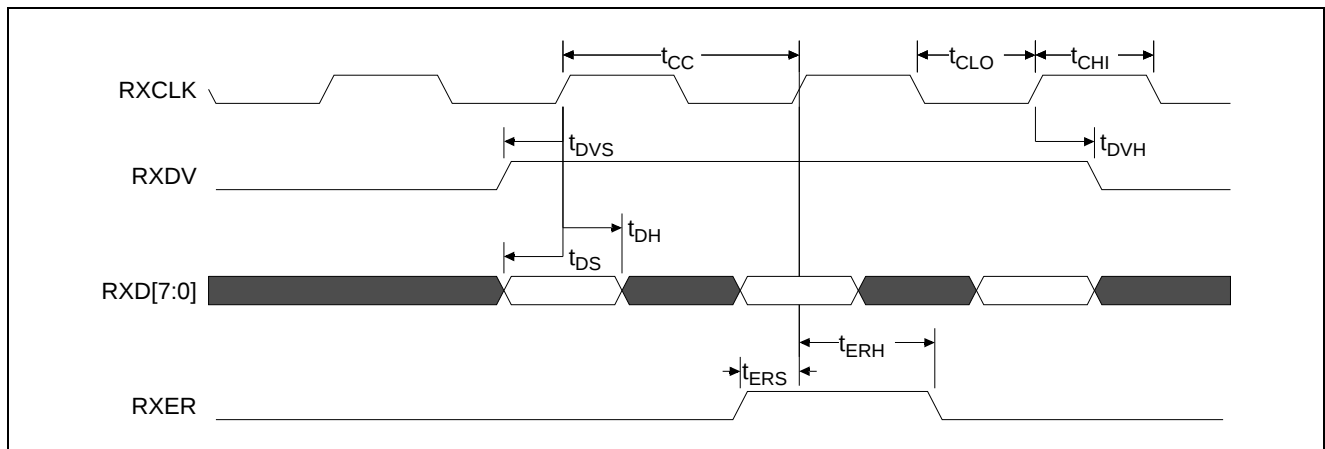


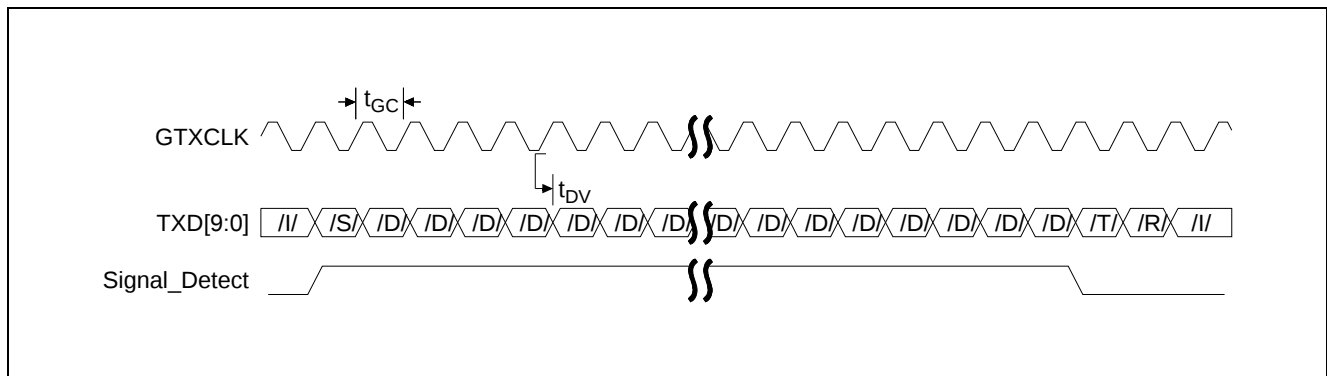
Figure 37 - GMII Receive Timing Diagram

### 11.6.5 TBI Interface Timing

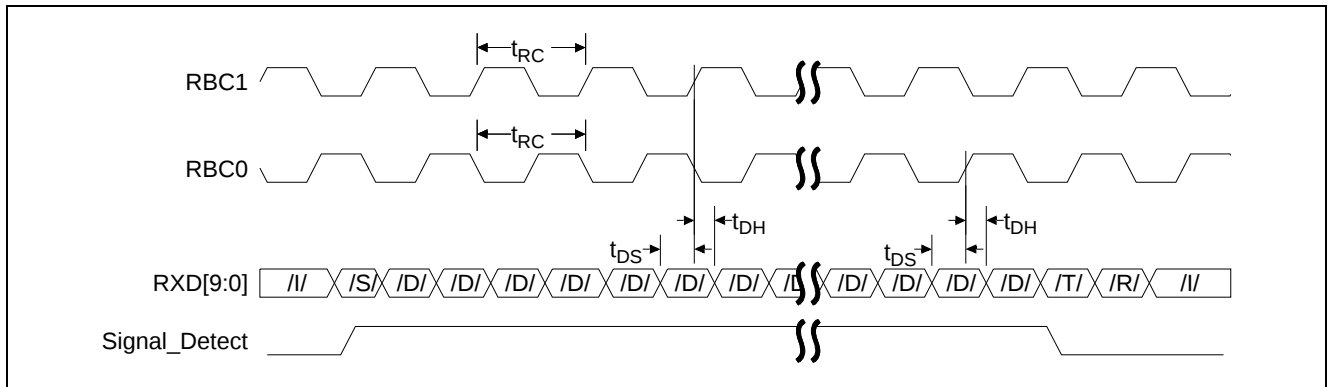
| Parameter                                  | Symbol   | 1000 Mbps |      |      | Units | Notes                  |
|--------------------------------------------|----------|-----------|------|------|-------|------------------------|
|                                            |          | Min.      | Typ. | Max. |       |                        |
| GTXCLK period                              | $t_{GC}$ | 7.5       | -    | 8.5  | ns    |                        |
| GTXCLK high wide time                      | $t_{GH}$ | 2.5       | -    | -    | ns    |                        |
| GTXCLK low wide time                       | $t_{GL}$ | 2.5       | -    | -    | ns    |                        |
| TXD[9:0] Output Delay (GTXCLK rising edge) | $t_{DV}$ | 0.1       | -    | 2.4  |       | Load = 10 pF<br>Note 1 |
| RCB0/RBC1 period                           | $t_{RC}$ | 15        | 16   | 17   | ns    |                        |
| RCB0/RBC1 high wide time                   | $t_{RH}$ | 5         | -    | -    | ns    |                        |
| RCB0/RBC1 low wide time                    | $t_{RL}$ | 5         | -    | -    | ns    |                        |
| RCB0/RBC1 rise time                        | $t_{RR}$ | -         | -    | 2    | ns    |                        |
| RCB0/RBC1 fall time                        | $t_{RF}$ | -         | -    | 2    | ns    |                        |
| RXD[9:0] setup time (RCB0 rising edge)     | $t_{DS}$ | 2         | -    | -    | ns    |                        |
| RXD[9:0] hold time (RCB0 rising edge)      | $t_{DH}$ | 1         | -    | -    | ns    |                        |
| REFCLK period                              | $t_{FC}$ | 7.5       | -    | 8.5  | ns    |                        |
| REFCLK high wide time                      | $t_{FH}$ | 2.5       | -    | -    | ns    |                        |
| REFCLK low wide time                       | $t_{FL}$ | 2.5       | -    | -    | ns    |                        |

**Table 39 - TBI Timing - 1000 Mbps**

Note1: These measurements were obtained through simulation and lab measurement using a 10pF load. See ZL5011x Design Manual section "7.1.3.1 TBI Interface Timing" for proper operation when using the TBI interface.



**Figure 38 - TBI Transmit Timing Diagram**



### Figure 39 - TBI Receive Timing Diagram

### 11.6.6 Management Interface Timing

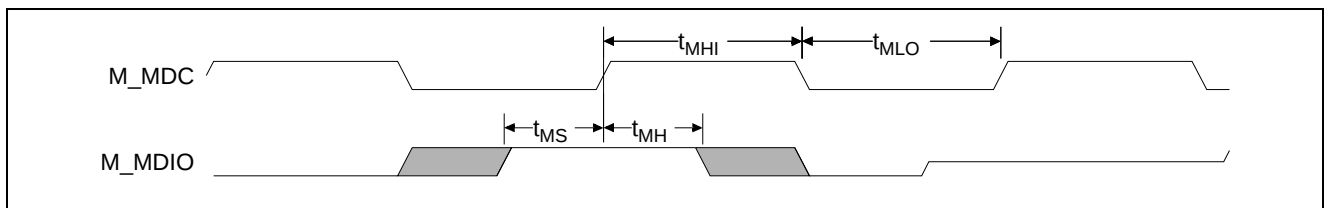
The management interface is common for all inputs and consists of a serial data I/O line and a clock line.

| Parameter                                | Symbol           | Min. | Typ. | Max. | Units | Notes  |
|------------------------------------------|------------------|------|------|------|-------|--------|
| M_MDC Clock Output period                | t <sub>MP</sub>  | 1990 | 2000 | 2010 | ns    | Note 1 |
| M_MDC high                               | t <sub>MHI</sub> | 900  | 1000 | 1100 | ns    |        |
| M_MDC low                                | t <sub>MLO</sub> | 900  | 1000 | 1100 | ns    |        |
| M_MDC rise time                          | t <sub>MR</sub>  | -    | -    | 5    | ns    |        |
| M_MDC fall time                          | t <sub>MF</sub>  | -    | -    | 5    | ns    |        |
| M_MDIO setup time (MDC rising edge)      | t <sub>MS</sub>  | 10   | -    | -    | ns    | Note 1 |
| M_MDIO hold time (M_MDC rising edge)     | t <sub>MH</sub>  | 0    | -    | -    | ns    | Note 1 |
| M_MDIO Output Delay (M_MDC falling edge) | t <sub>MD</sub>  | 1    | -    | 300  | ns    | Note 2 |

### Table 40 - MAC Management Timing Specification

Note 1: Refer to Clause 22 in IEEE802.3 (2000) Standard for input/output signal timing characteristics.

Note 2: Refer to Clause 22C.4 in IEEE802.3 (2000) Standard for output load description of MDIO.



### Figure 40 - Management Interface Timing for Ethernet Port - Read

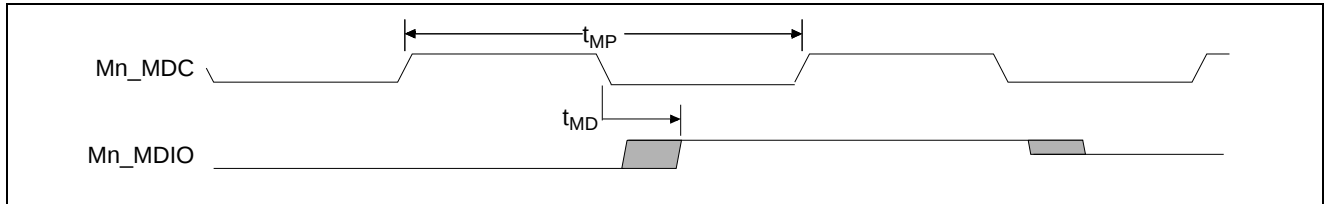


Figure 41 - Management Interface Timing for Ethernet Port - Write

## 11.7 External Memory Interface Timing

The timings for the External Memory Interface are based on the requirements of a ZBT-SRAM device, with the system clock speed at 100 MHz.

| Parameter                          | Symbol    | Min. | Typ. | Max. | Units | Notes                        |
|------------------------------------|-----------|------|------|------|-------|------------------------------|
| RAM_DATA[63:0] Output Valid Delay  | $t_{RDV}$ | 1    | -    | 4    | ns    | Load $C_L = 30$ pF           |
| RAM_RW/RAM_ADDR[19:0] Delay        | $t_{RAV}$ | 1    | -    | 4    | ns    | Load $C_L = 30$ pF<br>Note 1 |
| RAM_BW[7:0]# Delay                 | $t_{RBW}$ | 1    | -    | 4    | ns    | Load $C_L = 30$ pF           |
| RAM_DATA[63:0] Setup Time          | $t_{RDS}$ | 2    | -    | -    | ns    |                              |
| RAM_DATA[63:0] Hold Time           | $t_{RDH}$ | 0.5  | -    | -    | ns    |                              |
| RAM_PARITY[7:0] Output Valid Delay | $t_{RPV}$ | 1    | -    | 4    | ns    | Load $C_L = 30$ pF           |
| RAM_PARITY[7:0] Setup Time         | $t_{RPS}$ | 2    | -    | -    | ns    |                              |
| RAM_PARITY[7:0] Hold Time          | $t_{RPS}$ | 0.5  | -    | -    | ns    |                              |

Table 41 - External Memory Timing

Note 1: Must be capable of driving TWO separate RAM loads simultaneously.

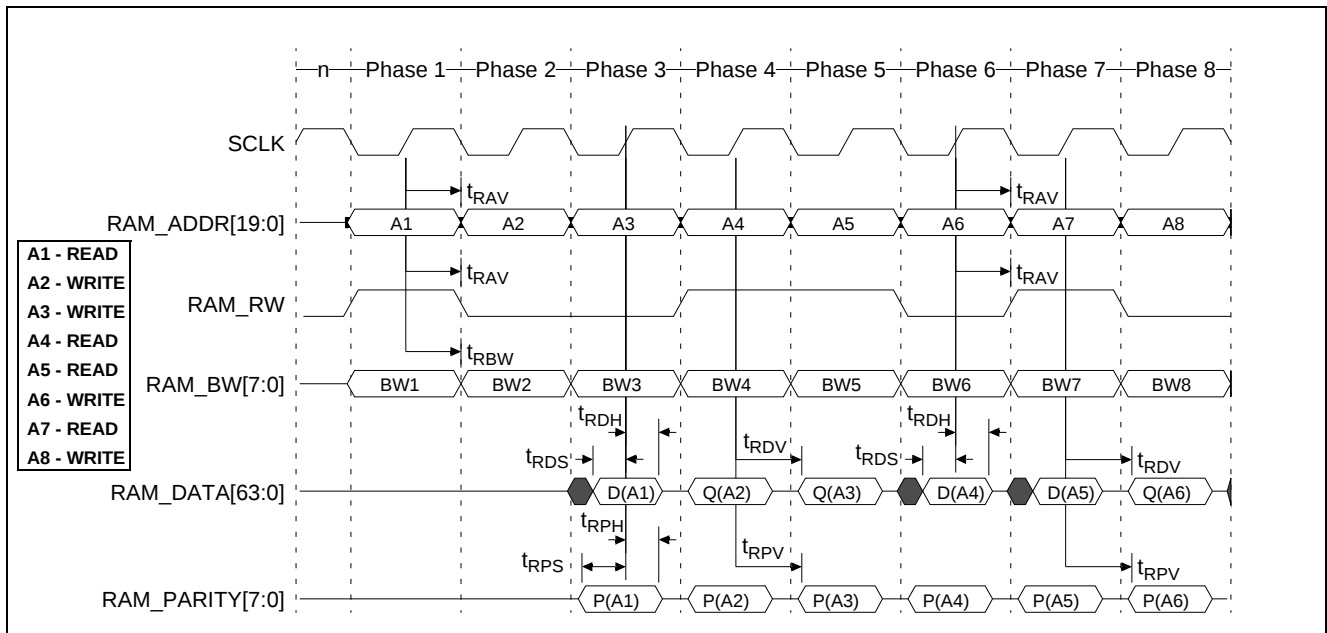


Figure 42 - External RAM Read and Write Timing

## 11.8 CPU Interface Timing

| Parameter                              | Symbol    | Min. | Typ.   | Max. | Units | Notes     |
|----------------------------------------|-----------|------|--------|------|-------|-----------|
| CPU_CLK Period                         | $t_{CC}$  |      | 15.152 |      | ns    |           |
| CPU_CLK High Time                      | $t_{CCH}$ | 6    |        |      | ns    |           |
| CPU_CLK Low Time                       | $t_{CCL}$ | 6    |        |      | ns    |           |
| CPU_CLK Rise Time                      | $t_{CCR}$ |      |        | 4    | ns    |           |
| CPU_CLK Fall Time                      | $t_{CCF}$ |      |        | 4    | ns    |           |
| CPU_ADDR[23:2] Setup Time              | $t_{CAS}$ | 4    |        |      | ns    |           |
| CPU_ADDR[23:2] Hold Time               | $t_{CAH}$ | 2    |        |      | ns    |           |
| CPU_DATA[31:0] Setup Time              | $t_{CDS}$ | 4    |        |      | ns    |           |
| CPU_DATA[31:0] Hold Time               | $t_{CDH}$ | 2    |        |      | ns    |           |
| CPU_CS Setup Time                      | $t_{CSS}$ | 4    |        |      | ns    |           |
| CPU_CS Hold Time                       | $t_{CSH}$ | 2    |        |      | ns    |           |
| CPU_WE/CPU_OE Setup Time               | $t_{CES}$ | 5    |        |      | ns    |           |
| CPU_WE/CPU_OE Hold Time                | $t_{CEH}$ | 2    |        |      | ns    |           |
| CPU_TS_ALE Setup Time                  | $t_{CTS}$ | 4    |        |      | ns    |           |
| CPU_TS_ALE Hold Time                   | $t_{CTH}$ | 2    |        |      | ns    |           |
| CPU_SDACK1/CPU_SDACK2 Setup Time       | $t_{CKS}$ | 2    |        |      | ns    |           |
| CPU_SDACK1/CPU_SDACK2 Hold Time        | $t_{CKH}$ | 2    |        |      | ns    | Note 1    |
| CPU_TA Output Valid Delay              | $t_{CTV}$ | 2    |        | 11.3 | ns    | Note 1, 2 |
| CPU_DREQ0/CPU_DREQ1 Output Valid Delay | $t_{CWV}$ | 2    |        | 6    | ns    | Note 1    |
| CPU_IREQ0/CPU_IREQ1 Output Valid Delay | $t_{CRV}$ | 2    |        | 6    | ns    | Note 1    |
| CPU_DATA[31:0] Output Valid Delay      | $t_{CDV}$ | 2    |        | 7    | ns    | Note 1    |
| CPU_CS to Output Data Valid            | $t_{SDV}$ | 3.2  |        | 10.4 | ns    |           |
| CPU_OE to Output Data Valid            | $t_{ODV}$ | 3.3  |        | 10.4 | ns    |           |
| CPU_CLK(falling) to CPU_TA Valid       | $t_{OTV}$ | 3.2  |        | 9.5  | ns    |           |

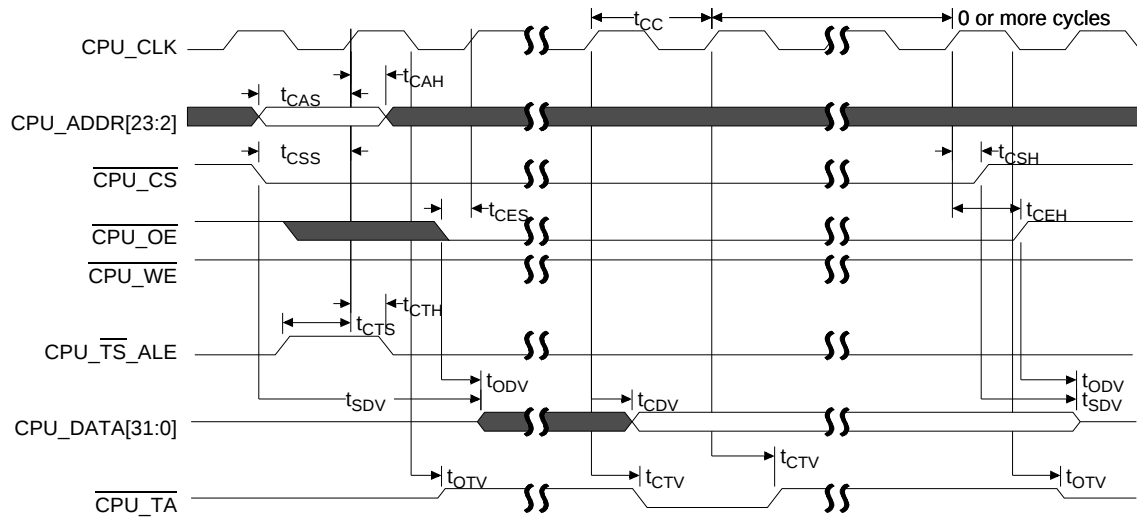
**Table 42 - CPU Timing Specification**

Note 1: Load = 50 pF maximum

Note 2: The maximum value of  $t_{CTV}$  may cause setup violations if directly connected to the MPC8260. See Section 13.2 for details of how to accommodate this during board design.

The actual point where read/write data is transferred occurs at the positive clock edge following the assertion of CPU\_TA, not at the positive clock edge during the assertion of CPU\_TA.

The CPU\_TA maximum assertion time is 4  $\mu$ s.



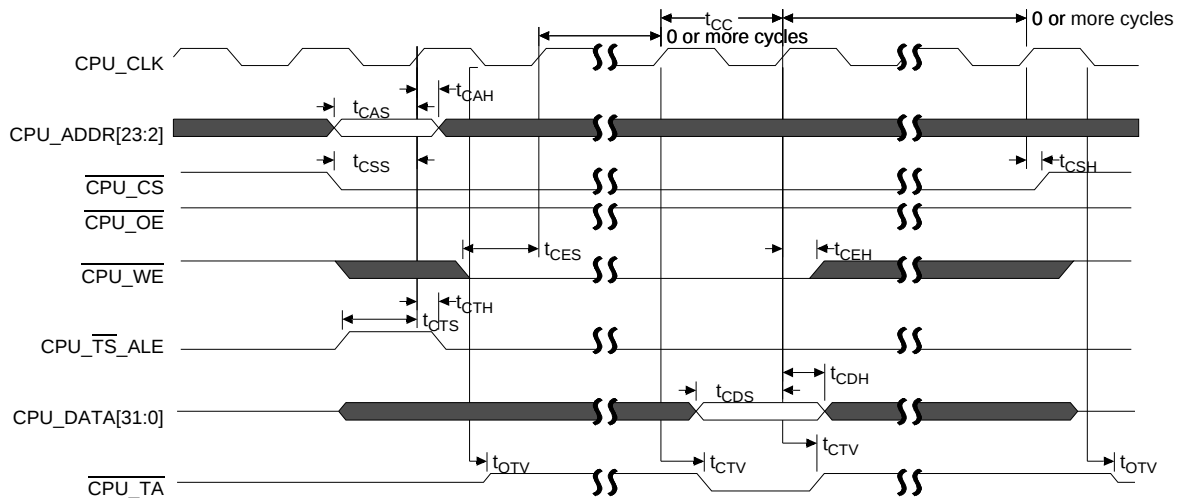
NOTE 1: CPU\_DATA is valid when  $\overline{\text{CPU\_TA}}$  is asserted. CPU\_DATA will remain valid while both  $\overline{\text{CPU\_CS}}$  and  $\overline{\text{CPU\_OE}}$  are asserted.  $\overline{\text{CPU\_TA}}$  will continue to be driven until  $\overline{\text{CPU\_CS}}$  is deasserted.

$\overline{\text{CPU\_CS}}$  and  $\overline{\text{CPU\_OE}}$  must BOTH be asserted to enable the CPU\_DATA output.

NOTE 2: CPU\_TS\_ALE is no more than one clock cycle width and it can be delayed by one clock cycle from CS assertion.

NOTE 3: The CPU\_TA maximum assertion time is 4  $\mu\text{s}$ .

Figure 43 - CPU Read - MPC8260

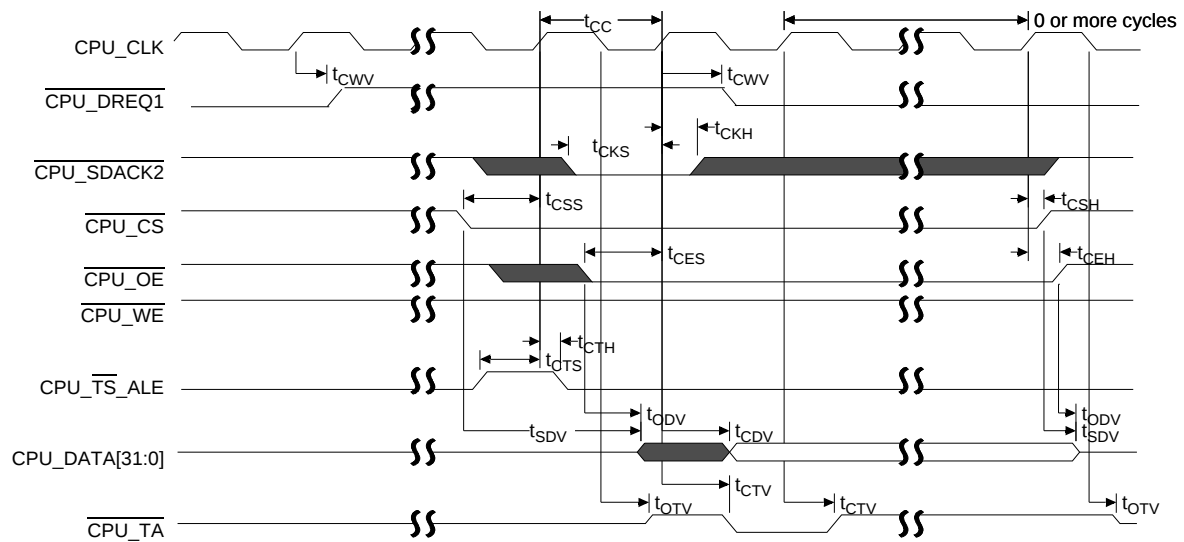


NOTE 1: Following assertion of CPU\_TA, CPU\_CS may be deasserted. The MPC8260 will continue to assert CPU\_CS until CPU\_TA has been synchronized internally. CPU\_TA will continue to be driven until CPU\_CS is finally deasserted. During continued assertion of CPU\_CS, CPU\_WE and CPU\_DATA may be removed.

NOTE 2: CPU\_TS\_ALE is no more than one clock cycle width and it can be delayed by one clock cycle from CS assertion.

NOTE 3: The CPU\_TA maximum assertion time is 4  $\mu\text{s}$ .

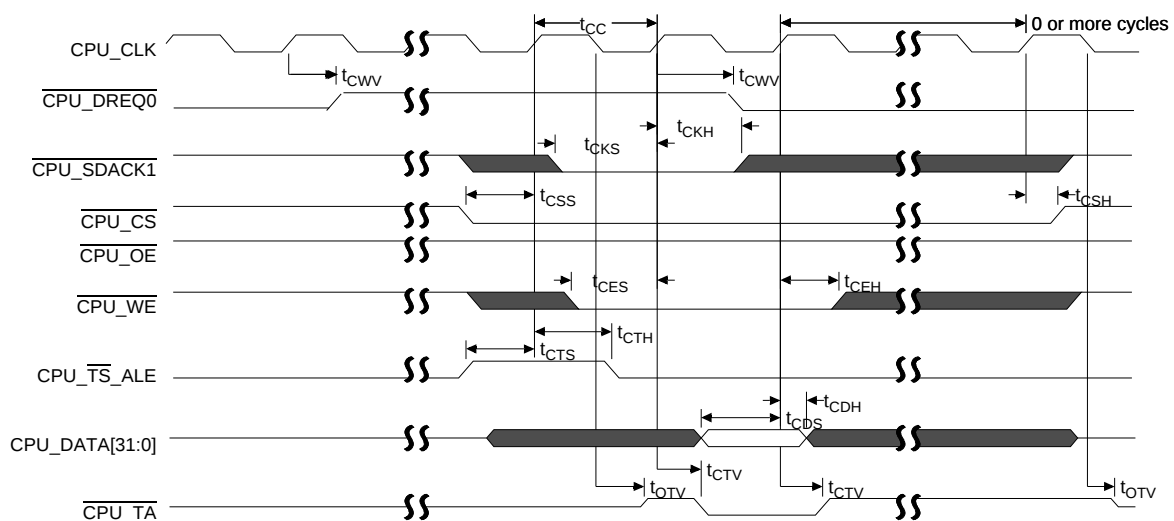
Figure 44 - CPU Write - MPC8260



Note 1:  $\overline{\text{CPU\_SDACK2}}$  must be asserted during the cycle shown. It may then be deasserted at any time.  $\text{CPU\_DATA}$  is valid when  $\overline{\text{CPU\_TA}}$  is asserted (always timed as shown).  $\text{CPU\_DATA}$  will remain valid while  $\overline{\text{CPU\_CS}}$  and  $\overline{\text{CPU\_OE}}$  are asserted.  $\overline{\text{CPU\_TA}}$  will continue to be driven until  $\overline{\text{CPU\_CS}}$  is deasserted.  $\overline{\text{CPU\_CS}}$  and  $\overline{\text{CPU\_OE}}$  must BOTH be asserted to enable the  $\text{CPU\_DATA}$  output.

Note 2: CPU\_DREQ1 shown with positive polarity  
CPU\_SDACK1 shown with negative polarity

### Figure 45 - CPU DMA Read - MPC8260



Note 1: CPU\_SDACK1 must be asserted during the cycle shown. It may then be deasserted at any time. Following assertion of CPU\_TA (always timed as shown), CPU\_CS may be deasserted. The MPC8260 will continue to assert CPU\_CS until CPU\_TA has been synchronized internally. CPU\_TA will continue to be driven until CPU\_CS is finally deasserted. During continued assertion of CPU\_CS, CPU\_WE and CPU\_DATA may be removed.

Note 2: CPU\_DREQ0 shown with positive polarity  
CPU\_SDACK1 shown with negative polarity

Figure 46 - CPU DMA Write - MPC8260

## 11.9 System Function Port

| Parameter                                                          | Symbol             | Min. | Typ. | Max. | Units | Notes                     |
|--------------------------------------------------------------------|--------------------|------|------|------|-------|---------------------------|
| SYSTEM_CLK Frequency                                               | CLK <sub>FR</sub>  | -    | 100  | -    | MHz   | Note 1, Note 2 and Note 5 |
| SYSTEM_CLK accuracy (synchronous master mode)                      | CLK <sub>ACS</sub> | -    | -    | ±30  | ppm   | Note 3                    |
| SYSTEM_CLK accuracy (synchronous slave mode and asynchronous mode) | CLK <sub>ACA</sub> | -    | -    | ±200 | ppm   | Note 4                    |

**Table 43 - System Clock Timing**

- Note 1: The system clock frequency stability affects the holdover-operating mode of the DPLL. Holdover Mode is typically used for a short duration while network synchronisation is temporarily disrupted. Drift on the system clock directly affects the Holdover Mode accuracy. Note that the absolute system clock accuracy does not affect the Holdover accuracy, only the change in the system clock (SYSTEM\_CLK) accuracy while in Holdover. For example, if the system clock oscillator has a temperature coefficient of 0.1 ppm/°C, a 10°C change in temperature while the DPLL is in will result in a frequency accuracy offset of 1ppm. The intrinsic frequency accuracy of the DPLL Holdover Mode is 0.06 ppm, excluding the system clock drift.
- Note 2: The system clock frequency affects the operation of the DPLL in free-run mode. In this mode, the DPLL provides timing and synchronisation signals which are based on the frequency of the accuracy of the master clock (i.e. frequency of clock output equals 8.192 MHz ± SYSTEM\_CLK accuracy ± 0.005 ppm).
- Note 3: The absolute SYSTEM\_CLK accuracy must be controlled to ± 30 ppm in synchronous master mode to enable the internal DPLL to function correctly.
- Note 4: In asynchronous mode and in synchronous slave mode the DPLL is not used. Therefore the tolerance on SYSTEM\_CLK may be relaxed slightly.
- Note 5: The quality of SYSTEM\_CLK, or the oscillator that drives SYSTEM\_CLK directly impacts the adaptive clock recovery performance. See Section 6.3.

**11.10 JTAG Interface Timing**

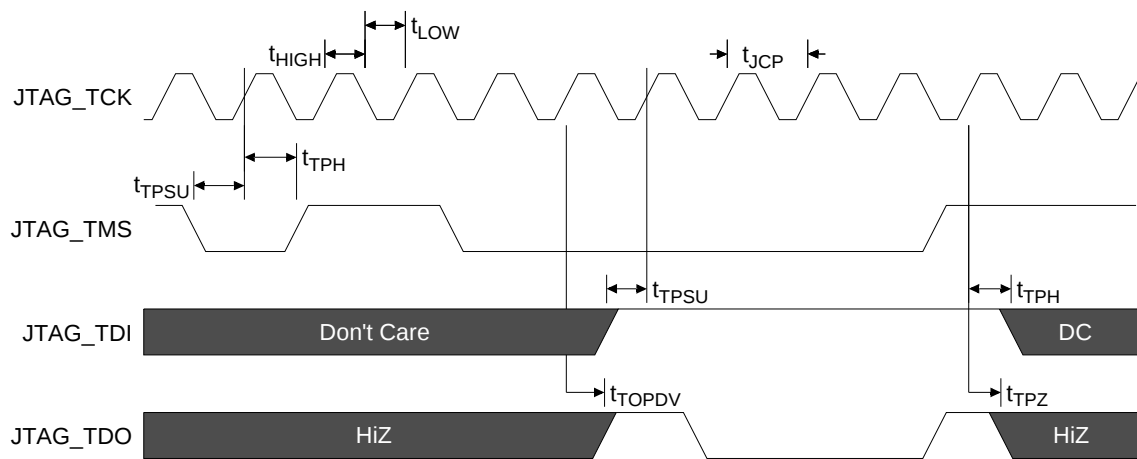
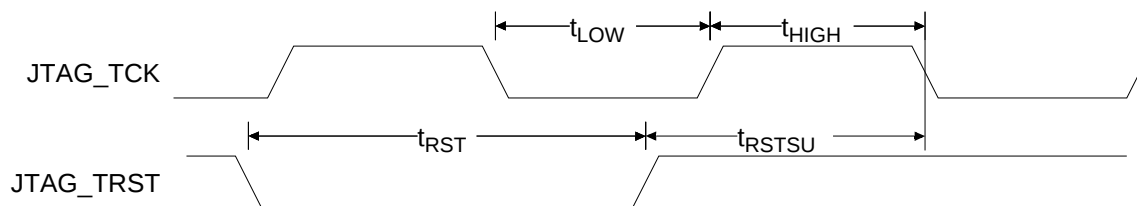
| Parameter                              | Symbol                    | Min. | Typ. | Max. | Units | Notes                                         |
|----------------------------------------|---------------------------|------|------|------|-------|-----------------------------------------------|
| JTAG_CLK period                        | $t_{JCP}$                 | 40   | 100  |      | ns    |                                               |
| JTAG_CLK clock pulse width             | $t_{LOW}$ ,<br>$t_{HIGH}$ | 20   | -    | -    | ns    |                                               |
| JTAG_CLK rise and fall time            | $t_{JRF}$                 | 0    | -    | 3    | ns    |                                               |
| JTAG_TRST setup time                   | $t_{RSTSU}$               | 10   | -    | -    | ns    | With respect to JTAG_CLK falling edge. Note 1 |
| JTAG_TRST assert time                  | $t_{RST}$                 | 10   | -    | -    | ns    |                                               |
| Input data setup time                  | $t_{JSU}$                 | 5    | -    | -    | ns    | Note 2                                        |
| Input Data hold time                   | $t_{JH}$                  | 15   | -    | -    | ns    | Note 2                                        |
| JTAG_CLK to Output data valid          | $t_{JDV}$                 | 0    | -    | 20   | ns    | Note 3                                        |
| JTAG_CLK to Output data high impedance | $t_{JZ}$                  | 0    | -    | 20   | ns    | Note 3                                        |
| JTAG_TMS, JTAG_TDI setup time          | $t_{TPSU}$                | 5    | -    | -    | ns    |                                               |
| JTAG_TMS, JTAG_TDI hold time           | $t_{TPH}$                 | 15   | -    | -    | ns    |                                               |
| JTAG_TDO delay                         | $t_{TOPDV}$               | 0    | -    | 15   | ns    |                                               |
| JTAG_TDO delay to high impedance       | $t_{TPZ}$                 | 0    | -    | 15   | ns    |                                               |

**Table 44 - JTAG Interface Timing**

Note 1:  $\overline{JTAG\_TRST}$  is an asynchronous signal. The setup time is for test purposes only.

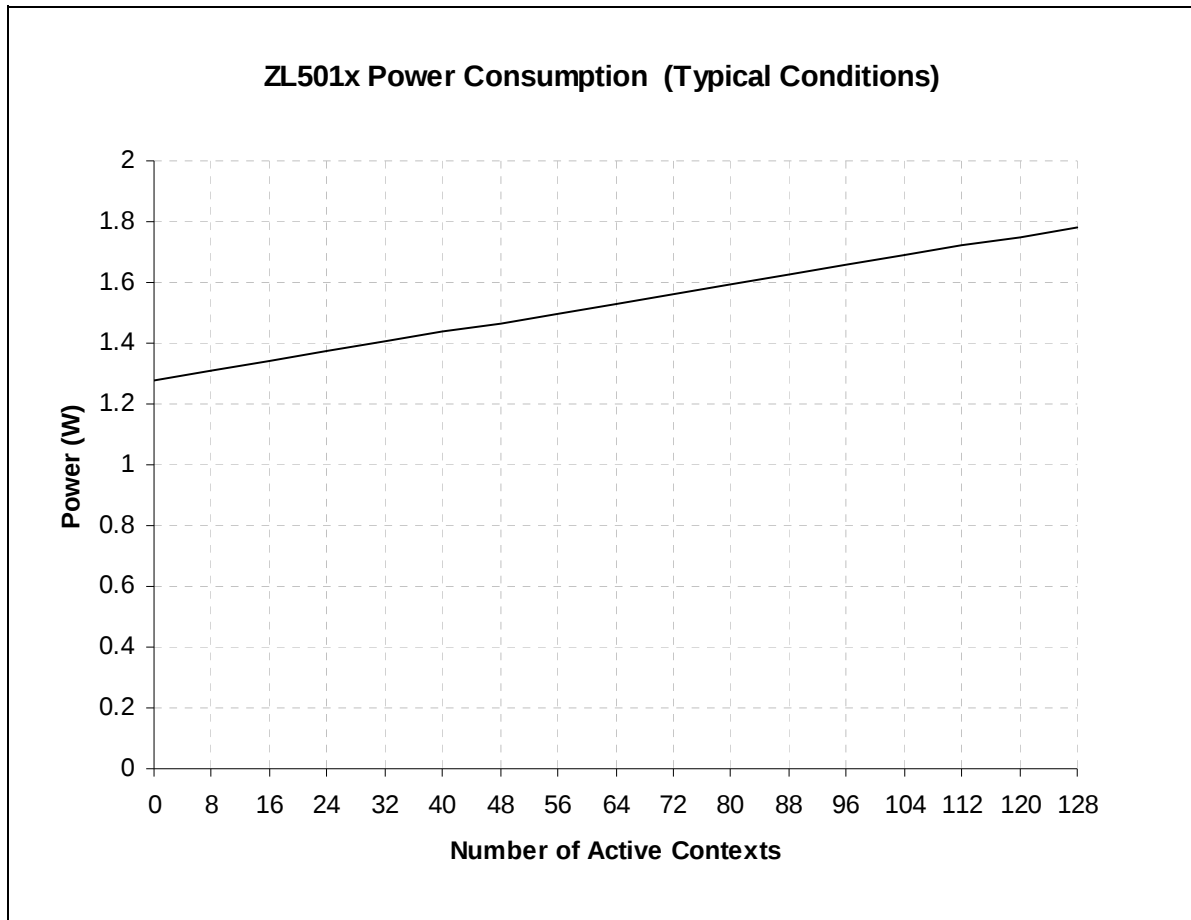
Note 2: Non Test (other than JTAG\_TDI and JTAG\_TMS) signal input timing with respect to JTAG\_CLK.

Note 3: Non Test (other than JTAG\_TDO) signal output with respect to JTAG\_CLK.

**Figure 47 - JTAG Signal Timing****Figure 48 - JTAG Clock and Reset Timing**

## 12.0 Power Characteristics

The following graph in Figure 49 illustrates typical power consumption figures for the ZL50110/11/12/14 family. Typical characteristics are at 1.8 V core, 3.3 V I/O, 25°C and typical processing. Power is plotted against the number of active contexts, which is the dominant factor for power consumption.



**Figure 49 - ZL50110/11/12/14 Power Consumption Plot**

## 13.0 Design and Layout Guidelines

This guide will provide information and guidance for PCB layouts when using the ZL50110/11/12/14. Specific areas of guidance are:

- High Speed Clock and Data, Outputs and Inputs
- CPU\_TA Output

### 13.1 High Speed Clock & Data Interfaces

On the ZL50110/11/12/14 series of devices there are four high-speed data interfaces that need consideration when laying out a PCB to ensure correct termination of traces and the reduction of crosstalk noise. The interfaces being:

- External Memory Interface
- GMAC Interfaces
- TDM Interface
- CPU Interface

It is recommended that the outputs are suitably terminated using a series termination through a resistor as close to the output pin as possible. The purpose of the series termination resistor is to reduce reflections on the line. The value of the series termination and the length of trace the output can drive will depend on the driver output impedance, the characteristic impedance of the PCB trace (recommend 50 ohm), the distributed trace capacitance and the load capacitance. As a general rule of thumb, if the trace length is less than 1/6th of the equivalent length of the rise and fall times, then a series termination may not be required.

$$\text{the equivalent length of rise time} = \text{rise time (ps)} / \text{delay (ps/mm)}$$

For example:

Typical FR4 board delay = 6.8 ps/mm

Typical rise/fall time for a ZL50110/11/12/14 output = 2.5 ns

$$\text{critical track length} = (1/6) \times (2500/6.8) = 61 \text{ mm}$$

Therefore tracks longer than 61 mm will require termination.

As a signal travels along a trace it creates a magnetic field, which induces noise voltages in adjacent traces, this is crosstalk. If the crosstalk is of sufficiently strong amplitude, false data can be induced in the trace and therefore it should be minimized in the layout. The voltage that the external fields cause is proportional to the strength of the field and the length of the trace exposed to the field. Therefore to minimize the effect of crosstalk some basic guidelines should be followed.

First, increase separation of sensitive signals, a rough rule of thumb is that doubling the separation reduces the coupling by a factor of four. Alternatively, shield the victim traces from the aggressor by either routing on another layer separated by a power plane (in a correctly decoupled design the power planes have the same AC potential) or by placing guard traces between the signals usually held ground potential.

Particular effort should be made to minimize crosstalk from ZL50110/11/12/14 outputs and ensuring fast rise time to these inputs.

In Summary:

- Place series termination resistors as close to the pins as possible
- Minimize output capacitance
- Keep common interface traces close to the same length to avoid skew
- Protect input clocks and signals from crosstalk

### 13.1.1 External Memory Interface - special considerations during layout

The timing of address, data and control are all related to the system clock which is also used by the external SSRAM to clock these signals. Therefore the propagation delay of the clock to the ZL50110/11/12/14 and the SSRAM must be matched to within 250 ps, worst case conditions. Trace lengths of these signals must also be minimized (<100 mm) and matched to ensure correct operation under all conditions.

### 13.1.2 GMAC Interface - special considerations during layout

The GMII interface passes data to and from the ZL50110/11/12/14 with their related transmit and receive clocks. It is therefore recommended that the trace lengths for transmit related signals and their clock and the receive related signals and their clock are kept to the same length. By doing this the skew between individual signals and their related clock will be minimized.

### 13.1.3 TDM Interface - special considerations during layout

Although the data rate of this interface is low the outputs edge speeds share the characteristics of the higher data rate outputs and therefore must be treated with the same care extended to the other interfaces with particular reference to the lower stream numbers which support the higher data rates. The TDM interface has numerous clocking schemes and as a result of this the input clock traces to the ZL50110/11/12/14 devices should be treated with care.

### 13.1.4 Summary

Particular effort should be made to minimize crosstalk from ZL50110/11/12/14 outputs and ensuring fast rise time to these inputs.

In Summary:

- Place series termination resistors as close to the pins as possible
- Minimize output capacitance
- Keep common interface traces close to the same length to avoid skew
- Protect input clocks and signals from crosstalk

## 13.2 CPU TA Output

The CPU\_TA output signal from the ZL50110/11/12/14 is a critical handshake signal to the CPU that ensures the correct completion of a bus transaction between the two devices. As the signal is critical, it is recommended that the circuit shown in Figure 50 - CPU\_TA Board Circuit is implemented in systems operating above 40 MHz bus frequency to ensure robust operation under all conditions.

The following external logic is required to implement the circuit:

- 74LCX74 dual D-type flip-flop (one section of two)
- 74LCX08 quad AND gate (one section of four)
- 74LCX125 quad tri-state buffer (one section of four)
- 4K7 resistor x2

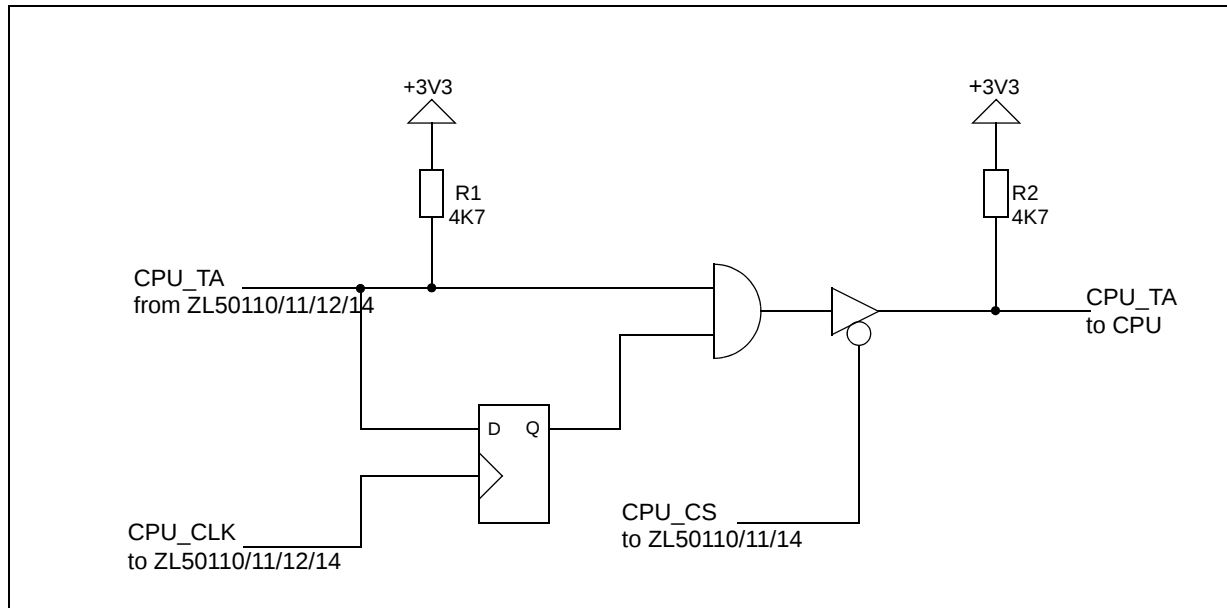


Figure 50 - CPU\_TA Board Circuit

The function of the circuit is to extend the TA signal, to ensure the CPU correctly registers it. Resistor R2 must be fitted to ensure correct operation of the TA input to the processor. It is recommended that the logic is fitted close to the ZL50110/11/12/14 and that the clock to the 74LCX74 is derived from the same clock source as that input to the ZL50110/11/12/14.

### 13.3 Mx\_LINKUP\_LED Outputs

The ZL50111/2 and ZL50110/4 have different Mx\_LINKUP\_LED pin assignments as shown in Table 46.

| Signal        | ZL50111/2 Pin | ZL50110/4 Pin |
|---------------|---------------|---------------|
| M0_LINKUP_LED | AB23          | G24           |
| M1_LINKUP_LED | F26           | G23           |
| M2_LINKUP_LED | G23           | NC            |
| M3_LINKUP_LED | G24           | NC            |

Table 45 - Mx\_LINKUP\_LED Pin Assignments

To generate a pin for pin compatible PCB for all three variants, the following stuffing options may be used as shown in Figure 51. For the ZL50111 and ZL50112 variants, resistors R4 and R6 are not populated. For the ZL50110 and ZL50114 variants, resistors R1, R2, R3 and R5 as well as LEDs for M2 and M3 are not populated.

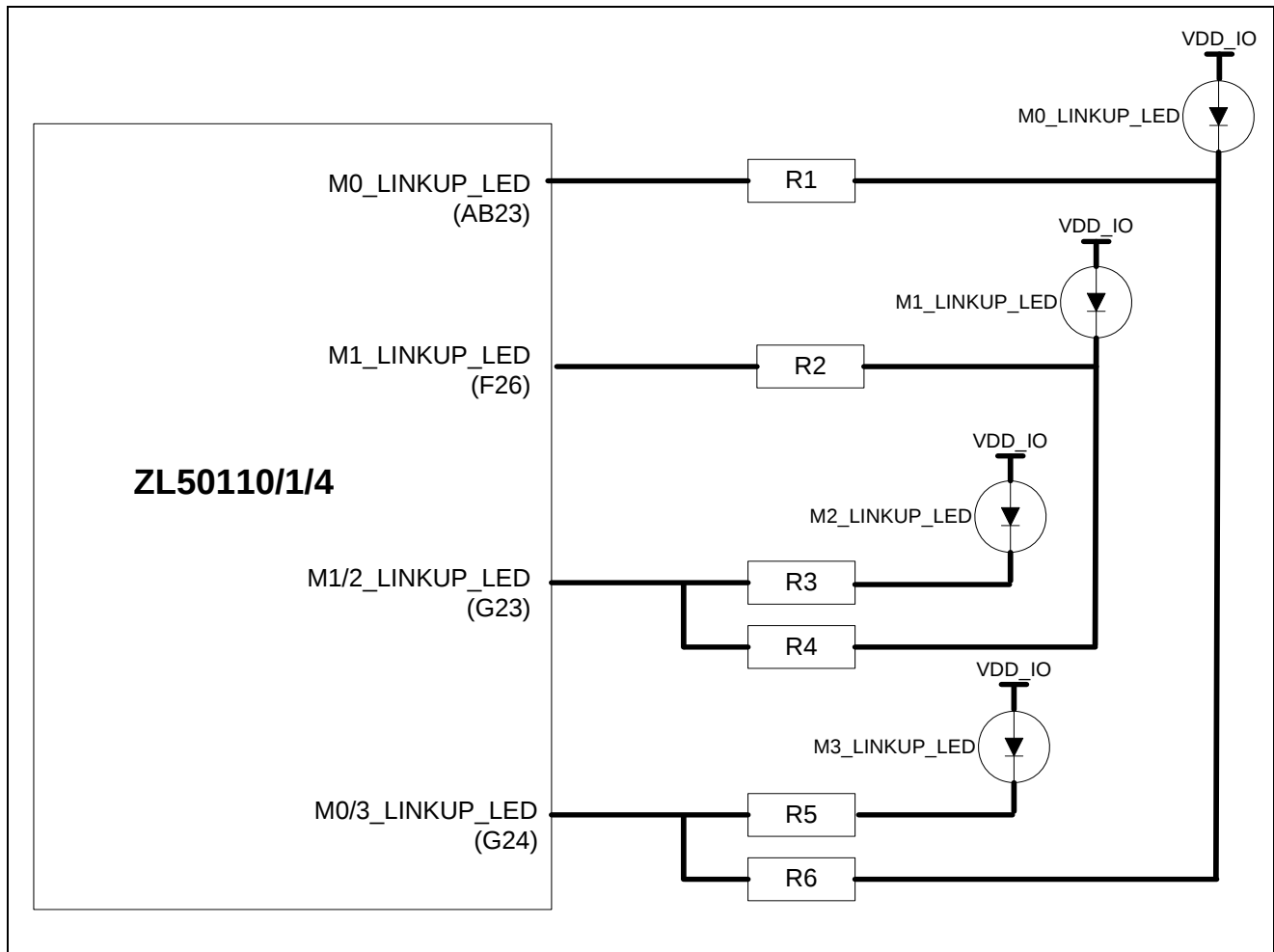


Figure 51 - Mx\_LINKUP\_LED Stuffing Option

Table 46 lists the various components that are used for each variant.

| Component | ZL50111/2 | ZL50110/4 |
|-----------|-----------|-----------|
| R1        | √         | -         |
| R2        | √         | -         |
| R3        | √         | -         |
| R4        | -         | √         |
| R5        | √         | -         |
| R6        | -         | √         |
| M0 LED    | √         | √         |
| M1 LED    | √         | √         |
| M2 LED    | √         | -         |
| M3 LED    | √         | -         |

**Table 46 - Mx\_LINKUP\_LED Stuffing Option**

## 14.0 Reference Documents

### 14.1 External Standards/Specifications

- IEEE Standard 1149.1-2001; Test Access Port and Boundary Scan Architecture
- IEEE Standard 802.3-2000; Local and Metropolitan Networks CSMA/CD Access Method and Physical Layer
- ECTF H.110 Revision 1.0; Hardware Compatibility Specification
- H-MVIP (GO-MVIP) Standard Release 1.1a; Multi-Vendor Integration Protocol
- MPC8260AEC/D Revision 0.7; Motorola MPC8260 Family Hardware Specification
- RFC 768; UDP
- RFC 791; IPv4
- RFC 2460; IPv6
- RFC 1889; RTP
- RFC 2661; L2TP
- RFC 1213; MIB II
- RFC 1757; Remote Network Monitoring MIB (for SMIv1)
- RFC 2819; Remote Network Monitoring MIB (for SMIv2)
- RFC 2863; Interfaces Group MIB
- CCITT G.712; TDM Timing Specification (Method 2)
- G.823; Control of Jitter/Wander with digital networks based on the 2.048 Mbps hierarchy
- G.824; Control of Jitter/Wander with digital networks based on the 1.544 Mbps hierarchy
- G.8261; Timing and Synchronization aspects in Packet Networks
- ANSI T1.101 Stratum 3/4
- Telcordia GR-1244-CORE Stratum 3/4/4e
- RFC4553; Structure-Agnostic TDM over Packet (SAToP)
- ITU-T Y.1413 TDM-MPLS Network Interworking
- *Optional Packet Memory Device* - Micron MT55L128L32P1 8 Mb ZBT-SRAM

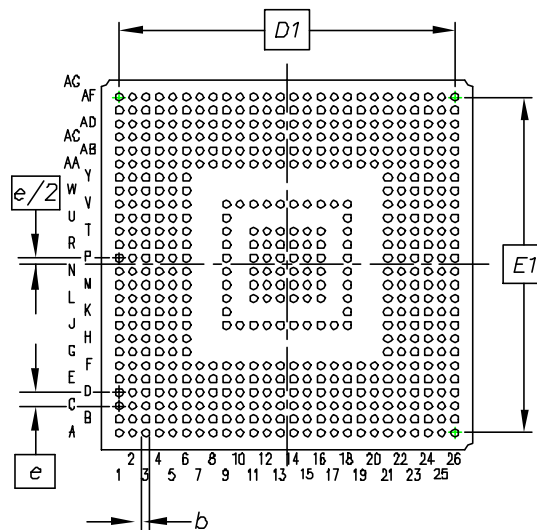
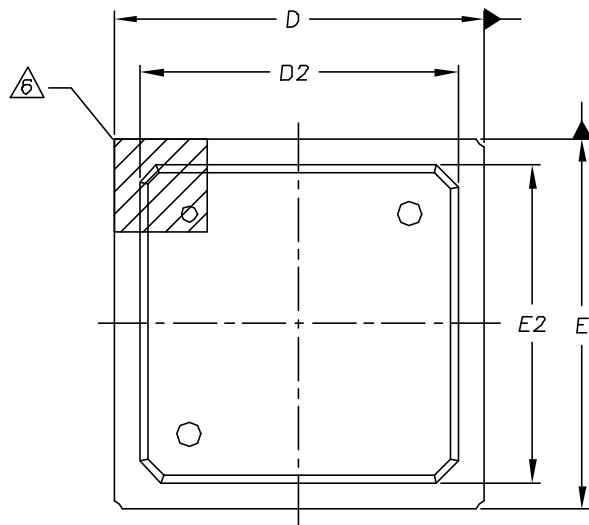
### 14.2 Zarlink Standards

- MSAN-126 Revision B, Issue 4; ST-BUS Generic Device Specification

## 15.0 Glossary

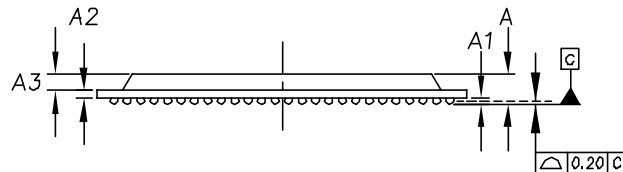
|                    |                                                                                                                  |
|--------------------|------------------------------------------------------------------------------------------------------------------|
| <b>API</b>         | Application Program Interface                                                                                    |
| <b>ATM</b>         | Asynchronous Transfer Mode                                                                                       |
| <b>CDP</b>         | Context Descriptor Protocol (the protocol used by Zarlink's MT9088x family of TDM-Packet devices)                |
| <b>CESoP</b>       | Circuit Emulation Services over Packet                                                                           |
| <b>CESoPSN</b>     | Circuit Emulation Services over Packet Switched Networks (draft-ietf-pwe3-cesopsn)                               |
| <b>CONTEXT</b>     | A programmed connection of a number of TDM timeslots assembled into a unique packet stream.                      |
| <b>CPU</b>         | Central Processing Unit                                                                                          |
| <b>DMA</b>         | Direct Memory Access                                                                                             |
| <b>DPLL</b>        | Digital Phase Locked Loop                                                                                        |
| <b>DSP</b>         | Digital Signal Processor                                                                                         |
| <b>GMII</b>        | Gigabit Media Independent Interface                                                                              |
| <b>H.100/H.110</b> | High capacity TDM backplane standards                                                                            |
| <b>H-MVIP</b>      | High-performance Multi-Vendor Integration Protocol (a TDM bus standard)                                          |
| <b>IA</b>          | Implementation Agreement                                                                                         |
| <b>IETF</b>        | Internet Engineering Task Force                                                                                  |
| <b>IP</b>          | Internet Protocol (version 4, RFC 791, version 6, RFC 2460)                                                      |
| <b>JTAG</b>        | Joint Test Algorithms Group (generally used to refer to a standard way of providing a board-level test facility) |
| <b>L2TP</b>        | Layer 2 Tunneling Protocol (RFC 2661)                                                                            |
| <b>LAN</b>         | Local Area Network                                                                                               |
| <b>LIU</b>         | Line Interface Unit                                                                                              |
| <b>MAC</b>         | Media Access Control                                                                                             |
| <b>MEF</b>         | Metro Ethernet Forum                                                                                             |
| <b>MFA</b>         | MPLS and Frame Relay Alliance                                                                                    |
| <b>MII</b>         | Media Independent Interface                                                                                      |
| <b>MIB</b>         | Management Information Base                                                                                      |
| <b>MPLS</b>        | Multi Protocol Label Switching                                                                                   |
| <b>MTIE</b>        | Maximum Time Interval Error                                                                                      |
| <b>MVIP</b>        | Multi-Vendor Integration Protocol (a TDM bus standard)                                                           |
| <b>OC3</b>         | Optical Carrier 3 - 155.52 Mbps leased line                                                                      |
| <b>PDH</b>         | Plesiochronous Digital Hierarchy                                                                                 |
| <b>PLL</b>         | Phase Locked Loop                                                                                                |
| <b>PRS</b>         | Primary Reference Source                                                                                         |
| <b>PRX</b>         | Packet Receive                                                                                                   |

|               |                                                                  |
|---------------|------------------------------------------------------------------|
| <b>PSTN</b>   | Public Switched Telephone Circuit                                |
| <b>PTX</b>    | Packet Transmit                                                  |
| <b>PWE3</b>   | Pseudo-Wire Emulation Edge to Edge (a working group of the IETF) |
| <b>QOS</b>    | Quality of Service                                               |
| <b>RTP</b>    | Real Time Protocol (RFC 1889)                                    |
| <b>PE</b>     | Protocol Engine                                                  |
| <b>SAToP</b>  | Structure-Agnostic Transport over Packet                         |
| <b>SSRAM</b>  | Synchronous Static Random Access Memory                          |
| <b>ST BUS</b> | Standard Telecom Bus, a standard interface for TDM data streams  |
| <b>TDL</b>    | Tapped Delay Line                                                |
| <b>TDM</b>    | Time Division Multiplexing                                       |
| <b>UDP</b>    | User Datagram Protocol (RFC 768)                                 |
| <b>UI</b>     | Unit Interval                                                    |
| <b>VLAN</b>   | Virtual Local Area Network                                       |
| <b>WFQ</b>    | Weighted Fair Queuing                                            |
| <b>ZBT</b>    | Zero Bus Turnaround, a type of synchronous SRAM                  |



| SYMBOL | MILLIMETER |       |       | INCH      |       |       |
|--------|------------|-------|-------|-----------|-------|-------|
|        | MIN        | NOM   | MAX   | MIN       | NOM   | MAX   |
| A      | 2.13       | 2.33  | 2.53  | .084      | .092  | .100  |
| A1     | 0.50       | 0.60  | 0.70  | .020      | .024  | .028  |
| A2     | 0.51       | 0.56  | 0.61  | .020      | .022  | .024  |
| A3     | 1.12       | 1.17  | 1.22  | .044      | .046  | .048  |
| b      | 0.60       | 0.75  | 0.90  | .024      | .030  | .035  |
| D      | 34.80      | 35.00 | 35.20 | 1.370     | 1.378 | 1.386 |
| D1     | 31.75 BSC  |       |       | 1.250 BSC |       |       |
| D2     | 29.90      | 30.00 | 30.10 | 1.177     | 1.181 | 1.185 |
| E      | 34.80      | 35.00 | 35.20 | 1.370     | 1.378 | 1.386 |
| E1     | 31.75 BSC  |       |       | 1.250 BSC |       |       |
| E2     | 29.90      | 30.00 | 30.10 | 1.177     | 1.181 | 1.185 |
| e      | 1.27 BSC   |       |       | .050 BSC  |       |       |

Confirms to JEDEC MS-034  
BAR-2 iss. A



#### NOTE:

1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M-1982.
2. DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER
3. PRIMARY DATUM  $\square C \square$  AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
4. ALL DIMENSIONS ARE IN MILLIMETERS.
5. NOT TO SCALE.
6. DETAILS OF A1 CORNER ARE OPTIONAL, AND MAY CONSIST OF INK DOT, LASER MARK OR METALISED MARKING, BUT MUST BE LOCATED WITHIN ZONE INDICATED.

© Zarlink Semiconductor 2003 All rights reserved.

| ISSUE  | 1       | 2       |  |  |
|--------|---------|---------|--|--|
| ACN    | 213837  |         |  |  |
| DATE   | 12Dec02 | 19Aug03 |  |  |
| APPRD. |         |         |  |  |



Previous package codes

BP

Package Code GA

Package Outline Drawing for 552  
PBGA (35x35)mm, 1.27mm pitch

GPD00809



**For more information about all Zarlink products  
visit our Web Site at  
[www.zarlink.com](http://www.zarlink.com)**

Information relating to products and services furnished herein by Zarlink Semiconductor Inc. or its subsidiaries (collectively "Zarlink") is believed to be reliable. However, Zarlink assumes no liability for errors that may appear in this publication, or for liability otherwise arising from the application or use of any such information, product or service or for any infringement of patents or other intellectual property rights owned by third parties which may result from such application or use. Neither the supply of such information or purchase of product or service conveys any license, either express or implied, under patents or other intellectual property rights owned by Zarlink or licensed from third parties by Zarlink, whatsoever. Purchasers of products are also hereby notified that the use of product in certain ways or in combination with Zarlink, or non-Zarlink furnished goods or services may infringe patents or other intellectual property rights owned by Zarlink.

This publication is issued to provide information only and (unless agreed by Zarlink in writing) may not be used, applied or reproduced for any purpose nor form part of any order or contract nor to be regarded as a representation relating to the products or services concerned. The products, their specifications, services and other information appearing in this publication are subject to change by Zarlink without notice. No warranty or guarantee express or implied is made regarding the capability, performance or suitability of any product or service. Information concerning possible methods of use is provided as a guide only and does not constitute any guarantee that such methods of use will be satisfactory in a specific piece of equipment. It is the user's responsibility to fully determine the performance and suitability of any equipment using such information and to ensure that any publication or data used is up to date and has not been superseded. Manufacturing does not necessarily include testing of all functions or parameters. These products are not suitable for use in any medical products whose failure to perform may result in significant injury or death to the user. All products and materials are sold and services provided subject to Zarlink's conditions of sale which are available on request.

Purchase of Zarlink's I<sup>2</sup>C components conveys a license under the Philips I<sup>2</sup>C Patent rights to use these components in an I<sup>2</sup>C System, provided that the system conforms to the I<sup>2</sup>C Standard Specification as defined by Philips.

Zarlink, ZL, the Zarlink Semiconductor logo and the Legerity logo and combinations thereof, VoiceEdge, VoicePort, SLAC, ISLIC, ISLAC and VoicePath are trademarks of Zarlink Semiconductor Inc.

**TECHNICAL DOCUMENTATION - NOT FOR RESALE**